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مع تحيات إدارة الموقع وفريق عمله

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PHILOSOPHY AND GOALS

The purpose of the third edition of this book is to provide a basis for understanding the characteristics, operation, and limitations of semiconductor devices. In order to gain this understanding, it is essential to have a thorough knowledge of the physics of the semiconductor material. The goal of this book is to bring together quantum mechanics, the quantum theory of solids, semiconductor material physics, and semiconductor device physics. All of these components are vital to the understanding of both the operation of present day devices and any future development in the field.

The amount of physics presented in this text is greater than what is covered in many introductory semiconductor device books. Although this coverage is more extensive, the author has found that once the basic introductory and material physics have been thoroughly covered, the physics of the semiconductor device follows quite naturally and can be covered fairly quickly and efficiently. The emphasis on the underlying physics will also be a benefit in understanding and perhaps in developing new semiconductor devices.

Since the objective of this text is to provide an introduction to the theory of semiconductor devices, there is a great deal of advanced theory that is not considered. In addition, fabrication processes are not described in detail. There are a few references and general discussions about processing techniques such as diffusion and ion implantation, but only where the results of this processing have direct impact on device characteristics.

PREREQUISITES

This book is intended for junior and senior undergraduates. The prerequisites for understanding the material are college mathematics, up to and including differential equations, and college physics, including an introduction to modern physics and electrostatics. Prior completion of an introductory course in electronic circuits is helpful, but not essential.

ORGANIZATION

The text begins with the introductory physics, moves on to the semiconductor material physics, and then covers the physics of semiconductor devices. Chapter 1 presents an introduction to the crystal structure of solids, leading to the ideal single-crystal semiconductor material. Chapters 2 and 3 introduce quantum mechanics and the quantum theory of solids, which together provide the necessary basic physics.

Chapters 4 through 6 cover the semiconductor material physics. Chapter 4 presents the physics of the semiconductor in thermal equilibrium; Chapter 5 treats the transport
phenomena of the charge carriers in a semiconductor. The nonequilibrium excess carrier characteristics are then developed in Chapter 6. Understanding the behavior of excess carriers in a semiconductor is vital to the goal of understanding the device physics.

The physics of the basic semiconductor devices is developed in Chapters 7 through 13. Chapter 7 treats the electrostatics of the basic pn junction, and Chapter 8 covers the current-voltage characteristics of the pn junction. Metal-semiconductor junctions, both rectifying and nonrectifying, and semiconductor heterojunctions are considered in Chapter 9, while Chapter 10 treats the bipolar transistor. The physics of the metal-oxide-semiconductor field-effect transistor is presented in Chapters 11 and 12, and Chapter 13 covers the junction field-effect transistor. Once the physics of the pn junction is developed, the chapters dealing with the three basic transistors may be covered in any order—these chapters are written so as not to depend on one another. Chapter 14 considers optical devices and finally Chapter 15 covers power semiconductor devices.

USE OF THE BOOK
The text is intended for a one-semester course at the junior or senior level. As with most textbooks, there is more material than can be conveniently covered in one semester; this allows each instructor some flexibility in designing the course to his/her own specific needs. Two possible orders of presentation are discussed later in a separate section in this preface. However, the text is not an encyclopedia. Sections in each chapter that can be skipped without loss of continuity are identified by an asterisk in both the table of contents and in the chapter itself. These sections, although important to the development of semiconductor device physics, can be postponed to a later time.

The material in the text has been used extensively in a course that is required for junior-level electrical engineering students at the University of New Mexico. Slightly less than half of the semester is devoted to the first six chapters; the remainder of the semester is devoted to the pn junction, the bipolar transistor, and the metal-oxide-semiconductor field-effect transistor. A few other special topics may be briefly considered near the end of the semester.

Although the bipolar transistor is discussed in Chapter 10 before the MOSFET or JFET, each chapter dealing with one of the three basic types of transistors is written to stand alone. Any one of the transistor types may be covered first.

NOTES TO THE READER
This book introduces the physics of semiconductor materials and devices. Although many electrical engineering students are more comfortable building electronic circuits or writing computer programs than studying the underlying principles of semiconductor devices, the material presented here is vital to an understanding of the limitations of electronic devices, such as the microprocessor.

Mathematics is used extensively throughout the book. This may at times seem tedious, but the end result is an understanding that will not otherwise occur. Although some of the mathematical models used to describe physical processes may seem abstract, they have withstood the test of time in their ability to describe and predict these physical processes.
The reader is encouraged to continually refer to the preview sections so that the objective of the chapter and the purposes of each topic can be kept in mind. This constant review is especially important in the first five chapters, dealing with basic physics.

The reader must keep in mind that, although some sections may be skipped without loss of continuity, many instructors will choose to cover these topics. The fact that sections are marked with an asterisk does not minimize the importance of these subjects.

It is also important that the reader keep in mind that there may be questions still unanswered at the end of a course. Although the author dislikes the phrase, “it can be shown that . . . ,” there are some concepts used here that rely on derivations beyond the scope of the text. This book is intended as an introduction to the subject. Those questions remaining unanswered at the end of the course, the reader is encouraged to keep “in a desk drawer.” Then, during the next course in this area of concentration, the reader can take out these questions and search for the answers.

ORDER OF PRESENTATION

Each instructor has a personal preference for the order in which the course material is presented. Listed below are two possible scenarios. The first case, called the classical approach, covers the bipolar transistor before the MOS transistor. However, because the MOS transistor topic is left until the end of the semester, time constraints may shortchange the amount of class time devoted to this important topic.

The second method of presentation listed, called the nonclassical approach, discusses the MOS transistor before the bipolar transistor. Two advantages to this approach are that the MOS transistor will not get shortchanged in terms of time devoted to the topic and, since a “real device” is discussed earlier in the semester, the reader may have more motivation to continue studying this course material. A possible disadvantage to this approach is that the reader may be somewhat intimidated by jumping from Chapter 7 to Chapter 11. However, the material in Chapters 11 and 12 is written so that this jump can be made.

Unfortunately, because of time constraints, every topic in every chapter cannot be covered in a one-semester course. The remaining topics must be left for a second-semester course or for further study by the reader.

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**FEATURES OF THE THIRD EDITION**

- **Preview section:** A preview section introduces each chapter. This preview links the chapter to previous chapters and states the chapter's goals, i.e., what the reader should gain from the chapter.

- **Examples:** An extensive number of worked examples are used throughout the text to reinforce the theoretical concepts being developed. These examples contain all the details of the analysis or design, so the reader does not have to fill in missing steps.

- **Test your understanding:** Exercise or drill problems are included throughout each chapter. These problems are generally placed immediately after an example problem, rather than at the end of a long section, so that readers can immediately test their understanding of the material just covered. Answers are given for each drill problem so readers do not have to search for an answer at the end of the book. These exercise problems will reinforce readers' grasp of the material before they move on to the next section.

- **Summary section:** A summary section, in bullet form, follows the text of each chapter. This section summarizes the overall results derived in the chapter and reviews the basic concepts developed.

- **Glossary of important terms:** A glossary of important terms follows the Summary section of each chapter. This section defines and summarizes the most important terms discussed in the chapter.

- **Checkpoint:** A checkpoint section follows the Glossary section. This section states the goals that should have been met and states the abilities the reader should have gained. The Checkpoints will help assess progress before moving on to the next chapter.

- **Review questions:** A list of review questions is included at the end of each chapter. These questions serve as a self-test to help the reader determine how well the concepts developed in the chapter have been mastered.

- **End-of-chapter problems:** A large number of problems are given at the end of each chapter, organized according to the subject of each section in the chapter.
body. A larger number of problems have been included than in the second edition. Design-oriented or open-ended problems are included at the end in a Summary and Review section.

- **Computer simulation:** Computer simulation problems are included in many end-of-chapter problems. Computer simulation has not been directly incorporated into the text. However, a website has been established that considers computer simulation using MATLAB. This website contains computer simulations of material considered in most chapters. These computer simulations enhance the theoretical material presented. There also are exercise or drill problems that a reader may consider.

- **Reading list:** A reading list finishes up each chapter. The references, that are at an advanced level compared with that of this text, are indicated by an asterisk.

- **Answers to selected problems:** Answers to selected problems are given in the last appendix. Knowing the answer to a problem is an aid and a reinforcement in problem solving.

**ICONS**

- Computer Simulations
- Design Problems and Examples

**SUPPLEMENTS**

This book is supported by the following supplements:

- Solutions Manual available to instructors in paper form and on the website.
- Power Point slides of important figures are available on the website.
- Computer simulations are available on the website.

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I appreciate the many fine and thorough reviews—you suggestions have made this a better book.

Donald A. Neamen
PROLOGUE

Semiconductors and the Integrated Circuit

PREVIEW

We often hear that we are living in the information age. Large amounts of information can be obtained via the Internet, for example, and can also be obtained quickly over long distances via satellite communication systems. The development of the transistor and the integrated circuit (IC) has lead to these remarkable capabilities. The IC permeates almost every facet of our daily lives, including such things as the compact disk player, the fax machine, laser scanners at the grocery store, and the cellular telephone. One of the most dramatic examples of IC technology is the digital computer—a relatively small laptop computer today has more computing capability than the equipment used to send a man to the moon a few years ago. The semiconductor electronics field continues to be a fast-changing one, with thousands of technical papers published each year.

HISTORY

The semiconductor device has a fairly long history, although the greatest explosion of IC technology has occurred during the last two or three decades. The metal-semiconductor contact dates back to the early work of Braun in 1874, who discovered the asymmetric nature of electrical conduction between metal contacts and semiconductors, such as copper, iron, and lead sulfide. These devices were used as

---

1This brief introduction is intended to give a flavor of the history of the semiconductor device and integrated circuit. Thousands of engineers and scientists have made significant contributions to the development of semiconductor electronics—the few events and names mentioned here are not meant to imply that these are the only significant events or people involved in the semiconductor history.
detectors in early experiments on radio. In 1906, Pickard took out a patent for a point contact detector using silicon and, in 1907, Pierce published rectification characteristics of diodes made by sputtering metals onto a variety of semiconductors.

By 1935, selenium rectifiers and silicon point contact diodes were available for use as radio detectors. With the development of radar, the need for detector diodes and mixers increased. Methods of achieving high-purity silicon and germanium were developed during this time. A significant advance in our understanding of the metal-semiconductor contact was aided by developments in the semiconductor physics. Perhaps most important during this period was Bethe's thermionic-emission theory in 1942, according to which the current is determined by the process of emission of electrons into the metal rather than by drift or diffusion.

Another big breakthrough came in December 1947 when the first transistor was constructed and tested at Bell Telephone Laboratories by William Shockley, John Bardeen, and Walter Brattain. This first transistor was a point contact device and used polycrystalline germanium. The transistor effect was soon demonstrated in silicon as well. A significant improvement occurred at the end of 1949 when single-crystal material was used rather than the polycrystalline material. The single crystal yields uniform and improved properties throughout the whole semiconductor material.

The next significant step in the development of the transistor was the use of the diffusion process to form the necessary junctions. This process allowed better control of the transistor characteristics and yielded higher-frequency devices. The diffused mesa transistor was commercially available in germanium in 1957 and in silicon in 1958. The diffusion process also allowed many transistors to be fabricated on a single silicon slice, so the cost of these devices decreased.

THE INTEGRATED CIRCUIT (IC)

Up to this point, each component in an electronic circuit had to be individually connected by wires. In September 1958, Jack Kilby of Texas Instruments demonstrated the first integrated circuit, which was fabricated in germanium. At about the same time, Robert Noyce of Fairchild Semiconductor introduced the integrated circuit in silicon using a planar technology. The first circuit used bipolar transistors. Practical MOS transistors were then developed in the mid-'60s. The MOS technologies, especially CMOS, have become a major focus for IC design and development. Silicon is the main semiconductor material. Gallium arsenide and other compound semiconductors are used for special applications requiring very high frequency devices and for optical devices.

Since that first IC, circuit design has become more sophisticated, and the integrated circuit more complex. A single silicon chip may be on the order of 1 square centimeter and contain over a million transistors. Some ICs may have more than a hundred terminals, while an individual transistor has only three. An IC can contain the arithmetic, logic, and memory functions on a single semiconductor chip—the primary example of this type of IC is the microprocessor. Intense research on silicon processing and increased automation in design and manufacturing have led to lower costs and higher fabrication yields.
FACTORATION

The integrated circuit is a direct result of the development of various processing techniques needed to fabricate the transistor and interconnect lines on the single chip. The total collection of these processes for making an IC is called a technology. The following few paragraphs provide an introduction to a few of these processes. This introduction is intended to provide the reader with some of the basic terminology used in processing.

Thermal Oxidation A major reason for the success of silicon ICs is the fact that an excellent native oxide, SiO₂, can be formed on the surface of silicon. This oxide is used as a gate insulator in the MOSFET and is also used as an insulator, known as the field oxide, between devices. Metal interconnect lines that connect various devices can be placed on top of the field oxide. Most other semiconductors do not form native oxides that are of sufficient quality to be used in device fabrication.

Silicon will oxidize at room temperature in air forming a thin native oxide of approximately 25 Å thick. However, most oxidations are done at elevated temperatures since the basic process requires that oxygen diffuse through the existing oxide to the silicon surface where a reaction can occur. A schematic of the oxidation process is shown in Figure 0.1. Oxygen diffuses across a stagnant gas layer directly adjacent to the oxide surface and then diffuses through the existing oxide layer to the silicon surface where the reaction between O₂ and Si forms SiO₂. Because of this reaction, silicon is actually consumed from the surface of the silicon. The amount of silicon consumed is approximately 44 percent of the thickness of the final oxide.

Photomasks and Photolithography The actual circuitry on each chip is created through the use of photomasks and photolithography. The photomask is a physical representation of a device or a portion of a device. Opaque regions on the mask are made of an ultraviolet-light-absorbing material. A photosensitive layer, called photoresist, is first spread over the surface of the semiconductor. The photoresist is an
organic polymer that undergoes chemical change when exposed to ultraviolet light. The photoresist is exposed to ultraviolet light through the photomask as indicated in Figure 0.2. The photoresist is then developed in a chemical solution. The developer is used to remove the unwanted portions of the photoresist and generate the appropriate patterns on the silicon. The photomasks and photolithography process is critical in that it determines how small the devices can be made. Instead of using ultraviolet light, electrons and x-rays can also be used to expose the photoresist.

**Etching** After the photoresist pattern is formed, the remaining photoresist can be used as a mask, so that the material not covered by the photoresist can be etched. Plasma etching is now the standard process used in IC fabrication. Typically, an etch gas such as chlorofluorocarbons are injected into a low-pressure chamber. A plasma is created by applying a radio-frequency voltage between cathode and anode terminals. The silicon wafer is placed on the cathode. Positively charged ions in the plasma are accelerated toward the cathode and bombard the wafer normal to the surface. The actual chemical and physical reaction at the surface is complex, but the net result is that silicon can be etched anisotropically in very selected regions of the wafer. If photoresist is applied on the surface of silicon dioxide, then the silicon dioxide can also be etched in a similar way.

**Diffusion** A thermal process that is used extensively in IC fabrication is diffusion. Diffusion is the process by which specific types of "impurity" atoms can be introduced into the silicon material. This doping process changes the conductivity type of the silicon so that pn junctions can be formed. (The pn junction is a basic building block of semiconductor devices.) Silicon wafers are oxidized to form a layer of silicon dioxide and windows are opened in the oxide in selected areas using photolithography and etching as just described.

The wafers are then placed in a high-temperature furnace (about 1100 C) and dopant atoms such as boron or phosphorus are introduced. The dopant atoms gradually diffuse or move into the silicon due to a density gradient. Since the diffusion process requires a gradient in the concentration of atoms, the final concentration of
diffused atoms is nonlinear, as shown in Figure 0.3. When the wafer is removed from the furnace and the wafer temperature returns to room temperature, the diffusion coefficient of the dopant atoms is essentially zero so that the dopant atoms are then fixed in the silicon material.

**Ion Implantation** A fabrication process that is an alternative to high-temperature diffusion is ion implantation. A beam of dopant ions is accelerated to a high energy and is directed at the surface of a semiconductor. As the ions enter the silicon, they collide with silicon atoms and lose energy and finally come to rest at some depth within the crystal. Since the collision process is statistical in nature, there is a distribution in the depth of penetration of the dopant ions. Figure 0.4 shows such an example of the implantation of boron into silicon at a particular energy.

Two advantages of the ion implantation process compared to diffusion are (1) the ion implantation process is a low temperature process and (2) very well defined doping layers can be achieved. Photoresist layers or layers of oxide can be used to block the penetration of dopant atoms so that ion implantation can occur in very selected regions of the silicon.

![Figure 0.3](image1.png)

**Figure 0.3** | Final concentration of diffused impurities into the surface of a semiconductor.

![Figure 0.4](image2.png)

**Figure 0.4** | Final concentration of ion-implanted boron into silicon.
One disadvantage of ion implantation is that the silicon crystal is damaged by the penetrating dopant atoms because of collisions between the incident dopant atoms and the host silicon atoms. However, most of the damage can be removed by thermal annealing the silicon at an elevated temperature. The thermal annealing temperature, however, is normally much less that the diffusion process temperature.

**Metallization, Bonding, and Packaging**  After the semiconductor devices have been fabricated by the processing steps discussed, they need to be connected to each other to form the circuit. Metal films are generally deposited by a vapor deposition technique and the actual interconnect lines are formed using photolithography and etching. In general, a protective layer of silicon nitride is finally deposited over the entire chip.

The individual integrated circuit chips are separated by scribing and breaking the wafer. The integrated circuit chip is then mounted in a package. Lead bonders are finally used to attach gold or aluminum wires between the chip and package terminals.

**Summary: Simplified Fabrication of a pn Junction**  Figure 0.5 shows the basic steps in forming a pn junction. These steps involve some of the processing described in the previous paragraphs.

**Figure 0.5** The basic steps in forming a pn junction.
The Crystal Structure of Solids

PREVIEW

This text deals with the electrical properties and characteristics of semiconductor materials and devices. The electrical properties of solids are therefore of primary interest. The semiconductor is in general a single-crystal material. The electrical properties of a single-crystal material are determined not only by the chemical composition but also by the arrangement of atoms in the solid; this being true, a brief study of the crystal structure of solids is warranted. The formation, or growth, of the single-crystal material is an important part of semiconductor technology. A short discussion of several growth techniques is included in this chapter to provide the reader with some of the terminology that describes semiconductor device structures. This introductory chapter provides the necessary background in single-crystal materials and crystal growth for the basic understanding of the electrical properties of semiconductor materials and devices.

1.1 SEMICONDUCTOR MATERIALS

Semiconductors are a group of materials having conductivities between those of metals and insulators. Two general classifications of semiconductors are the elemental semiconductor materials, found in group IV of the periodic table, and the compound semiconductor materials, most of which are formed from special combinations of group III and group V elements. Table 1.1 shows a portion of the periodic table in which the more common semiconductors are found and Table 1.2 lists a few of the semiconductor materials. (Semiconductors can also be formed from combinations of group II and group VI elements, but in general these will not be considered in this text.) The elemental materials, those that are composed of single species of atoms, are silicon and germanium. Silicon is by far the most common semiconductor used in integrated circuits and will be emphasized to a great extent.
The two-element, or binary, compounds such as gallium arsenide or gallium phosphide are formed by combining one group III and one group V element. Gallium arsenide is one of the more common of the compound semiconductors. Its good optical properties make it useful in optical devices. GaAs is also used in specialized applications in which, for example, high speed is required.

We can also form a three-element, or ternary, compound semiconductor. An example is Al$_x$Ga$_{1-x}$As, in which the subscript $x$ indicates the fraction of the lower atomic number element component. More complex semiconductors can also be formed that provide flexibility when choosing material properties.

### 1.2 TYPES OF SOLIDS

Amorphous, polycrystalline, and single crystal are the three general types of solids. Each type is characterized by the size of an ordered region within the material. An ordered region is a spatial volume in which atoms or molecules have a regular geometric arrangement or periodicity. Amorphous materials have order only within a few atomic or molecular dimensions, while polycrystalline materials have a high degree
of order over many atomic or molecular dimensions. These ordered regions, or single-crystal regions, vary in size and orientation with respect to one another. The single-crystal regions are called grains and are separated from one another by grain boundaries. Single-crystal materials, ideally, have a high degree of order, or regular geometric periodicity, throughout the entire volume of the material. The advantage of a single-crystal material is that, in general, its electrical properties are superior to those of a nonsingle-crystal material, since grain boundaries tend to degrade the electrical characteristics. Two-dimensional representations of amorphous, polycrystalline, and single-crystal materials are shown in Figure 1.1.

1.3 | SPACE LATTICES

Our primary concern will be the single crystal with its regular geometric periodicity in the atomic arrangement. A representative unit, or group of atoms, is repeated at regular intervals in each of the three dimensions to form the single crystal. The periodic arrangement of atoms in the crystal is called the lattice.

1.3.1 Primitive and Unit Cell

We can represent a particular atomic array by a dot that is called a lattice point. Figure 1.2 shows an infinite two-dimensional array of lattice points. The simplest means of repeating an atomic array is by translation. Each lattice point in Figure 1.2 can be translated a distance \( a_1 \) in one direction and a distance \( b_1 \) in a second noncolinear direction to generate the two-dimensional lattice. A third noncolinear translation will produce the three-dimensional lattice. The translation directions need not be perpendicular.

Since the three-dimensional lattice is a periodic repetition of a group of atoms, we do not need to consider the entire lattice, but only a fundamental unit that is being repeated. A unit cell is a small volume of the crystal that can be used to reproduce the entire crystal. A unit cell is not a unique entity. Figure 1.3 shows several possible unit cells in a two-dimensional lattice.

![Figure 1.2](image1.png) Two-dimensional representation of a single-crystal lattice.

![Figure 1.3](image2.png) Two-dimensional representation of a single-crystal lattice showing various possible unit cells.
CHAPTER 1

The Crystal Structure of Solids

Figure 1.4 | A generalized primitive unit cell.

The unit cell A can be translated in directions $a_2$ and $b_2$, the unit cell B can be translated in directions $a_3$ and $b_3$, and the entire two-dimensional lattice can be constructed by the translations of either of these unit cells. The unit cells C and D in Figure 1.3 can also be used to construct the entire lattice by using the appropriate translations. This discussion of two-dimensional unit cells can easily be extended to three dimensions to describe a real single-crystal material.

A primitive cell is the smallest unit cell that can be repeated to form the lattice. In many cases, it is more convenient to use a unit cell that is not a primitive cell. Unit cells may be chosen that have orthogonal sides, for example, whereas the sides of a primitive cell may be nonorthogonal.

A generalized three-dimensional unit cell is shown in Figure 1.4. The relationship between this cell and the lattice is characterized by three vectors $\vec{a}$, $\vec{b}$, and $\vec{c}$, which need not be perpendicular and which may or may not be equal in length. Every equivalent lattice point in the three-dimensional crystal can be found using the vector

$$\vec{r} = p\vec{a} + q\vec{b} + s\vec{c} \quad (1.1)$$

where $p$, $q$, and $s$ are integers. Since the location of the origin is arbitrary, we will let $p$, $q$, and $s$ be positive integers for simplicity.

1.3.2 Basic Crystal Structures

Before we discuss the semiconductor crystal, let us consider three crystal structures and determine some of the basic characteristics of these crystals. Figure 1.5 shows the simple cubic, body-centered cubic, and face-centered cubic structures. For these simple structures, we may choose unit cells such that the general vectors $\vec{a}$, $\vec{b}$, and $\vec{c}$ are perpendicular to each other and the lengths are equal. The simple cubic (sc) structure has an atom located at each corner; the body-centered cubic (bcc) structure has an additional atom at the center of the cube; and the face-centered cubic (fcc) structure has additional atoms on each face plane.

By knowing the crystal structure of a material and its lattice dimensions, we can determine several characteristics of the crystal. For example, we can determine the volume density of atoms.
Figure 1.5 | Three lattice types: (a) simple cubic, (b) body-centered cubic, (c) face-centered cubic.

Objective

EXAMPLE 1.1

To find the volume density of atoms in a crystal.

Consider a single-crystal material that is a body-centered cubic with a lattice constant \( a = 5 \text{ Å} = 5 \times 10^{-8} \text{ cm} \). A corner atom is shared by eight unit cells which meet at each corner so that each corner atom effectively contributes one-eighth of its volume to each unit cell. The eight corner atoms then contribute an equivalent of one atom to the unit cell. If we add the body-centered atom to the corner atoms, each unit cell contains an equivalent of two atoms.

Solution

The volume density of atoms is then found as

\[
\text{Density} = \frac{2 \text{ atoms}}{(5 \times 10^{-8})^3} = 1.6 \times 10^{23} \text{ atoms per cm}^3
\]

Comment

The volume density of atoms just calculated represents the order of magnitude of density for most materials. The actual density is a function of the crystal type and crystal structure since the packing density—number of atoms per unit cell—depends on crystal structure.

TEST YOUR UNDERSTANDING

E1.1 The lattice constant of a face-centered-cubic structure is 4.75 Å. Determine the volume density of atoms. (\( \text{E1.1: } V \times \text{cm}^3 \times \text{a} \times \text{su} \))

E1.2 The volume density of atoms for a simple cubic lattice is \( 3 \times 10^{22} \text{ cm}^{-3} \). Assume that the atoms are hard spheres with each atom touching its nearest neighbor. Determine the lattice constant and the radius of the atom. (\( \mathcal{V} \times 19^1 = 1 \times \mathcal{V} \times \mathcal{C} = 6 \mathcal{O} \times \mathcal{U} \))

1.3.3 Crystal Planes and Miller Indices

Since real crystals are not infinitely large, they eventually terminate at a surface. Semiconductor devices are fabricated at or near a surface, so the surface properties
CHAPTER 1  The Crystal Structure of Solids

may influence the device characteristics. We would like to be able to describe these surfaces in terms of the lattice. Surfaces, or planes through the crystal, can be described by first considering the intercepts of the plane along the \(\bar{a}, \bar{b},\) and \(\bar{c}\) axes used to describe the lattice.

**EXAMPLE 1.2**

**Objective**

To describe the plane shown in Figure 1.6. (The lattice points in Figure 1.6 are shown along the \(\bar{a}, \bar{b},\) and \(\bar{c}\) axes only.)

![Figure 1.6](image)

**Solution**

From Equation (1.1), the intercepts of the plane correspond to \(p = 3, q = 2,\) and \(s = 1.\) Now write the reciprocals of the intercepts, which gives

\[
\left(\frac{1}{3}, \frac{1}{2}, \frac{1}{1}\right)
\]

Multiply by the lowest common denominator, which in this case is 6, to obtain \((2, 3, 6).\) The plane in Figure 1.6 is then referred to as the \((236)\) plane. The integers are referred to as the Miller indices. We will refer to a general plane as the \((hkl)\) plane.

**Comment**

We can show that the same three Miller indices are obtained for any plane that is parallel to the one shown in Figure 1.6. Any parallel plane is entirely equivalent to any other.

Three planes that are commonly considered in a cubic crystal are shown in Figure 1.7. The plane in Figure 1.7a is parallel to the \(\bar{b}\) and \(\bar{c}\) axes so the intercepts are given as \(p = 1, q = \infty,\) and \(s = \infty.\) Taking the reciprocal, we obtain the Miller indices as \((1, 0, 0),\) so the plane shown in Figure 1.7a is referred to as the \((100)\) plane. Again, any plane parallel to the one shown in Figure 1.7a and separated by an integral
number of lattice constants is equivalent and is referred to as the (100) plane. One advantage to taking the reciprocal of the intercepts to obtain the Miller indices is that the use of infinity is avoided when describing a plane that is parallel to an axis. If we were to describe a plane passing through the origin of our system, we would obtain infinity as one or more of the Miller indices after taking the reciprocal of the intercepts. However, the location of the origin of our system is entirely arbitrary and so, by translating the origin to another equivalent lattice point, we can avoid the use of infinity in the set of Miller indices.

For the simple cubic structure, the body-centered cubic, and the face-centered cubic, there is a high degree of symmetry. The axes can be rotated by 90° in each of the three dimensions and each lattice point can again be described by Equation (1.1) as

$$ \hat{r} = pa + qb + sc $$

Each face plane of the cubic structure shown in Figure 1.7a is entirely equivalent. These planes are grouped together and are referred to as the (100) set of planes.

We may also consider the planes shown in Figures 1.7b and 1.7c. The intercepts of the plane shown in Figure 1.7b are $p = 1$, $q = 1$, and $s = \infty$. The Miller indices are found by taking the reciprocal of these intercepts and, as a result, this plane is referred to as the (110) plane. In a similar way, the plane shown in Figure 1.7c is referred to as the (111) plane.

One characteristic of a crystal that can be determined is the distance between nearest equivalent parallel planes. Another characteristic is the surface concentration of atoms, number per square centimeter (#/cm²), that are cut by a particular plane. Again, a single-crystal semiconductor is not infinitely large and must terminate at some surface. The surface density of atoms may be important, for example, in determining how another material, such as an insulator, will "fit" on the surface of a semiconductor material.
EXAMPLE 1.3

Objective

To calculate the surface density of atoms on a particular plane in a crystal.

Consider the body-centered cubic structure and the (110) plane shown in Figure 1.8a. Assume the atoms can be represented as hard spheres with the closest atoms touching each other. Assume the lattice constant is \( a_1 = 5 \) Å. Figure 1.8b shows how the atoms are cut by the (110) plane.

The atom at each corner is shared by four similar equivalent lattice planes, so each corner atom effectively contributes one-fourth of its area to this lattice plane as indicated in the figure. The four corner atoms then effectively contribute one atom to this lattice plane. The atom in the center is completely enclosed in the lattice plane. There is no other equivalent plane that cuts the center atom and the corner atoms, so the entire center atom is included in the number of atoms in the crystal plane. The lattice plane in Figure 1.8b, then, contains two atoms.

![Diagram of the (110) plane in a body-centered cubic structure and the atoms cut by the (110) plane.](image)

**Figure 1.8** (a) The (110) plane in a body-centered cubic and (b) the atoms cut by the (110) plane in a body-centered cubic.

**Solution**

We find the surface density by dividing the number of lattice atoms by the surface area, or in this case

\[
\text{Surface density} = \frac{2 \text{ atoms}}{(a_1)(a_1 \sqrt{2})} = \frac{2}{(5 \times 10^{-8})^2(\sqrt{2})}
\]

which is

\[5.66 \times 10^{13} \text{ atoms/cm}^2\]

**Comment**

The surface density of atoms is a function of the particular crystal plane in the lattice and generally varies from one crystal plane to another.
E1.3 Determine the distance between nearest (110) planes in a simple cubic lattice with a lattice constant of \( a_0 = 4.83 \, \text{Å} \).

E1.4 The lattice constant of a face-centered-cubic structure is 4.75 Å. Calculate the surface density of atoms for (a) a (100) plane and (b) a (110) plane.

In addition to describing crystal planes in a lattice, we may want to describe a particular direction in the crystal. The direction can be expressed as a set of three integers which are the components of a vector in that direction. For example, the body diagonal in a simple cubic lattice is composed of vector components 1, 1, 1. The body diagonal is then described as the \([111]\) direction. The brackets are used to designate direction as distinct from the parentheses used for the crystal planes. The three basic directions and the associated crystal planes for the simple cubic structure are shown in Figure 1.9. Note that in the simple cubic lattices, the \([hkl]\) direction is perpendicular to the \((hkl)\) plane. This perpendicularity may not be true in noncubic lattices.

1.3.4 The Diamond Structure

As already stated, silicon is the most common semiconductor material. Silicon is referred to as a group IV element and has a diamond crystal structure. Germanium is also a group IV element and has the same diamond structure. A unit cell of the diamond structure, shown in Figure 1.10, is more complicated than the simple cubic structures that we have considered up to this point.

We may begin to understand the diamond lattice by considering the tetrahedral structure shown in Figure 1.11. This structure is basically a body-centered cubic with...
The diamond structure has four of the corner atoms missing. Every atom in the tetrahedral structure has four nearest neighbors and it is this structure which is the basic building block of the diamond lattice.

There are several ways to visualize the diamond structure. One way to gain a further understanding of the diamond lattice is by considering Figure 1.12. Figure 1.12a shows two body-centered cubic, or tetrahedral, structures diagonally adjacent to each other. The shaded circles represent atoms in the lattice that are generated when the structure is translated to the right or left, one lattice constant, \(a\). Figure 1.12b represents the top half of the diamond structure. The top half again consists of two tetrahedral structures joined diagonally, but which are at \(90^\circ\) with respect to the bottom-half diagonal. An important characteristic of the diamond lattice is that any atom within the diamond structure will have four nearest neighboring atoms. We will note this characteristic again in our discussion of atomic bonding in the next section.
1.4 Atomic Bonding

1.4.1 Atomic Bonding

We have been considering various single-crystal structures. The question arises as to why one particular crystal structure is favored over another for a particular assembly of atoms. A fundamental law of nature is that the total energy of a system in thermal equilibrium tends to reach a minimum value. The interaction that occurs between atoms to form a solid and to reach the minimum total energy depends on the type of atom or atoms involved. The type of bond, or interaction, between atoms then, depends on the particular atom or atoms in the crystal. If there is not a strong bond between atoms, they will not "stick together" to create a solid.

**TEST YOUR UNDERSTANDING**

E1.5 The lattice constant of silicon is 5.43 Å. Calculate the volume density of silicon atoms. (\( \frac{1}{2820} \times \frac{1}{2820} \times \frac{1}{2820} \))
The interaction between atoms can be described by quantum mechanics. Although an introduction to quantum mechanics is presented in the next chapter, the quantum-mechanical description of the atomic bonding interaction is still beyond the scope of this text. We can nevertheless obtain a qualitative understanding of how various atoms interact by considering the valence, or outermost, electrons of an atom.

The atoms at the two extremes of the periodic table (excepting the inert elements) tend to lose or gain valence electrons, thus forming ions. These ions then essentially have complete outer energy shells. The elements in group I of the periodic table tend to lose their one electron and become positively charged, while the elements in group VII tend to gain an electron and become negatively charged. These oppositely charged ions then experience a coulomb attraction and form a bond referred to as an ionic bond. If the ions were to get too close, a repulsive force would become dominant, so an equilibrium distance results between these two ions. In a crystal, negatively charged ions tend to be surrounded by positively charged ions and positively charged ions tend to be surrounded by negatively charged ions, so a periodic array of the atoms is formed to create the lattice. A classic example of ionic bonding is sodium chloride.

The interaction of atoms tends to form closed valence shells such as we see in ionic bonding. Another atomic bond that tends to achieve closed-valence energy shells is covalent bonding, an example of which is found in the hydrogen molecule. A hydrogen atom has one electron and needs one more electron to complete the lowest energy shell. A schematic of two noninteracting hydrogen atoms, and the hydrogen molecule with the covalent bonding, are shown in Figure 1.15. Covalent bonding results in electrons being shared between atoms, so that in effect the valence energy shell of each atom is full.

Atoms in group 1V of the periodic table, such as silicon and germanium, also tend to form covalent bonds. Each of these elements has four valence electrons and needs four more electrons to complete the valence energy shell. If a silicon atom, for example, has four nearest neighbors, with each neighbor atom contributing one valence electron to be shared, then the center atom will in effect have eight electrons in its outer shell. Figure 1.16a schematically shows five noninteracting silicon atoms with the four valence electrons around each atom. A two-dimensional representation...
of the covalent bonding in silicon is shown in Figure 1.16b. The center atom has eight shared valence electrons.

A significant difference between the covalent bonding of hydrogen and of silicon is that, when the hydrogen molecule is formed, it has no additional electrons to form additional covalent bonds, while the outer silicon atoms always have valence electrons available for additional covalent bonding. The silicon array may then be formed into an infinite crystal, with each silicon atom having four nearest neighbors and eight shared electrons. The four nearest neighbors in silicon forming the covalent bond correspond to the tetrahedral structure and the diamond lattice, which were shown in Figures 1.11 and 1.10, respectively. Atomic bonding and crystal structure are obviously directly related.

The third major atomic bonding scheme is referred to as metallic bonding. Group I elements have one valence electron. If two sodium atoms (Z = 11), for example, are brought into close proximity, the valence electrons interact in a way similar to that in covalent bonding. When a third sodium atom is brought into close proximity with the first two, the valence electrons can also interact and continue to form a bond. Solid sodium has a body-centered cubic structure, so each atom has eight nearest neighbors with each atom sharing many valence electrons. We may think of the positive metallic ions as being surrounded by a sea of negative electrons, the solid being held together by the electrostatic forces. This description gives a qualitative picture of the metallic bond.

A fourth type of atomic bond, called the Van der Waals bond, is the weakest of the chemical bonds. A hydrogen fluoride (HF) molecule, for example, is formed by an ionic bond. The effective center of the positive charge of the molecule is not the same as the effective center of the negative charge. This nonsymmetry in the charge distribution results in a small electric dipole that can interact with the dipoles of other HF molecules. With these weak interactions, solids formed by the Van der Waals bonds have a relatively low melting temperature—in fact, most of these materials are in gaseous form at room temperature.

1.5.1 Imperfections in Solids

Up to this point, we have been considering an ideal single-crystal structure. In a real crystal, the lattice is not perfect, but contains imperfections or defects; that is, the perfect geometric periodicity is disrupted in some manner. Imperfections tend to alter the electrical properties of a material and, in some cases, electrical parameters can be dominated by these defects or impurities.
Crystal Structure of Solids

Figure 1.17 | Two-dimensional representation of a single-crystal lattice showing (a) a vacancy defect and (b) an interstitial defect.

crystal, however, have a certain thermal energy, which is a function of temperature. The thermal energy causes the atoms to vibrate in a random manner about an equilibrium lattice point. This random thermal motion causes the distance between atoms to randomly fluctuate, slightly disrupting the perfect geometric arrangement of atoms. This imperfection, called lattice vibrations, affects some electrical parameters, as we will see later in our discussion of semiconductor material characteristics.

Another type of defect is called a point defect. There are several of this type that we need to consider. Again, in an ideal single-crystal lattice, the atoms are arranged in a perfect periodic arrangement. However, in a real crystal, an atom may be missing from a particular lattice site. This defect is referred to as a vacancy; it is schematically shown in Figure 1.17a. In another situation, an atom may be located between lattice sites. This defect is referred to as an interstitial and is schematically shown in Figure 1.17b. In the case of vacancy and interstitial defects, not only is the perfect geometric arrangement of atoms broken, but also the ideal chemical bonding between atoms is disrupted, which tends to change the electrical properties of the material. A vacancy and interstitial may be in close enough proximity to exhibit an interaction between the two point defects. This vacancy-interstitial defect, also known as a Frenkel defect, produces different effects than the simple vacancy or interstitial.

The point defects involve single atoms or single-atom locations. In forming single-crystal materials, more complex defects may occur. A line defect, for example, occurs when an entire row of atoms is missing from its normal lattice site. This defect is referred to as a line dislocation and is shown in Figure 1.18. As with a point defect, a line dislocation disrupts both the normal geometric periodicity of the lattice and the ideal atomic bonds in the crystal. This dislocation can also alter the electrical properties of the material, usually in a more unpredictable manner than the simple point defects.

Other complex dislocations can also occur in a crystal lattice. However, this introductory discussion is intended only to present a few of the basic types of defect, and to show that a real crystal is not necessarily a perfect lattice structure. The effect of these imperfections on the electrical properties of a semiconductor will be considered in later chapters.
1.5.2 Impurities in Solids

Foreign atoms, or impurity atoms, may be present in a crystal lattice. Impurity atoms may be located at normal lattice sites, in which case they are called substitutional impurities. Impurity atoms may also be located between normal sites, in which case they are called interstitial impurities. Both these impurities are lattice defects and are schematically shown in Figure 1.19. Some impurities, such as oxygen in silicon, tend to be essentially inert; however, other impurities, such as gold or phosphorus in silicon, can drastically alter the electrical properties of the material.

In Chapter 4 we will see that, by adding controlled amounts of particular impurity atoms, the electrical characteristics of a semiconductor material can be favorably altered. The technique of adding impurity atoms to a semiconductor material in order to change its conductivity is called doping. There are two general methods of doping: impurity diffusion and ion implantation.

The actual diffusion process depends to some extent on the material but, in general, impurity diffusion occurs when a semiconductor crystal is placed in a high-temperature (≈ 1000°C) gaseous atmosphere containing the desired impurity atom. At this high temperature, many of the crystal atoms can randomly move in and out of their single-crystal lattice sites. Vacancies may be created by this random motion so
that impurity atoms can move through the lattice by hopping from one vacancy to another. Impurity diffusion is the process by which impurity particles move from a region of high concentration near the surface, to a region of lower concentration within the crystal. When the temperature decreases, the impurity atoms become permanently frozen into the substitutional lattice sites. Diffusion of various impurities into selected regions of a semiconductor allows us to fabricate complex electronic circuits in a single semiconductor crystal.

Ion implantation generally takes place at a lower temperature than diffusion. A beam of impurity ions is accelerated to kinetic energies in the range of 50 keV or greater and then directed to the surface of the semiconductor. The high-energy impurity ions enter the crystal and come to rest at some average depth from the surface. One advantage of ion implantation is that controlled numbers of impurity atoms can be introduced into specific regions of the crystal. A disadvantage of this technique is that the incident impurity atoms collide with the crystal atoms, causing lattice-displacement damage. However, most of the lattice damage can be removed by thermal annealing, in which the temperature of the crystal is raised for a short time. Thermal annealing is a required step after implantation.

*1.6 | GROWTH OF SEMICONDUCTOR MATERIALS*

The success in fabricating very large scale integrated (VLSI) circuits is a result, to a large extent, of the development of and improvement in the formation or growth of pure single-crystal semiconductor materials. Semiconductors are some of the purest materials. Silicon, for example, has concentrations of most impurities of less than 1 part in 10 billion. The high purity requirement means that extreme care is necessary in the growth and the treatment of the material at each step of the fabrication process. The mechanics and kinetics of crystal growth are extremely complex and will be described in only very general terms in this text. However, a general knowledge of the growth techniques and terminology is valuable.

1.6.1 Growth from a Melt

A common technique for growing single-crystal materials is called the Czochralski method. In this technique, a small piece of single-crystal material, known as a seed, is brought into contact with the surface of the same material in liquid phase, and then slowly pulled from the melt. As the seed is slowly pulled, solidification occurs along the plane between the solid-liquid interface. Usually the crystal is also rotated slowly as it is being pulled, to provide a slight stirring action to the melt, resulting in a more uniform temperature. Controlled amounts of specific impurity atoms, such as boron or phosphorus, may be added to the melt so that the grown semiconductor crystal is intentionally doped with the impurity atom. Figure 1.20 shows a schematic of the Czochralski growth process and a silicon ingot or boule grown by this process.

*Indicates sections that can be skipped without loss of continuity.*
Figure 1.20  (a) Model of a crystal puller and (b) photograph of a silicon wafer with an array of integrated circuits. The circuits are tested on the wafer then sawed apart into chips that are mounted into packages. (Photo courtesy of Intel Corporation.)
Some impurities may be present in the ingot that are undesirable. Zone refining is a common technique for purifying material. A high-temperature coil, or r-f induction coil, is slowly passed along the length of the boule. The temperature induced by the coil is high enough so that a thin layer of liquid is formed. At the solid–liquid interface, there is a distribution of impurities between the two phases. The parameter that describes this distribution is called the segregation coefficient: the ratio of the concentration of impurities in the solid to the concentration in the liquid. If the segregation coefficient is 0.1, for example, the concentration of impurities in the liquid is a factor of 10 greater than that in the solid. As the liquid zone moves through the material, the impurities are driven along with the liquid. After several passes of the r-f coil, most impurities are at the end of the bar, which can then be cut off. The moving molten zone, or the zone-refining technique, can result in considerable purification.

After the semiconductor is grown, the boule is mechanically trimmed to the proper diameter and a flat is ground over the entire length of the boule to denote the crystal orientation. The flat is perpendicular to the [110] direction or indicates the (110) plane. (See Figure 1.20b.) This then allows the individual chips to be fabricated along given crystal planes so that the chips can be sawed apart more easily. The boule is then sliced into wafers. The wafer must be thick enough to mechanically support itself. A mechanical two-sided lapping operation produces a flat wafer of uniform thickness. Since the lapping procedure can leave a surface damaged and contaminated by the mechanical operation, the surface must be removed by chemical etching. The final step is polishing. This provides a smooth surface on which devices may be fabricated or further growth processes may be carried out. This final semiconductor wafer is called the substrate material.

### 1.6.2 Epitaxial Growth

A common and versatile growth technique that is used extensively in device and integrated circuit fabrication is epitaxial growth. Epitaxial growth is a process whereby a thin, single-crystal layer of material is grown on the surface of a single-crystal substrate. In the epitaxial process, the single-crystal substrate acts as the seed, although the process takes place far below the melting temperature. When an epitaxial layer is grown on a substrate of the same material, the process is termed homoepitaxy. Growing silicon on a silicon substrate is one example of a homoepitaxy process. At present, a great deal of work is being done with heteroepitaxy. In a heteroepitaxy process, although the substrate and epitaxial materials are not the same, the two crystal structures should be very similar if single-crystal growth is to be obtained and if a large number of defects are to be avoided at the epitaxial–substrate interface. Growing epitaxial layers of the ternary alloy AlGaAs on a GaAs substrate is one example of a heteroepitaxy process.

One epitaxial growth technique that has been used extensively is called chemical vapor-phase deposition (CVD). Silicon epitaxial layers, for example, are grown on silicon substrates by the controlled deposition of silicon atoms onto the surface from a chemical vapor containing silicon. In one method, silicon tetrachloride reacts with hydrogen at the surface of a heated substrate. The silicon atoms are released in
the reaction and can be deposited onto the substrate, while the other chemical reagent, HCl, is in gaseous form and is swept out of the reactor. A sharp demarcation between the impurity doping in the substrate and in the epitaxial layer can be achieved using the CVD process. This technique allows great flexibility in the fabrication of semiconductor devices.

**Liquid-phase epitaxy** is another epitaxial growth technique. A compound of the semiconductor with another element may have a melting temperature lower than that of the semiconductor itself. The semiconductor substrate is held in the liquid compound and, since the temperature of the melt is lower than the melting temperature of the substrate, the substrate does not melt. As the solution is slowly cooled, a single-crystal semiconductor layer grows on the seed crystal. This technique, which occurs at a lower temperature than the Czochralski method, is useful in growing group III–V compound semiconductors.

A versatile technique for growing epitaxial layers is the *molecular beam epitaxy* (MBE) process. A substrate is held in vacuum at a temperature normally in the range of 400 to 800°C, a relatively low temperature compared with many semiconductor-processing steps. Semiconductor and dopant atoms are then evaporated onto the surface of the substrate. In this technique, the doping can be precisely controlled resulting in very complex doping profiles. Complex ternary compounds, such as AlGaAs, can be grown on substrates, such as GaAs, where abrupt changes in the crystal composition are desired. Many layers of various types of epitaxial compositions can be grown on a substrate in this manner. These structures are extremely beneficial in optical devices such as laser diodes.

### 1.7 Summary

- A few of the most common semiconductor materials were listed. Silicon is the most common semiconductor material.
- The properties of semiconductors and other materials are determined to a large extent by the single-crystal lattice structure. The unit cell is a small volume of the crystal that is used to reproduce the entire crystal. Three basic unit cells are the simple cubic, body-centered cubic, and face-centered cubic.
- Silicon has the diamond crystal structure. Atoms are formed in a tetrahedral configuration with four nearest neighbor atoms. The binary semiconductors have a zincblende lattice, that is basically the same as the diamond lattice.
- Miller indices are used to describe planes in a crystal lattice. These planes may be used to describe the surface of a semiconductor material. The Miller indices are also used to describe directions in a crystal.
- Imperfections do exist in semiconductor materials. A few of these imperfections are vacancies, substitutional impurities, and interstitial impurities. Small amounts of controlled substitutional impurities can favorably alter semiconductor properties as we will see in later chapters.
- A brief description of semiconductor growth methods was given. Bulk growth produces the starting semiconductor material or substrate. Epitaxial growth can be used to control the surface properties of a semiconductor. Most semiconductor devices are fabricated in the epitaxial layer.
GLOSSARY OF IMPORTANT TERMS

binary semiconductor  A two-element compound semiconductor, such as gallium arsenide (GaAs).
covalent bonding  The bonding between atoms in which valence electrons are shared.
diamond lattice  The atomic crystal structure of silicon, for example, in which each atom has four nearest neighbors in a tetrahedral configuration.
doping  The process of adding specific types of atoms to a semiconductor to favorably alter the electrical characteristics.
elemental semiconductor  A semiconductor composed of a single species of atom, such as silicon or germanium.
epitaxial layer  A thin, single-crystal layer of material formed on the surface of a substrate.
ion implantation  One particular process of doping a semiconductor.
lattice  The periodic arrangement of atoms in a crystal.
Miller indices  The set of integers used to describe a crystal plane.
primitive cell  The smallest unit cell that can be repeated to form a lattice.
substrate  A semiconductor wafer or other material used as the starting material for further semiconductor processing, such as epitaxial growth or diffusion.
ternary semiconductor  A three-element compound semiconductor, such as aluminum gallium arsenide (AlGaAs).
unit cell  A small volume of a crystal that can be used to reproduce the entire crystal.
zincblende lattice  A lattice structure identical to the diamond lattice except that there are two types of atoms instead of one.

CHECKPOINT

After studying this chapter, the reader should have the ability to:

- Determine the volume density of atoms for various lattice structures.
- Determine the Miller indices of a crystal-lattice plane.
- Sketch a lattice plane given the Miller indices.
- Determine the surface density of atoms on a given crystal-lattice plane.
- Understand and describe various defects in a single-crystal lattice.

REVIEW QUESTIONS

1. List two elemental semiconductor materials and two compound semiconductor materials.
2. Sketch three lattice structures: (a) simple cubic, (b) body-centered cubic, and (c) face-centered cubic.
3. Describe the procedure for finding the volume density of atoms in a crystal.
4. Describe the procedure for obtaining the Miller indices that describe a plane in a crystal.
5. What is meant by a substitutional impurity in a crystal? What is meant by an interstitial impurity?
PROBLEMS

Section 1.3 Space Lattices

1.1 Determine the number of atoms per unit cell in a (a) face-centered cubic, (b) body-centered cubic, and (c) diamond lattice.

1.2 (a) The lattice constant of GaAs is 5.65 Å. Determine the number of Ga atoms and As atoms per cm³. (b) Determine the volume density of germanium atoms in a germanium semiconductor. The lattice constant of germanium is 5.65 Å.

1.3 Assume that each atom is a hard sphere with the surface of each atom in contact with the surface of its nearest neighbor. Determine the percentage of total unit cell volume that is occupied in (a) a simple cubic lattice, (b) a face-centered cubic lattice, (c) a body-centered cubic lattice, and (d) a diamond lattice.

1.4 A material, with a volume of 1 cm³, is composed of an fcc lattice with a lattice constant of 2.5 mm. The “atoms” in this material are actually coffee beans. Assume the coffee beans are hard spheres with each bean touching its nearest neighbor. Determine the volume of coffee after the coffee beans have been ground. (Assume 100 percent packing density of the ground coffee.)

1.5 If the lattice constant of silicon is 5.43 Å, calculate (a) the distance from the center of one silicon atom to the center of its nearest neighbor, (b) the number density of silicon atoms (# per cm³), and (c) the mass density (grams per cm³) of silicon.

1.6 A crystal is composed of two elements, A and B. The basic crystal structure is a body-centered cubic with elements A at each of the corners and element B in the center. The effective radius of element A is 1.02 Å. Assume the elements are hard spheres with the surface of each A-type atom in contact with the surface of its nearest A-type neighbor. Calculate (a) the maximum radius of the B-type atom that will fit into this structure, and (b) the volume density (#/cm³) of both the A-type atoms and the B-type atoms.

1.7 The crystal structure of sodium chloride (NaCl) is a simple cubic with the Na and Cl atoms alternating positions. Each Na atom is then surrounded by six Cl atoms and likewise each Cl atom is surrounded by six Na atoms. (a) Sketch the atoms in a (100) plane. (b) Assume the atoms are hard spheres with nearest neighbors touching. The effective radius of Na is 1.0 Å and the effective radius of Cl is 1.8 Å. Determine the lattice constant, (c) Calculate the volume density of Na and Cl atoms. (d) Calculate the mass density of NaCl.

1.8 (a) A material is composed of two types of atoms. Atom A has an effective radius of 2.2 Å and atom B has an effective radius of 1.8 Å. The lattice is a bcc with atoms A at the corners and atom B in the center. Determine the lattice constant and the volume densities of A atoms and B atoms. (b) Repeat part (a) with atoms B at the corners and atom A in the center. (c) What comparison can be made of the materials in parts (a) and (b)?

1.9 Consider the materials described in Problem 1.8 in parts (a) and (b). For each case, calculate the surface density of A atoms and B atoms in the (110) plane. What comparison can be made of the two materials?

1.10 (a) The crystal structure of a particular material consists of a single atom in the center of a cube. The lattice constant is a₀ and the diameter of the atom is a₀. Determine the volume density of atoms and the surface density of atoms in the (110) plane.
(b) Compare the results of part (a) to the results for the case of the simple cubic structure shown in Figure 1.5a with the same lattice constant.
1.11 Consider a three-dimensional cubic lattice with a lattice constant equal to $a$. (a) Sketch the following planes: (i) $(100)$, (ii) $(110)$, (iii) $(310)$, and (iv) $(230)$. (b) Sketch the following directions: (i) $[100]$, (ii) $[110]$, (iii) $[310]$, and (iv) $[230]$. 

1.12 For a simple cubic lattice, determine the Miller indices for the planes shown in Figure 1.21.

1.13 The lattice constant of a simple cubic cell is 5.63 Å. Calculate the distance between the nearest parallel (a) $(100)$, (b) $(110)$, and (c) $(111)$ planes.

1.14 The lattice constant of a single crystal is 4.50 Å. Calculate the surface density of atoms (# per cm$^2$) on the following planes: (i) $(100)$, (ii) $(110)$, (iii) $(111)$ for each of the following lattice structures: (a) simple cubic, (b) body-centered cubic, and (c) face-centered cubic.

1.15 Determine the surface density of atoms for silicon on the (a) $(100)$ plane, (b) $(110)$ plane, and (c) $(111)$ plane.

1.16 Consider a face-centered cubic lattice. Assume the atoms are hard spheres with the surfaces of the nearest neighbors touching. Assume the radius of the atom is 2.25 Å. (a) Calculate the volume density of atoms in the crystal. (b) Calculate the distance between nearest $(110)$ planes. (c) Calculate the surface density of atoms on the $(110)$ plane.

Section 1.4 Atomic Bonding

1.17 Calculate the density of valence electrons in silicon.

1.18 The structure of GaAs is the zincblende lattice. The lattice constant is 5.65 Å. Calculate the density of valence electrons in GaAs.
Section 1.5 Imperfections and Impurities in Solids

1.19 (a) If $2 \times 10^{16}$ boron atoms per cm$^3$ are added to silicon as a substitutional impurity, determine what percentage of the silicon atoms are displaced in the single crystal lattice. (b) Repeat part (a) for $10^{15}$ boron atoms per cm$^3$.

1.20 (a) Phosphorus atoms, at a concentration of $5 \times 10^{16}$ cm$^{-3}$, are added to a pure sample of silicon. Assume the phosphorus atoms are distributed homogeneously throughout the silicon. What is the fraction by weight of phosphorus? (b) If boron atoms, at a concentration of $10^{18}$ cm$^{-3}$, are added to the material in part (a), determine the fraction by weight of boron.

1.21 If $2 \times 10^{15}$ gold atoms per cm$^3$ are added to silicon as a substitutional impurity and are distributed uniformly throughout the semiconductor, determine the distance between gold atoms in terms of the silicon lattice constant. (Assume the gold atoms are distributed in a rectangular or cubic array.)

READING LIST


*Indicates references that are at an advanced level compared to this text.
The goal of this text is to help readers understand the operation and characteristics of semiconductor devices. Ideally, we would like to begin discussing these devices immediately. However, in order to understand the current-voltage characteristics, we need some knowledge of the electron behavior in a crystal when the electron is subjected to various potential functions.

The motion of large objects, such as planets and satellites, can be predicted to a high degree of accuracy using classical theoretical physics based on Newton's laws of motion. But certain experimental results, involving electrons and high-frequency electromagnetic waves, appear to be inconsistent with classical physics. However, these experimental results can be predicted by the principles of quantum mechanics. The quantum mechanical wave theory is the basis for the theory of semiconductor physics.

We are ultimately interested in semiconductor materials whose electrical properties are directly related to the behavior of electrons in the crystal lattice. The behavior and characteristics of these electrons can be described by the formulation of quantum mechanics called wave mechanics. The essential elements of this wave mechanics, using Schrodinger's wave equation, are presented in this chapter.

The goal of this chapter is to provide a brief introduction to quantum mechanics so that readers gain an understanding of and become comfortable with the analysis techniques. This introductory material forms the basis of semiconductor physics.
2.1 PRINCIPLES OF QUANTUM MECHANICS

Before we delve into the mathematics of quantum mechanics, there are three principles we need to consider: the principle of energy quanta, the wave–particle duality principle, and the uncertainty principle.

2.1.1 Energy Quanta

One experiment that demonstrates an inconsistency between experimental results and the classical theory of light is called the photoelectric effect. If monochromatic light is incident on a clean surface of a material, then under certain conditions, electrons (photoelectrons) are emitted from the surface. According to classical physics, if the intensity of the light is large enough, the work function of the material will be overcome and an electron will be emitted from the surface independent of the incident frequency. This result is not observed. The observed effect is that, at a constant incident intensity, the maximum kinetic energy of the photoelectron varies linearly with frequency with a limiting frequency $\nu = \nu_0$, below which no photoelectron is produced. This result is shown in Figure 2.1. If the incident intensity varies at a constant frequency, the rate of photoelectron emission changes, but the maximum kinetic energy remains the same.

Planck postulated in 1900 that thermal radiation is emitted from a heated surface in discrete packets of energy called quanta. The energy of these quanta is given by $E = h\nu$, where $\nu$ is the frequency of the radiation and $h$ is a constant now known as Planck's constant ($h = 6.625 \times 10^{-34}$ J-s). Then in 1905, Einstein interpreted the photoelectric results by suggesting that the energy in a light wave is also contained in discrete packets or bundles. The particle-like packet of energy is called a photon, whose energy is also given by $E = h\nu$. A photon with sufficient energy, then, can knock an electron from the surface of the material. The minimum energy required to remove an electron is called the work function of the material.

\[
\begin{align*}
\text{Incident monochromatic light} & \quad \rightarrow \quad \text{Material} \\
\text{Photoelectron kinetic energy} = T & \quad \rightarrow \quad \text{Material}
\end{align*}
\]

**Figure 2.1** (a) The photoelectric effect and (b) the maximum kinetic energy of the photoelectron as a function of incident frequency.
and any excess photon energy goes into the kinetic energy of the photoelectron. This result was confirmed experimentally as demonstrated in Figure 2.1. The photoelectric effect shows the discrete nature of the photon and demonstrates the particle-like behavior of the photon.

The maximum kinetic energy of the photoelectron can be written as

$$T_{\text{max}} = \frac{1}{2}mv^2 = h\nu - h\nu_0 \quad (\nu \geq \nu_0) \quad (2.1)$$

where $h\nu$ is the incident photon energy and $h\nu_0$ is the minimum energy, or work function, required to remove an electron from the surface.

**EXAMPLE 2.1**

**Objective**

To calculate the photon energy corresponding to a particular wavelength.

Consider an x-ray with a wavelength of $\lambda = 0.708 \times 10^{-8}$ cm.

**Solution**

The energy is

$$E = h\nu = \frac{hc}{\lambda} = \frac{(6.625 \times 10^{-34}) (3 \times 10^{10})}{0.708 \times 10^{-8}} = 2.81 \times 10^{-15} \text{ J}$$

This value of energy may be given in the more common unit of electron-volt (see Appendix F). We have

$$E = \frac{2.81 \times 10^{-15}}{1.6 \times 10^{-19}} = 1.75 \times 10^4 \text{ eV}$$

**Comment**

The reciprocal relation between photon energy and wavelength is demonstrated: A large energy corresponds to a short wavelength.

**2.1.2 Wave–Particle Duality**

We have seen in the last section that light waves, in the photoelectric effect, behave as if they are particles. The particle-like behavior of electromagnetic waves was also instrumental in the explanation of the Compton effect. In this experiment, an x-ray beam was incident on a solid. A portion of the x-ray beam was deflected and the frequency of the deflected wave had shifted compared to the incident wave. The observed change in frequency and the deflected angle corresponded exactly to the expected results of a "billiard ball" collision between an x-ray quanta, or photon, and an electron in which both energy and momentum are conserved.

In 1924, de Broglie postulated the existence of matter waves. He suggested that since waves exhibit particle-like behavior, then particles should be expected to show wave-like properties. The hypothesis of de Broglie was the existence of a
wave–particle duality principle. The momentum of a photon is given by

$$p = \frac{h}{\lambda}$$  \hspace{1cm} (2.2)

where $\lambda$ is the wavelength of the light wave. Then, de Broglie hypothesized that the wavelength of a particle can be expressed as

$$\lambda = \frac{h}{p}$$  \hspace{1cm} (2.3)

where $p$ is the momentum of the particle and $\lambda$ is known as the de Broglie wavelength of the matter wave.

The wave nature of electrons has been tested in several ways. In one experiment by Davisson and Germer in 1927, electrons from a heated filament were accelerated at normal incidence onto a single crystal of nickel. A detector measured the scattered electrons as a function of angle. Figure 2.2 shows the experimental setup and Figure 2.3 shows the results. The existence of a peak in the density of scattered electrons can be explained as a constructive interference of waves scattered by the periodic atoms in the planes of the nickel crystal. The angular distribution is very similar to an interference pattern produced by light diffracted from a grating.

In order to gain some appreciation of the frequencies and wavelengths involved in the wave–particle duality principle, Figure 2.4 shows the electromagnetic frequency spectrum. We see that a wavelength of 72.7 Å obtained in the next example is in the ultraviolet range. Typically, we will be considering wavelengths in the
ultraviolet and visible range. These wavelengths are very short compared to the usual radio spectrum range.

**EXAMPLE 2.2**

**Objective**

To calculate the de Broglie wavelength of a particle.

Consider an electron traveling at a velocity of \(1 \times 10^7 \text{ cm/sec} = 10^5 \text{ m/s}.\)

**Solution**

The momentum is given by

\[
p = mv = (9.11 \times 10^{-31})(10^5) = 9.11 \times 10^{-26}
\]

Then, the de Broglie wavelength is

\[
\lambda = \frac{h}{p} = \frac{6.625 \times 10^{-34}}{9.11 \times 10^{-26}} = 7.27 \times 10^{-9} \text{ m}
\]

or

\[
\lambda = 72.7 \text{ Å}
\]

**Comment**

This calculation shows the order of magnitude of the de Broglie wavelength for a “typical” electron.

In some cases electromagnetic waves behave as if they are particles (photons) and sometimes particles behave as if they are waves. This wave-particle duality
principle of quantum mechanics applies primarily to small particles such as electrons, but it has also been shown to apply to protons and neutrons. For very large particles, we can show that the relevant equations reduce to those of classical mechanics. The wave-particle duality principle is the basis on which we will use wave theory to describe the motion and behavior of electrons in a crystal.

TEST YOUR UNDERSTANDING

**E2.1** Determine the energy of a photon having wavelengths of (a) $\lambda = 10.000 \text{ Å}$ and (b) $\lambda = 10 \text{ Å}$. \[ E = \frac{hc}{\lambda} \]

**E2.2** (a) Find the momentum and energy of a particle with mass of $5 \times 10^{-31} \text{ kg}$ and a de Broglie wavelength of 180 Å. (b) An electron has a kinetic energy of 20 meV. Determine the de Broglie wavelength. \[ p = \frac{h}{\lambda} = \frac{h\nu}{\lambda} \]

---

2.1.3 The Uncertainty Principle

The Heisenberg uncertainty principle, given in 1927, also applies primarily to very small particles, and states that we cannot describe with absolute accuracy the behavior of these subatomic particles. The uncertainty principle describes a fundamental relationship between conjugate variables, including position and momentum and also energy and time.

The first statement of the uncertainty principle is that it is impossible to simultaneously describe with absolute accuracy the position and momentum of a particle. If the uncertainty in the momentum is $\Delta p$ and the uncertainty in the position is $\Delta x$, then the uncertainty principle is stated as

$$\Delta p \Delta x \geq \hbar$$

where $\hbar$ is defined as $\hbar = h/2\pi = 1.054 \times 10^{-34} \text{ J-s}$ and is called a modified Planck's constant. This statement may be generalized to include angular position and angular momentum.

The second statement of the uncertainty principle is that it is impossible to simultaneously describe with absolute accuracy the energy of a particle and the instant of time the particle has this energy. Again, if the uncertainty in the energy is given by $\Delta E$ and the uncertainty in the time is given by $\Delta t$, then the uncertainty principle is stated as

$$\Delta E \Delta t \geq \hbar$$

One way to visualize the uncertainty principle is to consider the simultaneous measurement of position and momentum, and the simultaneous measurement of energy and time. The uncertainty principle implies that these simultaneous measurements

---

1In some texts, the uncertainty principle is stated as $\Delta p \Delta x \geq h/2$. We are interested here in the order of magnitude and will not be concerned with small differences.
are in error to a certain extent. However, the modified Planck's constant $\hbar$ is very small; the uncertainty principle is only significant for subatomic particles. We must keep in mind nevertheless that the uncertainty principle is a fundamental statement and does not deal only with measurements.

One consequence of the uncertainty principle is that we cannot, for example, determine the exact position of an electron. We will, instead, determine the probability of finding an electron at a particular position. In later chapters, we will develop a probability density function that will allow us to determine the probability that an electron has a particular energy. So in describing electron behavior, we will be dealing with probability functions.

**TEST YOUR UNDERSTANDING**

E2.3 The uncertainty in position of an electron is $12 \, \text{Å}$. Determine the minimum uncertainty in momentum and also the corresponding uncertainty in kinetic energy.

\[
\frac{\Delta x \Delta p}{\hbar} = \frac{\hbar}{2m} \times 12 \, \text{Å} \times 6 \times 10^{-8} = d \, \text{Å} \times \text{eV}
\]

E2.4 An electron's energy is measured with an uncertainty of $1.2 \, \text{eV}$. What is the minimum uncertainty in time over which the energy is measured?

\[
\hbar = m \times c \times 1 \, \text{Å} 
\]

**2.2 SCHRÖDINGER'S WAVE EQUATION**

The various experimental results involving electromagnetic waves and particles, which could not be explained by classical laws of physics, showed that a revised formulation of mechanics was required. Schrödinger, in 1926, provided a formulation called wave mechanics, which incorporated the principles of quanta introduced by Planck, and the wave-particle duality principle introduced by de Broglie. Based on the wave-particle duality principle, we will describe the motion of electrons in a crystal by wave theory. This wave theory is described by Schrödinger's wave equation.

**2.2.1 The Wave Equation**

The one-dimensional, nonrelativistic Schrödinger's wave equation is given by

\[
-\frac{\hbar^2}{2m} \frac{\partial^2 \Psi(x, t)}{\partial x^2} + V(x) \Psi(x, t) = j \hbar \frac{\partial \Psi(x, t)}{\partial t}
\]

(2.6)

where $\Psi(x, t)$ is the wave function, $V(x)$ is the potential function assumed to be independent of time, $m$ is the mass of the particle, and $j$ is the imaginary constant $\sqrt{-1}$. There are theoretical arguments that justify the form of Schrödinger's wave equation, but the equation is a basic postulate of quantum mechanics. The wave function $\Psi(x, t)$ will be used to describe the behavior of the system and, mathematically, $\Psi(x, t)$ can be a complex quantity.

We may determine the time-dependent portion of the wave function and the position-dependent, or time-independent, portion of the wave function by using the
technique of separation of variables. Assume that the wave function can be written in the form

\[ \psi(x, t) = \psi(x)\phi(t) \quad (2.7) \]

where \( \psi(x) \) is a function of the position \( x \) only and \( \phi(t) \) is a function of time \( t \) only. Substituting this form of the solution into Schrödinger's wave equation, we obtain

\[ -\frac{\hbar^2}{2m}\phi(t) \frac{\partial^2 \psi(x)}{\partial x^2} + V(x)\psi(x)\phi(t) = j\hbar\psi(x)\frac{\partial \phi(t)}{\partial t} \quad (2.8) \]

If we divide by the total wave function, Equation (2.8) becomes

\[ -\frac{\hbar^2}{2m}\frac{1}{\psi(x)} \frac{\partial^2 \psi(x)}{\partial x^2} + V(x) = j\hbar\frac{1}{\phi(t)} \frac{\partial \phi(t)}{\partial t} \quad (2.9) \]

Since the left side of Equation (2.9) is a function of position \( x \) only and the right side of the equation is a function of time \( t \) only, each side of this equation must be equal to a constant. We will denote this separation of variables constant by \( \eta \).

The time-dependent portion of Equation (2.9) is then written as

\[ \eta = j\hbar\frac{1}{\phi(t)} \frac{\partial \phi(t)}{\partial t} \quad (2.10) \]

where again the parameter \( \eta \) is called a separation constant. The solution of Equation (2.10) can be written in the form

\[ \phi(t) = e^{-j(E/\hbar)t} \quad (2.11) \]

The form of this solution is the classical exponential form of a sinusoidal wave where \( \eta/\hbar \) is the radian frequency \( \omega \). We have that \( E = \hbar \nu \) or \( E = \hbar \omega /2\pi \). Then \( \omega = \eta/\hbar = E/\hbar \) so that the separation constant is equal to the total energy \( E \) of the particle.

The time-independent portion of Schrödinger's wave equation can now be written from Equation (2.9) as

\[ -\frac{\hbar^2}{2m}\frac{1}{\psi(x)} \frac{\partial^2 \psi(x)}{\partial x^2} + V(x) = E \quad (2.12) \]

where the separation constant is the total energy \( E \) of the particle. Equation (2.12) may be written as

\[ \frac{\partial^2 \psi(x)}{\partial x^2} + \frac{2m}{\hbar^2} (E - V(x))\psi(x) = 0 \quad (2.13) \]

where again \( m \) is the mass of the particle, \( V(x) \) is the potential experienced by the particle, and \( E \) is the total energy of the particle. This time-independent Schrödinger's wave equation can also be justified on the basis of the classical wave equation as.
shown in Appendix E. The pseudo-derivation in the appendix is a simple approach but shows the plausibility of the time-independent Schrödinger's equation.

### 2.2.2 Physical Meaning of the Wave Function

We are ultimately trying to use the wave function $\Psi(x, t)$ to describe the behavior of an electron in a crystal. The function $\Psi(x, t)$ is a wave function, so it is reasonable to ask what the relation is between the function and the electron. The total wave function is the product of the position-dependent, or time-independent, function and the time-dependent function. We have from Equation (2.7) that

$$
\Psi(x, t) = \psi(x) \phi(t) = \psi(x)e^{-i(E/\hbar)t} \tag{2.14}
$$

Since the total wave function $\Psi(x, t)$ is a complex function, it cannot by itself represent a real physical quantity.

Max Born postulated in 1926 that the function $|\Psi(x, t)|^2 \, dx$ is the probability of finding the particle between $x$ and $x + dx$ at a given time, or that $|\Psi(x, t)|^2$ is a probability density function. We have that

$$
|\Psi(x, t)|^2 = \Psi(x, t) \cdot \Psi^*(x, t) \tag{2.15}
$$

where $\Psi^*(x, t)$ is the complex conjugate function. Therefore

$$
\Psi^*(x, t) = \psi^*(x) e^{+i(E/\hbar)t} \tag{2.16}
$$

Then the product of the total wave function and its complex conjugate is given by

$$
\Psi(x, t)\Psi^*(x, t) = [\psi(x)e^{-i(E/\hbar)t}][\psi^*(x)e^{+i(E/\hbar)t}] = \psi(x)\psi^*(x) \tag{2.17}
$$

Therefore, we have that

$$
|\Psi(x, t)|^2 = \psi(x)\psi^*(x) = |\psi(x)|^2 \tag{2.18}
$$

is the probability density function and is independent of time. One major difference between classical and quantum mechanics is that in classical mechanics, the position of a particle or body can be determined precisely, whereas in quantum mechanics, the position of a particle is found in terms of a probability. We will determine the probability density function for several examples, and, since this property is independent of time, we will, in general, only be concerned with the time-independent wave function.

### 2.2.3 Boundary Conditions

Since the function $|\Psi(x, t)|^2$ represents the probability density function, then for a single particle, we must have that

$$
\int_{-\infty}^{\infty} |\psi(x)|^2 \, dx = 1 \tag{2.18}
$$
The probability of finding the particle somewhere is certain. Equation (2.18) allows us to normalize the wave function and is one boundary condition that is used to determine some wave function coefficients.

The remaining boundary conditions imposed on the wave function and its derivative are postulates. However, we may state the boundary conditions and present arguments that justify why they must be imposed. The wave function and its first derivative must have the following properties if the total energy $E$ and the potential $V(x)$ are finite everywhere.

Condition 1. $\psi(x)$ must be finite, single-valued, and continuous.
Condition 2. $\frac{\partial \psi(x)}{\partial x}$ must be finite, single-valued, and continuous.

Since $|\psi(x)|^2$ is a probability density, then $\psi(x)$ must be finite and single-valued. If the probability density were to become infinite at some point in space, then the probability of finding the particle at this position would be certain and the uncertainty principle would be violated. If the total energy $E$ and the potential $V(x)$ are finite everywhere, then from Equation (2.13), the second derivative must be finite, which implies that the first derivative must be continuous. The first derivative is related to the particle momentum, which must be finite and single-valued. Finally, a finite first derivative implies that the function itself must be continuous. In some of the specific examples that we will consider, the potential function will become infinite in particular regions of space. For these cases, the first derivative will not necessarily be continuous, but the remaining boundary conditions will still hold.

### 2.3 Applications of Schrödinger's Wave Equation

We will now apply Schrödinger's wave equation in several examples using various potential functions. These examples will demonstrate the techniques used in the solution of Schrödinger's differential equation and the results of these examples will provide an indication of the electron behavior under these various potentials. We will utilize the resulting concepts later in the discussion of semiconductor properties.

#### 2.3.1 Electron in Free Space

As a first example of applying the Schrödinger's wave equation, consider the motion of an electron in free space. If there is no force acting on the particle, then the potential function $V(x)$ will be constant and we must have $E > V(x)$. Assume, for simplicity, that the potential function $V(x) = 0$ for all $x$. Then, the time-independent wave equation can be written from Equation (2.13) as

$$\frac{\partial^2 \psi(x)}{\partial x^2} + \frac{2mE}{\hbar^2} \psi(x) = 0$$

(2.19)

The solution to this differential equation can be written in the form

$$\psi(x) = A \exp \left[ \frac{jx\sqrt{2mE}}{\hbar} \right] + B \exp \left[ \frac{-jx\sqrt{2mE}}{\hbar} \right]$$

(2.20)
Recall that the time-dependent portion of the solution is
\[ \psi(t) = e^{-i(E/\hbar)t} \]  
(2.21)

Then the total solution for the wave function is given by
\[ \Psi(x, t) = A \exp \left[ \frac{j}{\hbar} (x\sqrt{2mE} - Et) \right] + B \exp \left[ \frac{-j}{\hbar} (x\sqrt{2mE} + Et) \right] \]  
(2.22)

This wave function solution is a traveling wave, which means that a particle moving in free space is represented by a traveling wave. The first term, with the coefficient \( A \), is a wave traveling in the \(+x\) direction, while the second term, with the coefficient \( B \), is a wave traveling in the \(-x\) direction. The value of these coefficients will be determined from boundary conditions. We will again see the traveling-wave solution for an electron in a crystal or semiconductor material.

Assume, for a moment, that we have a particle traveling in the \(+x\) direction, which will be described by the \(+x\) traveling wave. The coefficient \( B = 0 \). We can write the traveling-wave solution in the form
\[ \Psi(x, t) = A \exp \left[ j(kx - \omega t) \right] \]  
(2.23)

where \( k \) is a wave number and is
\[ k = \frac{2\pi}{\lambda} \]  
(2.24)

The parameter \( \lambda \) is the wavelength and, comparing Equation (2.23) with Equation (2.22), the wavelength is given by
\[ \lambda = \frac{\hbar}{\sqrt{2mE}} \]  
(2.25)

From de Broglie's wave–particle duality principle, the wavelength is also given by
\[ \lambda = \frac{\hbar}{p} \]  
(2.26)

A free particle with a well-defined energy will also have a well-defined wavelength and momentum.

The probability density function is \( \Psi(x, t)\Psi^*(x, t) = AA^* \), which is a constant independent of position. A free particle with a well-defined momentum can be found anywhere with equal probability. This result is in agreement with the Heisenberg uncertainty principle in that a precise momentum implies an undefined position.

A localized free particle is defined by a wave packet, formed by a superposition of wave functions with different momentum or \( k \) values. We will not consider the wave packet here.

### 2.3.2 The Infinite Potential Well

The problem of a particle in the infinite potential well is a classic example of a bound particle. The potential \( V(x) \) as a function of position for this problem is shown in
Figure 2.5. The particle is assumed to exist in region II so the particle is contained within a finite region of space. The time-independent Schrodinger's wave equation is again given by Equation (2.13) as

$$\frac{\partial^2 \psi(x)}{\partial x^2} + \frac{2m}{\hbar^2} (E - V(x)) \psi(x) = 0$$

where $E$ is the total energy of the particle. If $E$ is finite, the wave function must be zero, or $\psi(x) = 0$, in both regions I and III. A particle cannot penetrate these infinite potential barriers, so the probability of finding the particle in regions I and III is zero.

The time-independent Schrodinger's wave equation in region II, where $V = 0$, becomes

$$\frac{\partial^2 \psi(x)}{\partial x^2} + \frac{2mE}{\hbar^2} \psi(x) = 0$$

A particular form of solution to this equation is given by

$$\psi(x) = A_1 \cos Kx + A_2 \sin Kx$$

where

$$K = \sqrt{\frac{2mE}{\hbar^2}}$$

One boundary condition is that the wave function $\psi(x)$ must be continuous so that

$$\psi(x = 0) = \psi(x = a) = 0$$
Applying the boundary condition at \( x = 0 \), we must have that \( A_1 = 0 \). At \( x = a \), we have

\[
\psi(x = a) = 0 = A_2 \sin Ka
\]  

This equation is valid if \( Ka = n\pi \), where the parameter \( n \) is a positive integer, or \( n = 1, 2, 3, \ldots \). The parameter \( n \) is referred to as a quantum number. We can write

\[
K = \frac{n\pi}{a}
\]  

Negative values of \( n \) simply introduce a negative sign in the wave function and yield redundant solutions for the probability density function. We cannot physically distinguish any difference between \( +n \) and \( -n \) solutions. Because of this redundancy, negative values of \( n \) are not considered.

The coefficient \( A_2 \) can be found from the normalization boundary condition that was given by Equation (2.18) as \( \int_{-\infty}^{\infty} \psi(x)\psi^*(x)\,dx = 1 \). If we assume that the wave function solution \( \psi(x) \) is a real function, then \( \psi(x) = \psi^*(x) \). Substituting the wave function into Equation (2.18), we have

\[
\int_{0}^{a} A_2^2 \sin^2 Kx\,dx = 1
\]  

Evaluating this integral gives\(^2\)

\[
A_2 = \sqrt{\frac{2}{a}}
\]  

Finally, the time-independent wave solution is given by

\[
\psi(x) = \sqrt{\frac{2}{a}} \sin \left( \frac{n\pi x}{a} \right) \quad \text{where } n = 1, 2, 3, \ldots
\]  

This solution represents the electron in the infinite potential well and is a standing wave solution. The free electron was represented by a traveling wave, and now the bound particle is represented by a standing wave.

The parameter \( K \) in the wave solution was defined by Equations (2.29) and (2.32). Equating these two expressions for \( K \), we obtain

\[
\frac{2mE}{\hbar^2} = \frac{n^2\pi^2}{a^2}
\]  

\(^2\)A more thorough analysis shows that \( |A_2|^2 = 2/a \), so solutions for the coefficient \( A_2 \) include \( +\sqrt{2/a}, -\sqrt{2/a}, +j\sqrt{2/a}, -j\sqrt{2/a} \), or any complex number whose magnitude is \( \sqrt{2/a} \). Since the wave function itself has no physical meaning, the choice of which coefficient to use is immaterial: They all produce the same probability density function.
The total energy can then be written as

\[ E = E_n = \frac{n^2 \hbar^2 \pi^2}{2ma^2} \quad \text{where } n = 1, 2, 3, \ldots \]  

(2.37)

For the particle in the infinite potential well, the wave function is now given by

\[ \psi(x) = \sqrt{\frac{2}{a}} \sin Kx \]  

(2.38)

where the constant \( K \) must have discrete values, implying that the total energy of the particle can only have discrete values. This result means that the energy of the particle is quantized. That is, the energy of the particle can only have particular discrete values. The quantization of the particle energy is contrary to results from classical physics, which would allow the particle to have continuous energy values. The discrete energies lead to quantum states that will be considered in more detail in this and later chapters. The quantization of the energy of a bound particle is an extremely important result.

**Objective**

**Example 2.3**

To calculate the first three energy levels of an electron in an infinite potential well.

Consider an electron in an infinite potential well of width 5 Å.

**Solution**

From Equation (2.37) we have

\[ E_n = \frac{n^2 \hbar^2 \pi^2}{2ma^2} = \frac{n^2 (1.054 \times 10^{-34})^2 \pi^2}{2(9.11 \times 10^{-31})(5 \times 10^{-10})^2} = n^2 (2.41 \times 10^{-19}) \text{ J} \]

or

\[ E_n = \frac{n^2 (2.41 \times 10^{-19})}{1.6 \times 10^{-19}} = n^2 (1.51) \text{ eV} \]

Then,

\[ E_1 = 1.51 \text{ eV}, \quad E_2 = 6.04 \text{ eV}, \quad E_3 = 13.59 \text{ eV} \]

**Comment**

This calculation shows the order of magnitude of the energy levels of a bound electron.

Figure 2.6a shows the first four allowed energies for the particle in the infinite potential well, and Figures 2.6b and 2.6c show the corresponding wave functions and probability functions. We may note that as the energy increases, the probability of finding the particle at any given value of \( x \) becomes more uniform.
2.3.3 The Step Potential Function

Consider now a step potential function as shown in Figure 2.7. In the previous section, we considered a particle being confined between two potential barriers. In this example, we will assume that a flux of particles is incident on the potential barrier. We will assume that the particles are traveling in the +x direction and that they originated at \( x = -\infty \). A particularly interesting result is obtained for the case when the total energy of the particle is less than the barrier height, or \( E < V_0 \).

We again need to consider the time-independent wave equation in each of the two regions. This general equation was given in Equation (2.13) as

\[
\frac{\partial^2\psi(x)}{\partial x^2} + \frac{2m}{\hbar^2}(E - V(x))\psi(x) = 0.
\]

The wave equation in region I, in which \( V = 0 \), is

\[
\frac{\partial^2\psi_1(x)}{\partial x^2} + \frac{2m}{\hbar^2}\psi_1(x) = 0
\]  

\[(2.39)\]
2.3 Applications of Schrödinger's Wave Equation

The general solution to this equation can be written in the form

$$\psi_1(x) = A_1 e^{iK_1 x} + B_1 e^{-iK_1 x} \quad (x \leq 0) \quad (2.40)$$

where the constant $K_1$ is

$$K_1 = \sqrt{\frac{2mE}{\hbar^2}} \quad (2.41)$$

The first term in Equation (2.40) is a traveling wave in the $+x$ direction that represents the incident wave, and the second term is a traveling wave in the $-x$ direction that represents a reflected wave. As in the case of a free particle, the incident and reflected particles are represented by traveling waves.

For the incident wave, $A_1 \cdot A_1^*$ is the probability density function of the incident particles. If we multiply this probability density function by the incident velocity, then $v_1 \cdot A_1 \cdot A_1^*$ is the flux of incident particles in units of $\#$/cm$^2$-s. Likewise, the quantity $v_r \cdot B_1 \cdot B_1^*$ is the flux of the reflected particles, where $v_r$ is the velocity of the reflected wave. (The parameters $v_i$ and $v_r$ in these terms are actually the magnitudes of the velocity only.)

In region II, the potential is $V = V_0$. If we assume that $E < V_0$, then the differential equation describing the wave function in region II can be written as

$$\frac{\partial^2 \psi_2(x)}{\partial x^2} - \frac{2m}{\hbar^2} (V_0 - E) \psi_2(x) = 0 \quad (2.42)$$

The general solution may then be written in the form

$$\psi_2(x) = A_2 e^{-K_2 x} + B_2 e^{+K_2 x} \quad (x \geq 0) \quad (2.43)$$

where

$$K_2 = \sqrt{\frac{2m(V_0 - E)}{\hbar^2}} \quad (2.44)$$

One boundary condition is that the wave function $\psi_2(x)$ must remain finite, which means that the coefficient $B_2 = 0$. The wave function is now given by

$$\psi_2(x) = A_2 e^{-K_2 x} \quad (x \geq 0) \quad (2.45)$$
The wave function at $x = 0$ must be continuous so that

$$\psi_1(0) = \psi_2(0) \quad (2.46)$$

Then from Equations (2.40), (2.45), and (2.46), we obtain

$$A_1 + B_1 = A_2 \quad (2.47)$$

Since the potential function is everywhere finite, the first derivative of the wave function must also be continuous so that

$$\left. \frac{\partial \psi_1}{\partial x} \right|_{x=0} = \left. \frac{\partial \psi_2}{\partial x} \right|_{x=0} \quad (2.48)$$

Using Equations (2.40), (2.45), and (2.48), we obtain

$$jK_1A_1 - jK_1B_1 = -K_2A_2 \quad (2.49)$$

We can solve Equations (2.47) and (2.49) to determine the coefficients $B_1$ and $A_2$ in terms of the incident wave coefficient $A_1$. The results are

$$B_1 = \frac{-(K_1^2 - 2jK_1K_2 - K_2^2)A_1}{(K_2^2 + K_1^2)} \quad (2.50a)$$

and

$$A_2 = \frac{2K_1(K_1 - jK_2)A_1}{(K_2^2 + K_1^2)} \quad (2.50b)$$

The reflected probability density function is given by

$$B_1 \cdot B_1^* = \frac{(K_2^2 - K_1^2 + 2jK_1K_2)(K_2^2 - K_1^2 - 2jK_1K_2)A_1 \cdot A_1^*}{(K_2^2 + K_1^2)^2} \quad (2.51)$$

We can define a reflection coefficient, $R$, as the ratio of the reflected flux to the incident flux, which is written as

$$R = \frac{v_r \cdot B_1 \cdot B_1^*}{v_i \cdot A_1 \cdot A_1^*} \quad (2.52)$$

where $v_i$ and $v_r$ are the incident and reflected velocities, respectively, of the particles.

In region I, $V = 0$ so that $E = T$, where $T$ is the kinetic energy of the particle. The kinetic energy is given by

$$T = \frac{1}{2}mv^2 \quad (2.53)$$

so that the constant $K_1$, from Equation (2.41), may be written as

$$K_1 = \sqrt{\frac{2m}{\hbar^2} \left( \frac{1}{2}mv^2 \right)} = \sqrt{m^2 \frac{v^2}{\hbar^2}} = \frac{mv}{\hbar} \quad (2.54)$$
The incident velocity can then be written as

\[ v_i = \frac{\hbar}{m} \cdot K_1 \]  

(2.55)

Since the reflected particle also exists in region I, the reflected velocity (magnitude) is given by

\[ v_r = \frac{\hbar}{m} \cdot K_1 \]  

(2.56)

The incident and reflected velocities (magnitudes) are equal. The reflection coefficient is then

\[ R = \frac{v_r \cdot B_1 \cdot B_1^*}{v_i \cdot A_1 \cdot A_1^*} = \frac{B_1 \cdot B_1^*}{A_1 \cdot A_1^*} \]  

(2.57)

Substituting the expression from Equation (2.51) into Equation (2.57), we obtain

\[ R = \frac{B_1 \cdot B_1^*}{A_1 \cdot A_1^*} = \frac{(K_2^2 - K_1^2)^2 + 4K_2^2K_1^2}{(K_2^2 + K_1^2)^2} = 1.0 \]  

(2.58)

The result of \( R = 1 \) implies that all of the particles incident on the potential barrier for \( E < V_0 \) are eventually reflected. Particles are not absorbed or transmitted through the potential barrier. This result is entirely consistent with classical physics and one might ask why we should consider this problem in terms of quantum mechanics. The interesting result is in terms of what happens in region II.

The wave solution in region II was given by Equation (2.45) as \( \psi_2(x) = A_2e^{-K_2x} \). The coefficient \( A_2 \) from Equation (2.47) is \( A_2 = A_1 + B_1 \), which we derived from the boundary conditions. For the case of \( E < V_0 \), the coefficient \( A_2 \) is not zero. If \( A_2 \) is not zero, then the probability density function \( \psi_2(x) \cdot \psi_2^*(x) \) of the particle being found in region II is not equal to zero. This result implies that there is a finite probability that the incident particle will penetrate the potential barrier and exist in region II. The probability of a particle penetrating the potential barrier is another difference between classical and quantum mechanics: The quantum mechanical penetration is classically not allowed. Although there is a finite probability that the particle may penetrate the barrier, since the reflection coefficient in region I is unity, the particle in region II must eventually turn around and move back into region I.

---

**Objective**

**EXAMPLE 2.4**

To calculate the penetration depth of a particle impinging on a potential barrier.

Consider an incident electron that is traveling at a velocity of \( 1 \times 10^5 \) m/s in region I.

**Solution**

With \( V(x) = 0 \), the total energy is also equal to the kinetic energy so that

\[ E = T = \frac{1}{2}mv^2 = 4.56 \times 10^{-21} \text{J} = 2.85 \times 10^{-2} \text{eV} \]
Now, assume that the potential barrier at $x=0$ is twice as large as the total energy of the incident particle, or that $V_0 = 2E$. The wave function solution in region II is $\psi_2(x) = A_2 e^{-K x}$, where the constant $K_2$ is given by $K_2 = \sqrt{2m(V_0 - E)/\hbar^2}$.

In this example, we want to determine the distance $x = d$ at which the wave function magnitude has decayed to $e^{-1}$ of its value at $x = 0$. Then, for this case, we have $K_2 d = 1$ or

$$d = \frac{1}{K_2} = \frac{\sqrt{2m(V_0 - E)/\hbar^2}}{1}.$$

The distance is then given by

$$d = \sqrt{\frac{\hbar^2}{2mE}} = \frac{1.054 \times 10^{-34}}{\sqrt{2(9.11 \times 10^{-34})(4.56 \times 10^{-31})}} = 11.6 \times 10^{-10} \text{ m}$$

or

$$d = 11.6 \text{ Å}$$

**Comment**

This penetration distance corresponds to approximately two lattice constants of silicon. The numbers used in this example are rather arbitrary. We used a distance at which the wave function decayed to $e^{-1}$ of its initial value. We could have arbitrarily used $e^{-2}$, for example, but the results give an indication of the magnitude of penetration depth.

The case when the total energy of a particle, which is incident on the potential barrier, is greater than the barrier height, or $E > V_0$, is left as an exercise at the end of the chapter.

**TEST YOUR UNDERSTANDING**

*E2.7* The probability of finding a particle at a distance $d$ in region II compared to that at $x = 0$ is given by $\exp(-2K_2d)$. Consider an electron traveling in region I at a velocity of $10^5$ m/s incident on a potential barrier whose height is 3 times the kinetic energy of the electron. Find the probability of finding the electron at a distance $d$ compared to $x = 0$ where $d$ is (a) 10 Å and (b) 100 Å into the potential barrier.

**2.3.4 The Potential Barrier**

We now want to consider the potential barrier function, which is shown in Figure 2.8. The more interesting problem, again, is in the case when the total energy of an incident particle is $E < V_0$. Again assume that we have a flux of incident particles originating on the negative $x$ axis traveling in the $+x$ direction. As before, we need to solve Schrödinger's time-independent wave equation in each of the three regions. The
solutions of the wave equation in regions I, II, and III are given, respectively, as
\[
\psi_1(x) = A_1 e^{iK_1x} + B_1 e^{-iK_1x} \quad (2.59a)
\]
\[
\psi_2(x) = A_2 e^{iK_2x} + B_2 e^{-iK_2x} \quad (2.59b)
\]
\[
\psi_3(x) = A_3 e^{iK_3x} + B_3 e^{-iK_3x} \quad (2.59c)
\]
where
\[
K_1 = \sqrt{\frac{2mE}{\hbar^2}} \quad (2.60a)
\]
and
\[
K_2 = \sqrt{\frac{2m}{\hbar^2} (V_0 - E)} \quad (2.60b)
\]

The coefficient \( B_1 \) in Equation (2.59c) represents a negative traveling wave in region III. However, once a particle gets into region III, there are no potential changes to cause a reflection; therefore, the coefficient \( B_2 \) must be zero. We must keep both exponential terms in Equation (2.59b) since the potential barrier width is finite; that is, neither term will become unbounded. We have four boundary relations for the boundaries at \( x = 0 \) and \( x = a \) corresponding to the wave function and its first derivative being continuous. We can solve for the four coefficients \( B_1, A_2, B_2, \) and \( A_3 \) in terms of \( A_1 \). The wave solutions in the three regions are shown in Figure 2.9.

One particular parameter of interest is the transmission coefficient, in this case defined as the ratio of the transmitted flux in region III to the incident flux in region I. Then the transmission coefficient \( T \) is
\[
T = \frac{v_i \cdot A_3 \cdot A_3^*}{v_i \cdot A_1 \cdot A_1^*} = \frac{A_3 \cdot A_3^*}{A_1 \cdot A_1^*} \quad (2.61)
\]
where \( v_t \) and \( v_i \) are the velocities of the transmitted and incident particles, respectively. Since the potential \( V = 0 \) in both regions I and III, the incident and transmitted velocities are equal. The transmission coefficient may be determined by solving the boundary condition equations. For the special case when \( E \ll V_0 \), we find that

\[
T \approx 16 \left( \frac{E}{V_0} \right) \left( 1 - \frac{E}{V_0} \right) \exp(-2 K_2 a) \tag{2.62}
\]

Equation (2.62) implies that there is a finite probability that a particle impinging a potential barrier will penetrate the barrier and will appear in region III. This phenomenon is called tunneling and it, too, contradicts classical mechanics. We will see later how this quantum mechanical tunneling phenomenon can be applied to semiconductor device characteristics, such as in the tunnel diode.

### Example 2.5

**Objective**

To calculate the probability of an electron tunneling through a potential barrier.

Consider an electron with an energy of \( 2 \) eV impinging on a potential barrier with \( V_0 = 20 \) eV and a width of \( 3 \) Å.

**Solution**

Equation (2.62) is the tunneling probability. The factor \( K_2 \) is

\[
K_2 = \sqrt{\frac{2m(V_0 - E)}{\hbar^2}} = \sqrt{\frac{2(9.11 \times 10^{-31})(20 - 2)(1.6 \times 10^{-19})}{(1.054 \times 10^{-34})^2}}
\]

or

\[
K_2 = 2.17 \times 10^{16} \text{ m}^{-1}
\]

Then

\[
T = 16(0.1)(1 - 0.1) \exp\left[-2(2.17 \times 10^{16})(3 \times 10^{-13})\right]
\]

and finally

\[
T = 3.17 \times 10^{-6}
\]
Comment

The tunneling probability may appear to be a small value, but the value is not zero. If a large number of particles impinge on a potential barrier, a significant number can penetrate the barrier.

TEST YOUR UNDERSTANDING

E2.8 Estimate the tunneling probability of an electron tunneling through a rectangular barrier with a barrier height of $V_0 = 1$ eV and a barrier width of $15 \, \text{Å}$. The electron energy is $0.20 \, \text{eV}$. ($\varphi = 01 \times 97^2 = L \text{ cm}$)

E2.9 For a rectangular potential barrier with a height of $V_0 = 2$ eV and an electron with an energy of $0.25 \, \text{eV}$, plot the tunneling probability versus barrier width over the range $2 \leq a \leq 20 \, \text{Å}$. Use a log scale for the tunneling probability.

E2.10 A certain semiconductor device requires a tunneling probability of $T = 10^{-5}$ for an electron tunneling through a rectangular barrier with a barrier height of $V_0 = 0.4$ eV. The electron energy is $0.04 \, \text{eV}$. Determine the maximum barrier width.

Additional applications of Schrodinger's wave equation with various one-dimensional potential functions are found in problems at the end of the chapter. Several of these potential functions represent quantum well structures that are found in modern semiconductor devices.

*2.4 | EXTENSIONS OF THE WAVE THEORY TO ATOMS*

So far in this chapter, we have considered several one-dimensional potential energy functions and solved Schrodinger's time-independent wave equation to obtain the probability function of finding a particle at various positions. Consider now the one-electron, or hydrogen, atom potential function. We will only briefly consider the mathematical details and wave function solutions, but the results are extremely interesting and important.

2.4.1 The One-Electron Atom

The nucleus is a heavy, positively charged proton and the electron is a light, negatively charged particle that, in the classical Bohr theory, is revolving around the nucleus. The potential function is due to the coulomb attraction between the proton and electron and is given by

$$V(r) = \frac{-e^2}{4\pi \varepsilon_0 r}$$  \hspace{1cm} (2.63)

where $e$ is the magnitude of the electronic charge and $\varepsilon_0$ is the permittivity of free space. This potential function, although spherically symmetric, leads to a three-dimensional problem in spherical coordinates.

*Indicates sections that can be skipped without loss of continuity.*
We may generalize the time-independent Schrödinger's wave equation to three dimensions by writing
\[ V^2 \psi (r, \theta, \phi) + \frac{2m_0}{\hbar^2} (E - V(r)) \psi (r, \theta, \phi) = 0 \]
where \( V^2 \) is the Laplacian operator and must be written in spherical coordinates for this case. The parameter \( m_0 \) is the rest mass of the electron.\(^3\) In spherical coordinates, Schrödinger's wave equation may be written as
\[ \frac{1}{r^2} \frac{\partial}{\partial r} \left( r^2 \frac{\partial \psi}{\partial r} \right) + \frac{1}{r^2 \sin^2 \theta} \frac{\partial^2 \psi}{\partial \phi^2} + \frac{1}{r^2 \sin \theta} \frac{\partial}{\partial \theta} \left( \sin \theta \frac{\partial \psi}{\partial \theta} \right) + \frac{2m_0}{\hbar^2} (E - V(r)) \psi = 0 \]

The solution to Equation (2.65) can be determined by the separation-of-variables technique. We will assume that the solution to the time-independent wave equation can be written in the form
\[ \psi (r, \theta, \phi) = R(r) \Theta(\theta) \Phi(\phi) \]
where \( R, \Theta, \) and \( \Phi, \) are functions only of \( r, \theta, \) and \( \phi, \) respectively. Substituting this form of solution into Equation (2.65), we will obtain
\[ \frac{\sin^2 \theta}{R} \frac{\partial}{\partial r} \left( r^2 \frac{\partial R}{\partial r} \right) + \frac{1}{\Phi} \frac{\partial^2 \Phi}{\partial \phi^2} + \frac{\sin \theta}{\Theta} \frac{\partial}{\partial \theta} \left( \sin \theta \frac{\partial \Theta}{\partial \theta} \right) \]
\[ + \frac{2m_0}{\hbar^2} (E - V) = 0 \]

We may note that the second term in Equation (2.67) is a function of \( \phi \) only, while all the other terms are functions of either \( r \) or \( \theta. \) We may then write that
\[ \frac{1}{\Phi} \frac{\partial^2 \Phi}{\partial \phi^2} = -m^2 \]
where \( m \) is a separation of variables constant.\(^4\) The solution to Equation (2.68) is of the form
\[ \Phi = e^{im\phi} \]
Since the wave function must be single-valued, we impose the condition that \( m \) is an integer, or
\[ m = 0, \pm 1, \pm 2, \pm 3, \ldots \]
Incorporating the separation-of-variables constant we can further separate the variables $\theta$ and $r$ and generate two additional separation-of-variables constants $l$ and $m$. The separation-of-variables constants $n$, $l$, and $m$ are known as quantum numbers and are related by

$$n = 1, 2, 3, \ldots$$
$$l = n - 1, n - 2, n - 3, \ldots, 0$$
$$|m| = l, l - 1, \ldots, 0$$

Each set of quantum numbers corresponds to a quantum state which the electron may occupy.

The electron energy may be written in the form

$$E_n = \frac{-m_0 e^4}{(4\pi \varepsilon_0)^2 2\hbar^2 n^2}$$

where $n$ is the principal quantum number. The negative energy indicates that the electron is bound to the nucleus and we again see that the energy of the bound electron is quantized. If the energy were to become positive, then the electron would no longer be a bound particle and the total energy would no longer be quantized. Since the parameter $n$ in Equation (2.72) is an integer, the total energy of the electron can take on only discrete values. The quantized energy is again a result of the particle being bound in a finite region of space.

**TEST YOUR UNDERSTANDING**

**E2.11** Calculate the lowest energy (in electron volts) of an electron in a hydrogen atom. (Ans: $E = 1.51 \text{ eV}$)

The solution of the wave equation may be designated by $\psi_{nlm}$, where $n$, $l$, and $m$ are again the various quantum numbers. For the lowest energy state, $n = 1$, $l = 0$, and $m = 0$, and the wave function is given by

$$\psi_{100} = \frac{1}{\sqrt{\pi}} \cdot \left(\frac{1}{a_0}\right)^{3/2} e^{-r/a_0}$$

This function is spherically symmetric, and the parameter $a_0$ is given by

$$a_0 = \frac{4\pi \varepsilon_0 \hbar^2}{m_0 e^2} = 0.529 \text{ Å}$$

and is equal to the Bohr radius.

The radial probability density function, or the probability of finding the electron at a particular distance from the nucleus, is proportional to the product $\psi_{100} \cdot \psi_{100}^*$ and also to the differential volume of the shell around the nucleus. The probability
density function for the lowest energy state is plotted in Figure 2.10a. The most probable distance from the nucleus is at \( r = a_0 \), which is the same as the Bohr theory. Considering this spherically symmetric probability function, we may now begin to conceive the concept of an electron cloud, or energy shell, surrounding the nucleus rather than a discrete particle orbiting around the nucleus.

The radial probability density function for the next higher, spherically symmetric wave function, corresponding to \( n = 2, l = 0, \) and \( m = 0 \), is shown in Figure 2.10b. This figure shows the idea of the next-higher energy shell of the electron. The second energy shell is at a greater radius from the nucleus than the first energy shell. As indicated in the figure, though, there is still a small probability that the electron will exist at the smaller radius. For the case of \( n = 2 \) and \( l = 1 \), there are three possible states corresponding to the three allowed values of the quantum number \( m \). These wave functions are no longer spherically symmetric.

Although we have not gone into a great deal of mathematical detail for the one-electron atom, three results are important for the further analysis of semiconductor materials. The first is the solution of Schrödinger's wave equation, which again yields electron probability functions, as it did for the simpler potential functions. In developing the physics of semiconductor materials in later chapters, we will also be considering electron probability functions. The second result is the quantization of allowed energy levels for the bound electron. The third is the concept of quantum numbers and quantum states, which evolved from the separation-of-variables technique. We will consider this concept again in the next section and in later chapters when we deal with the semiconductor material physics.

### 2.4.2 The Periodic Table

The initial portion of the periodic table of elements may be determined by using the results of the one-electron atom plus two additional concepts. The first concept...
needed is that of electron spin. The electron has an intrinsic angular momentum, or spin, which is quantized and may take on one of two possible values. The spin is designated by a quantum number \( s \), which has a value of \( s = +\frac{1}{2} \) or \( s = -\frac{1}{2} \). We now have four basic quantum numbers: \( n, l, m, \) and \( s \).

The second concept needed is the Pauli exclusion principle. The Pauli exclusion principle states that, in any given system (an atom, molecule, or crystal), no two electrons may occupy the same quantum state. In an atom, the exclusion principle means that no two electrons may have the same set of quantum numbers. We will see that the exclusion principle is also an important factor in determining the distribution of electrons among available energy states in a crystal.

Table 2.1 shows the first few elements of the periodic table. For the first element, hydrogen, we have one electron in the lowest energy state corresponding to \( n = 1 \). From Equation (2.71) both quantum numbers \( l \) and \( m \) must be zero. However, the electron can take on either spin factor \( +\frac{1}{2} \) or \( -\frac{1}{2} \). For helium, two electrons may exist in the lowest energy state. For this case, \( l = m = 0 \), so now both electron spin states are occupied and the lowest energy shell is full. The chemical activity of an element is determined primarily by the valence, or outermost, electrons. Since the valence energy shell of helium is full, helium does not react with other elements and is an inert element.

The third element, lithium, has three electrons. The third electron must go into the second energy shell corresponding to \( n = 2 \). When \( n = 2 \), the quantum number \( l \) may be 0 or 1, and when \( l = 1 \), the quantum number \( m \) may be \(-1, 0, \) or \(+1\). In each case, the electron spin factor may be \( +\frac{1}{2} \) or \( -\frac{1}{2} \). For \( n = 2 \), then, there are eight possible quantum states. Neon has ten electrons. Two electrons are in the \( n = 1 \) energy shell and eight electrons are in the \( n = 2 \) energy shell. The second energy shell is now full, which means that neon is also an inert element.

From the solution of Schrodinger's wave equation for the one electron atom, plus the concepts of electron spin and the Pauli exclusion principle, we can begin to build up the periodic table of elements. As the atomic numbers of the elements increase, electrons will begin to interact with each other, so that the buildup of the periodic table will deviate somewhat from the simple method.

<table>
<thead>
<tr>
<th>Element</th>
<th>Notation</th>
<th>( n )</th>
<th>( l )</th>
<th>( m )</th>
<th>( s )</th>
</tr>
</thead>
<tbody>
<tr>
<td>Hydrogen</td>
<td>1s(^1)</td>
<td>1</td>
<td>0</td>
<td>0</td>
<td>( +\frac{1}{2} ) or ( -\frac{1}{2} )</td>
</tr>
<tr>
<td>Helium</td>
<td>1s(^2)</td>
<td>1</td>
<td>0</td>
<td>0</td>
<td>( +\frac{1}{2} ) and ( -\frac{1}{2} )</td>
</tr>
<tr>
<td>Lithium</td>
<td>1s(^2)2s(^1)</td>
<td>2</td>
<td>0</td>
<td>0</td>
<td>( +\frac{1}{2} ) or ( -\frac{1}{2} )</td>
</tr>
<tr>
<td>Beryllium</td>
<td>1s(^2)2s(^2)</td>
<td>2</td>
<td>0</td>
<td>0</td>
<td>( +\frac{1}{2} ) and ( -\frac{1}{2} )</td>
</tr>
<tr>
<td>Boron</td>
<td>1s(^2)2s(^2)2p(^1)</td>
<td>2</td>
<td>1</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Carbon</td>
<td>1s(^2)2s(^2)2p(^2)</td>
<td>2</td>
<td>1</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Nitrogen</td>
<td>1s(^2)2s(^2)2p(^3)</td>
<td>2</td>
<td>1</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Oxygen</td>
<td>1s(^2)2s(^2)2p(^4)</td>
<td>2</td>
<td>1</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Fluorine</td>
<td>1s(^2)2s(^2)2p(^5)</td>
<td>2</td>
<td>1</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Neon</td>
<td>1s(^2)2s(^2)2p(^6)</td>
<td>2</td>
<td>1</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
2.5 SUMMARY

- We considered some of the basic concepts of quantum mechanics, which can be used to describe the behavior of electrons under various potential functions. The understanding of electron behavior is crucial in understanding semiconductor physics.
- The wave–particle duality principle is an important element in quantum mechanics. Particles can have wave-like behavior and waves can have particle-like behavior.
- Schrodinger’s wave equation forms the basis for describing and predicting the behavior of electrons.
- Max Born postulated that $|\psi(x)|^2$ is a probability density function.
- A result of applying Schrodinger’s wave equation to a bound particle is that the energy of the bound particle is quantized.
- A result of applying Schrodinger’s wave equation to an electron incident on a potential barrier is that there is a finite probability of tunneling.
- The basic structure of the periodic table is predicted by applying Schrodinger’s wave equation to the one-electron atom.

GLOSSARY OF IMPORTANT TERMS

de Broglie wavelength  The wavelength of a particle given as the ratio of Planck’s constant to momentum.

Heisenberg uncertainty principle  The principle that states that we cannot describe with absolute accuracy the relationship between sets of conjugate variables that describe the behavior of particles, such as momentum and position.

Pauli exclusion principle  The principle that states that no two electrons can occupy the same quantum state.

photon  The particle-like packet of electromagnetic energy.

quanta  The particle-like packet of thermal radiation.

quantized energies  The allowed discrete energy levels that bound particles may occupy.

quantum numbers  A set of numbers that describes the quantum state of a particle, such as an electron in an atom.

quantum state  A particular state of an electron that may be described, for example, by a set of quantum numbers.

tunneling  The quantum mechanical phenomenon by which a particle may penetrate through a thin potential barrier.

wave–particle duality  The characteristic by which electromagnetic waves sometimes exhibit particle-like behavior and particles sometimes exhibit wave-like behavior.

CHECKPOINT

After studying this chapter, the reader should have the ability to:

- Discuss the principle of energy quanta, the wave–particle duality principle, and the uncertainty principle.
- Apply Schrodinger’s wave equation and boundary conditions to problems with various potential functions.
- Determine quantized energy levels of bound particles.
- Determine the approximate tunneling probability of a particle incident on a potential barrier.
**REVIEW QUESTIONS**

1. State the wave–particle duality principle and state the relationship between momentum and wavelength.
2. What is the physical meaning of Schrödinger’s wave function?
3. What is meant by a probability density function?
4. List the boundary conditions for solutions to Schrödinger’s wave equation.
5. What is meant by quantized energy levels?
6. Describe the concept of tunneling.
7. List the quantum numbers of the one-electron atom and discuss how they were developed.

**PROBLEMS**

2.1 The classical wave equation for a two-wire transmission line is given by
\[ \frac{\partial^2 V(x,t)}{\partial x^2} = \frac{L}{C} \frac{\partial^2 V(x,t)}{\partial t^2}. \]
One possible solution is given by
\[ V(x,t) = (\sin Kx) \cdot (\sin \omega t) \] where \( K = n \pi / a \) and \( \omega = K / \sqrt{LC} \). Sketch, on the same graph, the function \( V(x,t) \) as a function of \( x \) for \( 0 \leq x \leq a \) and \( n = 1 \) when (i) \( \omega t = 0 \), (ii) \( \omega t = \pi / 2 \), (iii) \( \omega t = \pi \), (iv) \( \omega t = 3\pi / 2 \), and (v) \( \omega t = 2\pi \).

2.2 The function \( V(x,t) = \cos (2\pi x / \lambda - \omega t) \) is also a solution to the classical wave equation. Sketch on the same graph the function \( V(x,t) \) as a function of \( x \) for \( 0 \leq x \leq 3\lambda \) when: (i) \( \omega t = 0 \), (ii) \( \omega t = 0.25\pi \), (iii) \( \omega t = 0.5\pi \), (iv) \( \omega t = 0.75\pi \), and (v) \( \omega t = \pi \).

2.3 Repeat Problem 2.2 for the function \( V(x,t) = \cos (2\pi x / \lambda + \omega t) \).

2.4 Determine the phase velocities of the traveling waves described in Problems 2.2 and 2.3.

### Section 2.1 Principles of Quantum Mechanics

2.5 The work function of a material refers to the minimum energy required to remove an electron from the material. Assume that the work function of gold is 4.90 eV and that of cesium is 1.90 eV. Calculate the maximum wavelength of light for the photoelectric emission of electrons for gold and cesium.

2.6 Calculate the de Broglie wavelength, \( \lambda = h / \rho \), for: (a) An electron with kinetic energy of (i) 1.0 eV, and (ii) 100 eV. (b) A proton with kinetic energy of 1.0 eV. (c) A singly ionized tungsten atom with kinetic energy of 1.0 eV. (d) A 2000-kg truck traveling at 20 m/s.

2.7 According to classical physics, the average energy of an electron in an electron gas at thermal equilibrium is \( 3kT / 2 \). Determine, for \( T = 300 \) K, the average electron energy (in eV), average electron momentum, and the de Broglie wavelength.

2.8 An electron and a photon have the same energy. At what value of energy (in eV) will the wavelength of the photon be 10 times that of the electron?

2.9 (a) An electron is moving with a velocity of \( 2 \times 10^6 \) cm/s. Determine the electron energy (in eV), momentum, and de Broglie wavelength (in Å). (b) The de Broglie wavelength of an electron is 125 Å. Determine the electron energy (in eV), momentum, and velocity.

2.10 It is desired to produce x-ray radiation with a wavelength of 1 Å. (a) Through what potential voltage difference must the electron be accelerated in vacuum so that it can,
upon colliding with a target, generate such a photon? (Assume that all of the electron's energy is transferred to the photon.) (b) What is the de Broglie wavelength of the electron in part (a) just before it hits the target?

2.11 When the uncertainty principle is considered, it is not possible to locate a photon in space more precisely than about one wavelength. Consider a photon with wavelength \( \lambda = 1 \, \mu \text{m} \). What is the uncertainty in the photon's (a) momentum and (b) energy?

2.12 The uncertainty in position is 12 Å for a particle of mass \( 5 \times 10^{-29} \) kg. Determine the minimum uncertainty in (a) the momentum of the particle and (b) the kinetic energy of the particle.

2.13 Repeat Problem 2.12 for a particle of mass \( 5 \times 10^{-28} \) kg.

2.14 An automobile has a mass of 1500 kg. What is the uncertainty in (a) the momentum and (b) the kinetic energy of the particle?

2.15 (a) The uncertainty in the position of an electron is no greater than 1 Å. Determine the minimum uncertainty in its momentum. (b) The electron's energy is measured with an uncertainty no greater than 1 eV. Determine the minimum uncertainty in the time over which the measurement is made.

Section 2.2 Schrödinger's Wave Equation

2.16 Assume that \( \Psi_1(x, t) \) and \( \Psi_2(x, t) \) are solutions of the one-dimensional time-dependent Schrödinger's wave equation. (a) Show that \( \Psi_1 + \Psi_2 \) is a solution. (b) Is \( \Psi_1 \cdot \Psi_2 \) a solution of the Schrödinger's equation in general? Why or why not?

2.17 Consider the wave function \( \Psi(x, t) = A(\sin \pi x)e^{-j\omega t} \) for \(-1 \leq x \leq 1\). Determine \( A \) so that \( \int_{-1}^{1} |\Psi(x, t)|^2 \, dx = 1 \).

2.18 Consider the wave function \( \Psi(x, t) = A(\sin n\pi x)e^{-j\omega t} \) for \(0 \leq x \leq 1\). Determine \( A \) so that \( \int_{0}^{1} |\Psi(x, t)|^2 \, dx = 1 \).

2.19 The solution to Schrödinger's wave equation for a particular situation is given by \( \psi(x) = \sqrt{2/a_0} e^{-x/a_0} \). Determine the probability of finding the particle between the following limits: (a) \( 0 \leq x \leq a_0/4 \), (b) \( a_0/4 \leq x \leq a_0/2 \), and (c) \( 0 \leq x \leq a_0 \).

Section 2.3 Applications of Schrödinger's Wave Equation

2.20 An electron in free space is described by a plane wave given by \( \Psi(x, t) = A e^{j(kx - \omega t)} \) where \( k = 1.5 \times 10^9 \, \text{m}^{-1} \) and \( \omega = 1.5 \times 10^{13} \, \text{rad/s} \). (a) Determine the phase velocity of the plane wave. (b) Calculate the wavelength, momentum, and kinetic energy (in eV) of the electron.

2.21 An electron is traveling in the negative \( x \) direction with a kinetic energy of 0.015 eV. Write the equation of a plane wave that describes this particle.

2.22 An electron is bound in a one-dimensional infinite potential well with a width of 100 Å. Determine the electron energy levels for \( n = 1, 2, 3 \).

2.23 A one-dimensional infinite potential well with a width of 12 Å contains an electron. (a) Calculate the first two energy levels that the electron may occupy. (b) If an electron drops from the second energy level to the first, what is the wavelength of a photon that might be emitted?

2.24 Consider a particle with mass of 10 mg in an infinite potential well 1.0 cm wide. (a) If the energy of the particle is 10 mJ, calculate the value of \( n \) for that state. (b) What is
Problems

2.25 Calculate the lowest energy level for a neutron in a nucleus, by treating it as if it were in an infinite potential well of width equal to $10^{-14}$ m. Compare this with the lowest energy level for an electron in the same infinite potential well.

2.26 Consider the particle in the infinite potential well as shown in Figure 2.11. Derive and sketch the wave functions corresponding to the four lowest energy levels. (Do not normalize the wave functions.)

*2.27 Consider a three-dimensional infinite potential well. The potential function is given by $V(x) = 0$ for $0 < x < a$, $0 < y < a$, $0 < z < a$, and $V(x) = \infty$ elsewhere. Start with Schrödinger’s wave equation, use the separation of variables technique, and show that the energy is quantized and is given by

$$E_{n_x,n_y,n_z} = \frac{\hbar^2 \pi^2}{2ma^2} \left( n_x^2 + n_y^2 + n_z^2 \right)$$

where $n_x = 1, 2, 3, \ldots$, $n_y = 1, 2, 3, \ldots$, $n_z = 1, 2, 3, \ldots$.

*2.28 Consider a free electron bound within a two-dimensional infinite potential well defined by $V = 0$ for $0 < x < 25 \text{ Å}$, $0 < y < 50 \text{ Å}$, and $V = \infty$ elsewhere. Determine the expression for the allowed electron energies.

Describe any similarities and any differences to the results of the one-dimensional infinite potential well.

2.29 Consider a proton in a one-dimensional infinite potential well shown in Figure 2.5. (a) Derive the expression for the allowed energy states of the proton. (b) Calculate the energy difference (in units of eV) between the lowest possible energy and the next higher energy state for (i) $a = 4 \text{ Å}$, and (ii) $a = 0.5 \text{ cm}$.

2.30 For the step potential function shown in Figure 2.12, assume that $E > V_0$ and that particles are incident from the $+x$ direction traveling in the $-x$ direction. (a) Write the wave solutions for each region. (b) Derive expressions for the transmission and reflection coefficients.

2.31 Consider the penetration of a step potential function of height 2.4 eV by an electron whose energy is 2.1 eV. Determine the relative probability of finding the electron at
the distance (a) 12 Å beyond the barrier, and (b) 48 Å beyond the barrier, compared to
the probability of finding the incident particle at the barrier edge.

2.32 Evaluate the transmission coefficient for an electron of energy 2.2 eV impinging on a
potential barrier of height 6.0 eV and thickness $10^{-10}$ m. Repeat the calculation for a
barrier thickness of $10^{-9}$ m. Assume that Equation (2.62) is valid.

2.33 (a) Estimate the tunneling probability of a particle with an effective mass of 0.067$m_0$
(an electron in gallium arsenide), where $m_0$ is the mass of an electron, tunneling
through a rectangular potential barrier of height $V_0 = 0.8$ eV and width 15 Å. The
particle kinetic energy is 0.20 eV. (b) Repeat part (a) if the effective mass of the
particle is 1.08$m_0$ (an electron in silicon).

2.34 A proton attempts to penetrate a rectangular potential barrier of height 10 MeV and
thickness $10^{-14}$ m. The particle has a total energy of 3 MeV. Calculate the probability
that the particle will penetrate the potential barrier. Assume that Equation (2.62) is
valid.

*2.35 An electron with energy $E$ is incident on a rectangular potential barrier as shown in
Figure 2.8. The potential barrier is of width $a$ and height $V_0 \gg E$. (a) Write the form
of the wave function in each of the three regions. (b) For this geometry, determine
what coefficient in the wave function solutions is zero. (c) Derive the expression for
the transmission coefficient for the electron (tunneling probability). (d) Sketch the
wave function for the electron in each region.

*2.36 A potential function is shown in Figure 2.13 with incident particles coming from $-\infty$
with a total energy $E \geq V_2$. The constants $k$ are defined as

$$k_1 = \sqrt{\frac{2mE}{\hbar^2}} \quad k_2 = \sqrt{\frac{2m}{\hbar^2}(E - V_1)} \quad k_3 = \sqrt{\frac{2m}{\hbar^2}(E - V_2)}$$

Assume a special case for which $k_2a = 2n\pi, \ n = 1, 2, 3, \ldots$. Derive the expres-
sion, in terms of the constants, $k_1, k_2, \text{ and } k_3, \text{ for the transmission coefficient.}
The transmission coefficient is defined as the ratio of the flux of particles in region III to
the incident flux in region I.

*2.37 Consider the one-dimensional potential function shown in Figure 2.14. Assume the
total energy of an electron is $E < V_0$. (a) Write the wave solutions that apply in each

![Figure 2.13](image1.png)  
**Figure 2.13** Potential function for Problem 2.36.

![Figure 2.14](image2.png)  
**Figure 2.14** Potential function for Problem 2.37.
region. (b) Write the set of equations that result from applying the boundary conditions. (c) Show explicitly why, or why not, the energy levels of the electron are quantized.

Section 2.4 Extensions of the Wave Theory to Atoms

2.38 Calculate the energy of the electron in the hydrogen atom (in units of eV) for the first four allowed energy levels.

2.39 Show that the most probable value of the radius \( r \) for the \( 1s \) electron in a hydrogen atom is equal to the Bohr radius \( a_0 \).

2.40 Show that the wave function for \( \psi_{100} \) given by Equation (2.73) is a solution to the differential equation given by Equation (2.64).

2.41 What property do H, Li, Na, and K have in common?

READING LIST


In the last chapter, we applied quantum mechanics and Schrödinger's wave equation to determine the behavior of electrons in the presence of various potential functions. We found that one important characteristic of an electron bound to an atom or bound within a finite space is that the electron can take on only discrete values of energy; that is, the energies are quantized. We also discussed the Pauli exclusion principle, which stated that only one electron is allowed to occupy any given quantum state. In this chapter, we will generalize these concepts to the electron in a crystal lattice.

One of our goals is to determine the electrical properties of a semiconductor material, which we will then use to develop the current-voltage characteristics of semiconductor devices. Toward this end, we have two tasks in this chapter: to determine the properties of electrons in a crystal lattice, and to determine the statistical characteristics of the very large number of electrons in a crystal.

To start, we will expand the concept of discrete allowed electron energies that occur in a single atom to a band of allowed electron energies in a single-crystal solid. First we will qualitatively discuss the feasibility of the allowed energy bands in a crystal and then we will develop a more rigorous mathematical derivation of this theory using Schrödinger's wave equation. This energy band theory is a basic principle of semiconductor material physics and can also be used to explain differences in electrical characteristics between metals, insulators, and semiconductors.

Since current in a solid is due to the net flow of charge, it is important to determine the response of an electron in the crystal to an applied external force, such as an electric field. The movement of an electron in a lattice is different than that of an electron in free space. We will develop a concept allowing us to relate the quantum mechanical behavior of electrons in a crystal to classical Newtonian mechanics. This
3. Allowed and Forbidden Energy Bands

Analysis leads to a parameter called the electron effective mass. As part of this development, we will find that we can define a new particle in a semiconductor called a hole. The motion of both electrons and holes gives rise to currents in a semiconductor.

Because the number of electrons in a semiconductor is very large, it is impossible to follow the motion of each individual particle. We will develop the statistical behavior of electrons in a crystal, noting that the Pauli exclusion principle is an important factor in determining the statistical law the electrons must follow. The resulting probability function will determine the distribution of electrons among the available energy states. The energy band theory and the probability function will be used extensively in the next chapter, when we develop the theory of the semiconductor in equilibrium.

3.1 ALLOWED AND FORBIDDEN ENERGY BANDS

In the last chapter, we treated the one-electron, or hydrogen, atom. That analysis showed that the energy of the bound electron is quantized: Only discrete values of electron energy are allowed. The radial probability density for the electron was also determined. This function gives the probability of finding the electron at a particular distance from the nucleus and shows that the electron is not localized at a given radius. We can extrapolate these single-atom results to a crystal and qualitatively derive the concepts of allowed and forbidden energy bands. We can then apply quantum mechanics and Schrodinger's wave equation to the problem of an electron in a single crystal. We find that the electronic energy states occur in bands of allowed states that are separated by forbidden energy bands.

3.1.1 Formation of Energy Bands

Figure 3.1a shows the radial probability density function for the lowest electron energy state of the single, noninteracting hydrogen atom, and Figure 3.1b shows the same probability curves for two atoms that are in close proximity to each other. The wave functions of the two atom electrons overlap, which means that the two electrons

![Figure 3.1](image-url)
will interact. This interaction or perturbation results in the discrete quantized energy level splitting into two discrete energy levels, schematically shown in Figure 3.1c. The splitting of the discrete state into two states is consistent with the Pauli exclusion principle.

A simple analogy of the splitting of energy levels by interacting particles is the following. Two identical race cars and drivers are far apart on a race track. There is no interaction between the cars, so they both must provide the same power to achieve a given speed. However, if one car pulls up close behind the other car, there is an interaction called draft. The second car will be pulled to an extent by the lead car. The lead car will therefore require more power to achieve the same speed, since it is pulling the second car and the second car will require less power since it is being pulled by the lead car. So there is a "splitting" of power (energy) of the two interacting race cars. (Keep in mind not to take analogies too literally.)

Now, if we somehow start with a regular periodic arrangement of hydrogen-type atoms that are initially very far apart, and begin pushing the atoms together, the initial quantized energy level will split into a band of discrete energy levels. This effect is shown schematically in Figure 3.2, where the parameter $r_0$ represents the equilibrium interatomic distance in the crystal. At the equilibrium interatomic distance, there is a band of allowed energies, but within the allowed band, the energies are at discrete levels. The Pauli exclusion principle states that the joining of atoms to form a system (crystal) does not alter the total number of quantum states regardless of size. However, since no two electrons can have the same quantum number, the discrete energy must split into a band of energies in order that each electron can occupy a distinct quantum state.

We have seen previously that, at any energy level, the number of allowed quantum states is relatively small. In order to accommodate all of the electrons in a crystal, then, we must have many energy levels within the allowed band. As an example, suppose that we have a system with $10^{19}$ one-electron atoms and also suppose that, at the equilibrium interatomic distance, the width of the allowed energy band is 1 eV. For simplicity, we assume that each electron in the system occupies a different energy level and, if the discrete energy states are equidistant, then the energy levels are separated by $10^{-19}$ eV. This energy difference is extremely small, so that for all practical purposes, we have a quasi-continuous energy distribution through the allowed

![Figure 3.2](image)

**Figure 3.2** The splitting of an energy state into a band of allowed energies.
energy band. The fact that $10^{-19}$ eV is a very small difference between two energy states can be seen from the following example.

### Objective

To calculate the change in kinetic energy of an electron when the velocity changes by a small value.

Consider an electron traveling at a velocity of $10^7$ cm/s. Assume the velocity increases by a value of 1 cm/s. The increase in kinetic energy is given by

$$\Delta E = \frac{1}{2} m v_f^2 - \frac{1}{2} m v_i^2 = \frac{1}{2} m (v_f^2 - v_i^2)$$

Let $v_2 = v_1 + \Delta v$. Then

$$v_2^2 = (v_1 + \Delta v)^2 = v_1^2 + 2 v_1 \Delta v + (\Delta v)^2$$

But $\Delta v \ll v_1$, so we have that

$$\Delta E \approx \frac{1}{2} m (2 v_1 \Delta v) = m v_1 \Delta v$$

### Solution

Substituting the number into this equation, we obtain

$$\Delta E = (9.11 \times 10^{-3}) (10^7)(0.01) = 9.11 \times 10^{-28} \text{ J}$$

which may be converted to units of electron volts as

$$\Delta E = \frac{9.11 \times 10^{-28}}{1.6 \times 10^{-19}} = 5.7 \times 10^{-9} \text{ eV}$$

### Comment

A change in velocity of 1 cm/s compared with $10^7$ cm/s results in a change in energy of $5.7 \times 10^{-9}$ eV, which is orders of magnitude larger than the change in energy of $10^{-19}$ eV between energy states in the allowed energy band. This example serves to demonstrate that a difference in adjacent energy states of $10^{-19}$ eV is indeed very small, so that the discrete energies within an allowed band may be treated as a quasi-continuous distribution.

Consider again a regular periodic arrangement of atoms, in which each atom now contains more than one electron. Suppose the atom in this imaginary crystal contains electrons up through the $n = 3$ energy level. If the atoms are initially very far apart, the electrons in adjacent atoms will not interact and will occupy the discrete energy levels. If these atoms are brought closer together, the outermost electrons in the $n = 3$ energy shell will begin to interact initially, so that this discrete energy level will split into a band of allowed energies. If the atoms continue to move closer together, the electrons in the $n = 2$ shell may begin to interact and will also split into a band of allowed energies. Finally, if the atoms become sufficiently close together, the innermost electrons in the $n = 1$ level may interact, so that this energy level may also split into a band of allowed energies. The splitting of these discrete energy levels is
qualitatively shown in Figure 3.3. If the equilibrium interatomic distance is $r_0$, then we have bands of allowed energies that the electrons may occupy separated by bands of forbidden energies. This energy-band splitting and the formation of allowed and forbidden bands is the energy-band theory of single-crystal materials.

The actual band splitting in a crystal is much more complicated than indicated in Figure 3.3. A schematic representation of an isolated silicon atom is shown in Figure 3.4a. Ten of the fourteen silicon atom electrons occupy deep-lying energy levels close to the nucleus. The four remaining valence electrons are relatively weakly bound and are the electrons involved in chemical reactions. Figure 3.4b shows the band splitting of silicon. We need only consider the $n = 3$ level for the valence electrons, since the first two energy shells are completely full and are tightly bound to the nucleus. The
3s state corresponds to \( n = 3 \) and \( l = 0 \) and contains two quantum states per atom. This state will contain two electrons at \( T = 0 \) K. The 3p state corresponds to \( n = 3 \) and \( l = 1 \) and contains six quantum states per atom. This state will contain the remaining two electrons in the individual silicon atom.

As the interatomic distance decreases, the 3s and 3p states interact and overlap. At the equilibrium interatomic distance, the bands have again split, but now four quantum states per atom are in the lower band and four quantum states per atom are in the upper band. At absolute zero degrees, electrons are in the lowest energy state, so that all states in the lower band (the valence band) will be full and all states in the upper band (the conduction band) will be empty. The bandgap energy \( E_g \) between the top of the valence band and the bottom of the conduction band is the width of the forbidden energy band.

We have discussed qualitatively how and why bands of allowed and forbidden energies are formed in a crystal. The formation of these energy bands is directly related to the electrical characteristics of the crystal, as we will see later in our discussion.

*3.1.2  The Kronig–Penney Model*

In the previous section, we discussed qualitatively the splitting of allowed electron energies as atoms are brought together to form a crystal. The concept of allowed and forbidden energy bands can be developed more rigorously by considering quantum mechanics and Schrodinger's wave equation. It may be easy for the reader to "get lost" in the following derivation, but the result forms the basis for the energy-band theory of semiconductors.

The potential function of a single, noninteracting, one-electron atom is shown in Figure 3.5a. Also indicated on the figure are the discrete energy levels allowed for the electron. Figure 3.5b shows the same type of potential function for the case when several atoms are in close proximity arranged in a one-dimensional array. The potential functions of adjacent atoms overlap, and the net potential function for this case is shown in Figure 3.5c. It is this potential function we would need to use in Schrodinger's wave equation to model a one-dimensional single-crystal material.

The solution to Schrodinger's wave equation, for this one-dimensional single-crystal lattice, is made more tractable by considering a simpler potential function. Figure 3.6 is the one-dimensional Kronig–Penney model of the periodic potential function, which is used to represent a one-dimensional single-crystal lattice. We need to solve Schrodinger's wave equation in each region. As with previous quantum mechanical problems, the more interesting solution occurs for the case when \( E < V_0 \), which corresponds to a particle being bound within the crystal. The electrons are contained in the potential wells, but we have the possibility of tunneling between wells. The Kronig–Penney model is an idealized periodic potential representing a one-dimensional single crystal, but the results will illustrate many of the important features of the quantum behavior of electrons in a periodic lattice.

To obtain the solution to Schrodinger's wave equation, we make use of a mathematical theorem by Bloch. The theorem states that all one-electron wave functions,

*Indicates sections that can be skipped without loss of continuity.*
Figure 3.5 | (a) Potential function of a single isolated atom. (b) Overlapping potential functions of adjacent atoms. (c) Net potential function of a one-dimensional single crystal.

Figure 3.6 | The one-dimensional periodic potential function of the Kronig–Penney model.
for problems involving periodically varying potential energy functions, must be of
the form

\[ \psi(x) = u(x)e^{jkx} \tag{3.1} \]

The parameter \( k \) is called a constant of motion and will be considered in more de-
tail as we develop the theory. The function \( u(x) \) is a periodic function with period
\((a + b)\).

We stated in Chapter 2 that the total solution to the wave equation is the product
of the time-independent solution and the time-dependent solution, or

\[ \Psi(x, t) = \psi(x)\phi(t) = u(x)e^{jkx} \cdot e^{-j(E/\hbar)t} \tag{3.2} \]

which may be written as

\[ \Psi(x, t) = u(x)e^{j(kx-(E/\hbar)t)} \tag{3.3} \]

This traveling-wave solution represents the motion of an electron in a single-crystal
material. The amplitude of the traveling wave is a periodic function and the param-
eter \( k \) is also referred to as a wave number.

We can now begin to determine a relation between the parameter \( k \), the total en-
ergy \( E \), and the potential \( V_0 \). If we consider region I in Figure 3.6 \((0 < x < a)\) in
which \( V(x) = 0 \), take the second derivative of Equation (3.1), and substitute this re-
sult into the time-independent Schrodinger's wave equation given by Equation (2.13),
we obtain the relation

\[
\frac{d^2 u_1(x)}{dx^2} + 2jk \frac{du_1(x)}{dx} - (k^2 - \alpha^2)u_1(x) = 0
\]

The function \( u_1(x) \) is the amplitude of the wave function in region I and the param-
eter \( \alpha \) is defined as

\[ \alpha^2 = \frac{2mE}{\hbar^2} \tag{3.5} \]

Consider now a specific region II, \(-b < x < 0\), in which \( V(x) = V_0 \), and apply
Schrodinger's wave equation. We obtain the relation

\[
\frac{d^2 u_2(x)}{dx^2} + 2jk \frac{du_2(x)}{dx} - \left(k^2 - \alpha^2 + \frac{2mV_0}{\hbar^2}\right)u_2(x) = 0
\]

where \( u_2(x) \) is the amplitude of the wave function in region II. We may define

\[ \frac{2m}{\hbar^2}(E - V_0) = \alpha^2 - \frac{2mV_0}{\hbar^2} = \beta^2 \tag{3.7} \]

so that Equation (3.6) may be written as

\[
\frac{d^2 u_2(x)}{dx^2} + 2jk \frac{du_2(x)}{dx} - (k^2 - \beta^2)u_2(x) = 0 \tag{3.8}
\]

Note that from Equation (3.7), if \( E > V_0 \), the parameter \( \beta \) is real, whereas if \( E < V_0 \),
then \( \beta \) is imaginary.
The solution to Equation (3.4), for region I, is of the form

\[ u_1(x) = Ae^{i(\alpha-k)x} + Be^{-i(\alpha+k)x} \quad \text{for} \quad 0 < x < a \]  

(3.9)

and the solution to Equation (3.8), for region II, is of the form

\[ u_2(x) = Ce^{i(\beta-k)x} + De^{-i(\beta+k)x} \quad \text{for} \quad -b < x < 0 \]  

(3.10)

Since the potential function \( V(x) \) is everywhere finite, both the wave function \( \psi(x) \) and its first derivative \( \partial \psi(x)/\partial x \) must be continuous. This continuity condition implies that the wave amplitude function \( u(x) \) and its first derivative \( \partial u(x)/\partial x \) must also be continuous.

If we consider the boundary at \( x = 0 \) and apply the continuity condition to the wave amplitude, we have

\[ u_1(0) = u_2(0) \]  

(3.11)

Substituting Equations (3.9) and (3.10) into Equation (3.11), we obtain

\[ A + B - C - D = 0 \]  

(3.12)

Now applying the condition that

\[ \left. \frac{du_1}{dx} \right|_{x=0} = \left. \frac{du_2}{dx} \right|_{x=0} \]  

(3.13)

we obtain

\[ (\alpha - k)A - (\alpha + k)B - (\beta - k)C + (\beta + k)D = 0 \]  

(3.14)

We have considered region I as \( 0 < x < a \) and region II as \( -b < x < 0 \). The periodicity and the continuity condition mean that the function \( u_1 \), as \( x \to a \), is equal to the function \( u_2 \), as \( x \to -b \). This condition may be written as

\[ u_1(a) = u_2(-b) \]  

(3.15)

Applying the solutions for \( u_1(x) \) and \( u_2(x) \) to the boundary condition in Equation (3.15) yields

\[ Ae^{i(\alpha-k)a} + Be^{-i(\alpha+k)a} - Ce^{-i(\beta-k)b} - De^{i(\beta+k)b} = 0 \]  

(3.16)

The last boundary condition is

\[ \left. \frac{du_1}{dx} \right|_{x=a} = \left. \frac{du_2}{dx} \right|_{x=-b} \]  

(3.17)

which gives

\[ (\alpha - k)Ae^{i(\alpha-k)a} - (\alpha + k)Be^{-i(\alpha+k)a} - (\beta - k)Ce^{-i(\beta-k)b} + (\beta + k)De^{i(\beta+k)b} = 0 \]  

(3.18)

We now have four homogeneous equations, Equations (3.12), (3.14), (3.16), and (3.18), with four unknowns as a result of applying the four boundary conditions. In a set of simultaneous, linear, homogeneous equations, there is a nontrivial solution if,
and only if, the determinant of the coefficients is zero. In our case, the coefficients in question are the coefficients of the parameters $A$, $B$, $C$, and $D$.

The evaluation of this determinant is extremely laborious and will not be considered in detail. The result is

$$\frac{-(a^2 + b^2)}{2\alpha \beta} (\sin \alpha a)(\sin \beta b) + (\cos \alpha a)(\cos \beta b) = \cos k(a + b) \quad (3.19)$$

Equation (3.19) relates the parameter $k$ to the total energy $E$ (through the parameter $\alpha$) and the potential function $V_0$ (through the parameter $\beta$).

As we mentioned, the more interesting solutions occur for $E < V_0$, which applies to the electron bound within the crystal. From Equation (3.7), the parameter $\beta$ is then an imaginary quantity. We may define

$$\beta = j\gamma \quad (3.20)$$

where $\gamma$ is a real quantity. Equation (3.19) can be written in terms of $\gamma$ as

$$\frac{\gamma^2 - \alpha^2}{2\alpha \gamma} (\sin \alpha a)(\sinh \gamma b) + (\cos \alpha a)(\cosh \gamma b) = \cos k(a + b) \quad (3.21)$$

Equation (3.21) does not lend itself to an analytical solution, but must be solved using numerical or graphical techniques to obtain the relation between $k$, $E$, and $V_0$. The solution of Schrödinger's wave equation for a single bound particle resulted in discrete allowed energies. The solution of Equation (3.21) will result in a band of allowed energies.

To obtain an equation that is more susceptible to a graphical solution and thus will illustrate the nature of the results, let the potential barrier width $b \to 0$ and the barrier height $V_0 \to \infty$, but such that the product $bV_0$ remains finite. Equation (3.21) then reduces to

$$\left( \frac{m V_0 b a}{\hbar^2} \right) \frac{\sin \alpha a}{\alpha a} + \cos \alpha a = \cos ka \quad (3.22)$$

We may define a parameter $P'$ as

$$P' = \frac{m V_0 b a}{\hbar^2} \quad (3.23)$$

Then, finally, we have the relation

$$P'\frac{\sin \alpha a}{\alpha a} + \cos \alpha a = \cos ka \quad (3.24)$$

Equation (3.24) again gives the relation between the parameter $k$, total energy $E$ (through the parameter $\alpha$), and the potential barrier $bV_0$. We may note that Equation (3.24) is not a solution of Schrödinger's wave equation but gives the conditions for which Schrödinger's wave equation will have a solution. If we assume the crystal is infinitely large, then $k$ in Equation (3.24) can assume a continuum of values and must be real.
3.1.3 The $k$-Space Diagram

To begin to understand the nature of the solution, initially consider the special case for which $V_0 = 0$. In this case $P' = 0$, which corresponds to a free particle since there are no potential barriers. From Equation (3.24), we have that

$$\cos \alpha a = \cos ka$$

or

$$\alpha = k$$

(3.26)

Since the potential is equal to zero, the total energy $E$ is equal to the kinetic energy, so that, from Equation (3.5), Equation (3.26) may be written as

$$\alpha = \sqrt{\frac{2mE}{\hbar^2}} = \sqrt{\frac{2m(\frac{1}{2}mv^2)}{\hbar^2}} = \frac{p}{\hbar} = k$$

(3.27)

where $p$ is the particle momentum. The constant of the motion parameter $k$ is related to the particle momentum for the free electron. The parameter $k$ is also referred to as a wave number.

We can also relate the energy and momentum as

$$E = \frac{p^2}{2m} = \frac{k^2\hbar^2}{2m}$$

(3.28)

Figure 3.7 shows the parabolic relation of Equation (3.28) between the energy $E$ and momentum $p$ for the free particle. Since the momentum and wave number are linearly related, Figure 3.7 is also the $E$ versus $k$ curve for the free particle.

We now want to consider the relation between $E$ and $k$ from Equation (3.24) for the particle in the single-crystal lattice. As the parameter $P'$ increases, the particle becomes more tightly bound to the potential well or atom. We may define the left side of Equation (3.24) to be a function $f(\alpha a)$, so that

$$f(\alpha a) = P' \frac{\sin \alpha a}{\alpha a} + \cos \alpha a$$

(3.29)
3.1 Allowed and Forbidden Energy Bands

Figure 3.8 | A plot of (a) the first term in Equation (3.29), (b) the second term in Equation (3.29), and (c) the entire $f(\alpha a)$ function. The shaded areas show the allowed values of $(\alpha a)$ corresponding to real values of $k$.

Figure 3.8a is a plot of the first term of Equation (3.29) versus $\alpha a$. Figure 3.8b shows a plot of the $\cos \alpha a$ term and Figure 3.8c is the sum of the two terms, or $f(\alpha a)$.

Now from Equation (3.24), we also have that

$$f(\alpha a) = \cos k\alpha$$  \hspace{1cm} (3.30)

For Equation (3.30) to be valid, the allowed values of the $f(\alpha a)$ function must be bounded between $+1$ and $-1$. Figure 3.8c shows the allowed values of $f(\alpha a)$ and the allowed values of $\alpha a$ in the shaded areas. Also shown on the figure are the values of $k\alpha$ from the right side of Equation (3.30) which correspond to the allowed values of $f(\alpha a)$.

The parameter $\alpha$ is related to the total energy $E$ of the particle through Equation (3.5), which is $\alpha^2 = 2mE/h^2$. A plot of the energy $E$ of the particle as a function of the wave number $k$ can be generated from Figure 3.8c. Figure 3.9 shows this plot and shows the concept of allowed energy bands for the particle propagating in the
crystal lattice. Since the energy $E$ has discontinuities, we also have the concept of forbidden energies for the particles in the crystal.

**EXAMPLE 3.2**

**Objective**

To determine the lowest allowed energy bandwidth.

Assume that the coefficient $P' = 10$ and that the potential width $a = 5 \text{ Å}$.

**Solution**

To find the lowest allowed energy bandwidth, we need to find the difference in $\alpha a$ values as $ka$ changes from 0 to $\pi$ (see Figure 3.8c). For $ka = 0$, Equation (3.29) becomes

$$1 = 10 \frac{\sin \alpha a}{\alpha a} + \cos \alpha a$$

By trial and error, we find $\alpha a = 2.628 \text{ rad}$. We see that for $ka = \pi$, $\alpha a = \pi$.

For $\alpha a = \pi$, we have

$$\sqrt{\frac{2mE_2}{\hbar^2}} \cdot a = \pi$$

or

$$E_2 = \frac{\pi^2 \hbar^2}{2m a^2} = \frac{\pi^2 (1.054 \times 10^{-34})^2}{2(9.11 \times 10^{-31})(5 \times 10^{-10})^2} = 2.407 \times 10^{-19} \text{ J} = 1.50 \text{ eV}$$

For $\alpha a = 2.628$, we find that $E_1 = 1.68 \times 10^{-19} \text{ J} = 1.053 \text{ eV}$. The allowed energy bandwidth is then

$$\Delta E = E_2 - E_1 = 1.50 - 1.053 = 0.447 \text{ eV}$$
Comment

We see from Figure 3.8c that, as the energy increases, the widths of the allowed bands increase from this Kronig–Penney model.

TEST YOUR UNDERSTANDING

E3.1 Using the parameters given in Example 3.2, determine the width (in eV) of the forbidden energy band that exists at $k\alpha = \pi$ (see Figure 3.8c). ($\Lambda \approx 6L = 3V$).

Consider again the right side of Equation (3.24), which is the function $\cos k\alpha$.

The cosine function is periodic so that

$$\cos k\alpha = \cos (k\alpha + 2n\pi) = \cos (k\alpha - 2n\pi)$$

where $n$ is a positive integer. We may consider Figure 3.9 and displace portions of the curve by $2\pi$. Mathematically, Equation (3.24) is still satisfied. Figure 3.10 shows how various segments of the curve can be displaced by the $2\pi$ factor. Figure 3.11 shows the case in which the entire $E$ versus $k$ plot is contained within $-\pi/a < k < \pi/a$. This plot is referred to as a reduced $k$-space diagram, or a reduced-zero representation.

We noted in Equation (3.27) that for a free electron, the particle momentum and the wave number $k$ are related by $p = \hbar k$. Given the similarity between the free

Figure 3.10 | The $E$ versus $k$ diagram showing $2\pi$ displacements of several sections of allowed energy bands.

Figure 3.11 | The $E$ versus $k$ diagram in the reduced-zone representation.
electron solution and the results of the single crystal shown in Figure 3.9, the parameter $hk$ in a single crystal is referred to as the *crystal momentum*. This parameter is not the actual momentum of the electron in the crystal, but is a constant of the motion that includes the crystal interaction.

We have been considering the Kronig–Penney model, which is a one-dimensional periodic potential function used to model a single-crystal lattice. The principle result of this analysis, so far, is that electrons in the crystal occupy certain allowed energy bands and are excluded from the forbidden energy bands. For real three-dimensional single-crystal materials, a similar energy-band theory exists. We will obtain additional electron properties from the Kronig–Penney model in the next sections.

### 3.2 | ELECTRICAL CONDUCTION IN SOLIDS

Again, we are eventually interested in determining the current–voltage characteristics of semiconductor devices. We will need to consider electrical conduction in solids as it relates to the band theory we have just developed. Let us begin by considering the motion of electrons in the various allowed energy bands.

#### 3.2.1 The Energy Band and the Bond Model

In Chapter 1, we discussed the covalent bonding of silicon. Figure 3.12 shows a two-dimensional representation of the covalent bonding in a single-crystal silicon lattice. This figure represents silicon at $T = 0$ K in which each silicon atom is surrounded by eight valence electrons that are in their lowest energy state and are directly involved in the covalent bonding. Figure 3.4b represented the splitting of the discrete silicon energy states into bands of allowed energies as the silicon crystal is formed. At $T = 0$ K, the $4N$ states in the lower band, the valence band, are filled with the valence electrons. All of the valence electrons schematically shown in Figure 3.12 are in the valence band. The upper energy band, the conduction band, is completely empty at $T = 0$ K.

![Figure 3.12](image-url)  
**Figure 3.12** | Two-dimensional representation of the covalent bonding in a semiconductor at $T = 0$ K.
As the temperature increases above 0 K, a few valence band electrons may gain enough thermal energy to break the covalent bond and jump into the conduction band. Figure 3.13a shows a two-dimensional representation of this bond-breaking effect and Figure 3.13b, a simple line representation of the energy-band model, shows the same effect.

The semiconductor is neutrally charged. This means that, as the negatively charged electron breaks away from its covalent bonding position, a positively charged "empty state" is created in the original covalent bonding position in the valence band. As the temperature further increases, more covalent bonds are broken, more electrons jump to the conduction band, and more positive "empty states" are created in the valence band.

We can also relate this bond breaking to the $E$ versus $k$ energy bands. Figure 3.14a shows the $E$ versus $k$ diagram of the conduction and valence bands at

\[ E \]

\[ k \]

Figure 3.13 | (a) Two-dimensional representation of the breaking of a covalent bond. (b) Corresponding line representation of the energy band and the generation of a negative and positive charge with the breaking of a covalent bond.

Figure 3.14 | The $E$ versus $k$ diagram of the conduction and valence bands of a semiconductor at (a) $T = 0$ K and (b) $T > 0$ K.
Chapter 3

3.1 Introduction to the Quantum Theory of Solids

$T = 0$ K. The energy states in the valence band are completely full and the states in the conduction band are empty. Figure 3.14b shows these same bands for $T > 0$ K, in which some electrons have gained enough energy to jump to the conduction band and have left empty states in the valence band. We are assuming at this point that no external forces are applied so the electron and “empty state” distributions are symmetrical with $k$.

3.2 Drift Current

Current is due to the net flow of charge. If we had a collection of positively charged ions with a volume density $N$ (cm$^{-3}$) and an average drift velocity $v_d$ (cm/s), then the drift current density would be

$$J = qNv_d \hspace{1cm} \text{A/cm}^2$$

(3.32)

If, instead of considering the average drift velocity, we considered the individual ion velocities, then we could write the drift current density as

$$J = q \sum_{i=1}^{N} v_i$$

(3.33)

where $v_i$ is the velocity of the $i$th ion. The summation in Equation (3.33) is taken over a unit volume so that the current density $J$ is still in units of A/cm$^2$.

Since electrons are charged particles, a net drift of electrons in the conduction band will give rise to a current. The electron distribution in the conduction band, as shown in Figure 3.14b, is an even function of $k$ when no external force is applied. Recall that $k$ for a free electron is related to momentum so that, since there are as many electrons with a $+|k|$ value as there are with a $-|k|$ value, the net drift current density due to these electrons is zero. This result is certainly expected since there is no externally applied force.

If a force is applied to a particle and the particle moves, it must gain energy. This effect is expressed as

$$dE = Fdx = Fv dt$$

(3.34)

where $F$ is the applied force, $dx$ is the differential distance the particle moves, $v$ is the velocity, and $dE$ is the increase in energy. If an external force is applied to the electrons in the conduction band, there are empty energy states into which the electrons can move; therefore, because of the external force, electrons can gain energy and a net momentum. The electron distribution in the conduction band may look like that shown in Figure 3.15, which implies that the electrons have gained a net momentum.

We may write the drift current density due to the motion of electrons as

$$J = -e \sum_{i=1}^{n} v_i$$

(3.35)

where $e$ is the magnitude of the electronic charge and $n$ is the number of electrons per unit volume in the conduction band. Again, the summation is taken over a unit
3.2 Electrical Conduction in Solids

Figure 3.15 The asymmetric distribution of electrons in the $E$ versus $k$ diagram when an external force is applied.

Volume so the current density is $A/cm^2$. We may note from Equation (3.35) that the current is directly related to the electron velocity; that is, the current is related to how well the electron can move in the crystal.

3.2.3 Electron Effective Mass

The movement of an electron in a lattice will, in general, be different from that of an electron in free space. In addition to an externally applied force, there are internal forces in the crystal due to positively charged ions or protons and negatively charged electrons, which will influence the motion of electrons in the lattice. We can write

$$F_{\text{total}} = F_{\text{ext}} + F_{\text{int}} = ma$$

where $F_{\text{total}}$, $F_{\text{ext}}$, and $F_{\text{int}}$ are the total force, the externally applied force, and the internal forces, respectively, acting on a particle in a crystal. The parameter $a$ is the acceleration and $m$ is the rest mass of the particle.

Since it is difficult to take into account all of the internal forces, we will write the equation

$$F_{\text{ext}} = m^*a$$

where the acceleration $a$ is now directly related to the external force. The parameter $m^*$, called the effective mass, takes into account the particle mass and also takes into account the effect of the internal forces.

To use an analogy for the effective mass concept, consider the difference in motion between a glass marble in a container filled with water and in a container filled with oil. In general, the marble will drop through the water at a faster rate than through the oil. The external force in this example is the gravitational force and the internal forces are related to the viscosity of the liquids. Because of the difference in motion of the marble in these two cases, the mass of the marble would appear to be different in water than in oil. (As with any analogy, we must be careful not to be too literal.)

We can also relate the effective mass of an electron in a crystal to the $E$ versus $k$ curves, such as was shown in Figure 3.11. In a semiconductor material, we will be dealing with allowed energy bands that are almost empty of electrons and other energy bands that are almost full of electrons.
To begin, consider the case of a free electron whose \( E \) versus \( k \) curve was shown in Figure 3.7. Recalling Equation (3.28), the energy and momentum are related by $E = \frac{p^2}{2m} = \frac{\hbar^2 k^2}{2m}$, where \( m \) is the mass of the electron. The momentum and wave number \( k \) are related by $p = \hbar k$. If we take the derivative of Equation (3.28) with respect to \( k \), we obtain

$$\frac{dE}{dk} = \frac{\hbar^2 k}{m} = \frac{\hbar p}{m}$$

(3.38)

Relating momentum to velocity, Equation (3.38) can be written as

$$\frac{1}{\hbar} \frac{dE}{dk} = \frac{p}{m} = v$$

(3.39)

where \( v \) is the velocity of the particle. The first derivative of \( E \) with respect to \( k \) is related to the velocity of the particle.

If we now take the second derivative of \( E \) with respect to \( k \), we have

$$\frac{d^2E}{dk^2} = \frac{\hbar^2}{m}$$

(3.40)

We may rewrite Equation (3.40) as

$$\frac{1}{\hbar^2} \frac{d^2E}{dk^2} = \frac{1}{m}$$

(3.41)

The second derivative of \( E \) with respect to \( k \) is inversely proportional to the mass of the particle. For the case of a free electron, the mass is a constant (nonrelativistic effect), so the second derivative function is a constant. We may also note from Figure 3.7 that $d^2E/dk^2$ is a positive quantity, which implies that the mass of the electron is also a positive quantity.

If we apply an electric field to the free electron and use Newton's classical equation of motion, we can write

$$F = ma = -eE$$

(3.42)

where \( a \) is the acceleration, \( E \) is the applied electric field, and \( e \) is the magnitude of the electronic charge. Solving for the acceleration, we have

$$a = \frac{-eE}{m}$$

(3.43)

The motion of the free electron is in the opposite direction to the applied electric field because of the negative charge.

We may now apply the results to the electron in the bottom of an allowed energy band. Consider the allowed energy band in Figure 3.16a. The energy near the bottom of this energy band may be approximated by a parabola, just as that of a free particle. We may write

$$E - E_c = C_1(k)^2$$

(3.44)
The energy \( E_c \) is the energy at the bottom of the band. Since \( E > E_c \), the parameter \( C_1 \) is a positive quantity.

Taking the second derivative of \( E \) with respect to \( k \) from Equation (3.44), we obtain

\[
\frac{d^2 E}{dk^2} = 2C_1
\]  

(3.45)

We may put Equation (3.45) in the form

\[
\frac{1}{\hbar^2} \frac{d^2 E}{dk^2} = \frac{2C_1}{\hbar^2}
\]  

(3.46)

Comparing Equation (3.46) with Equation (3.41), we may equate \( \hbar^2/2C_1 \) to the mass of the particle. However, the curvature of the curve in Figure 3.16a will not, in general, be the same as the curvature of the free-particle curve. We may write

\[
\frac{1}{\hbar^2} \frac{d^2 E}{dk^2} = \frac{2C_1}{\hbar^2} = \frac{1}{m^*}
\]  

(3.47)

where \( m^* \) is called the effective mass. Since \( C_1 > 0 \), we have that \( m^* > 0 \) also.

The effective mass is a parameter that relates the quantum mechanical results to the classical force equations. In most instances, the electron in the bottom of the conduction band can be thought of as a classical particle whose motion can be modeled by Newtonian mechanics, provided that the internal forces and quantum mechanical properties are taken into account through the effective mass. If we apply an electric field to the electron in the bottom of the allowed energy band, we may write the acceleration as

\[
a = \frac{-eE}{m_n^*}
\]  

(3.48)

where \( m_n^* \) is the effective mass of the electron. The effective mass \( m_n^* \) of the electron near the bottom of the conduction band is a constant.
3.2.4 Concept of the Hole

In considering the two-dimensional representation of the covalent bonding shown in Figure 3.13a, a positively charged "empty state" was created when a valence electron was elevated into the conduction band. For $T > 0$ K, all valence electrons may gain thermal energy; if a valence electron gains a small amount of thermal energy, it may hop into the empty state. The movement of a valence electron into the empty state is equivalent to the movement of the positively charged empty state itself. Figure 3.17 shows the movement of valence electrons in the crystal alternately filling one empty state and creating a new empty state, a motion equivalent to a positive charge moving in the valence band. The crystal now has a second equally important charge carrier that can give rise to a current. This charge carrier is called a hole and, as we will see, can also be thought of as a classical particle whose motion can be modeled using Newtonian mechanics.

The drift current density due to electrons in the valence band, such as shown in Figure 3.14b, can be written as

$$J = -e \sum_{i \text{(filled)}} v_i$$

(3.49)

where the summation extends over all filled states. This summation is inconvenient since it extends over a nearly full valence band and takes into account a very large number of states. We may rewrite Equation (3.49) in the form

$$J = -e \sum_{i \text{(total)}} v_i + e \sum_{i \text{(empty)}} v_i$$

(3.50)

If we consider a band that is totally full, all available states are occupied by electrons. The individual electrons can be thought of as moving with a velocity as given by Equation (3.39):

$$v(E) = \left( \frac{1}{\hbar} \right) \left( \frac{dE}{dk} \right)$$

(3.39)

The band is symmetric in $k$ and each state is occupied so that, for every electron with a velocity $|v|$, there is a corresponding electron with a velocity $-|v|$. Since the band is full, the distribution of electrons with respect to $k$ cannot be changed with an externally applied force. The net drift current density generated from a completely full

\begin{figure}[h]
\centering
\includegraphics[width=\textwidth]{figure3_17.png}
\caption{Visualization of the movement of a hole in a semiconductor.}
\end{figure}
band, then, is zero, or

\[-e \sum_{i=1}^{n} v_i = 0 \quad (3.51)\]

We can now write the drift current density from Equation (3.50) for an almost full band as

\[J = +e \sum_{i=\text{empty}} v_i \quad (3.52)\]

where the \(v_i\) in the summation is the associated with the empty state. Equation (3.52) is entirely equivalent to placing a positively charged particle in the empty states and assuming all other states in the band are empty, or neutrally charged. This concept is shown in Figure 3.18. Figure 3.18a shows the valence band with the conventional electron-filled states and empty states, while Figure 3.18b shows the new concept of positive charges occupying the original empty states. This concept is consistent with the discussion of the positively charged "empty state" in the valence band as shown in Figure 3.17.

The \(v_i\) in the summation of Equation (3.52) is related to how well this positively charged particle moves in the semiconductor. Now consider an electron near the top of the allowed energy band shown in Figure 3.16b. The energy near the top of the allowed energy band may again be approximated by a parabola so that we may write

\[(E - E_v) = -C_2(k)^2 \quad (3.53)\]

The energy \(E_v\) is the energy at the top of the energy band. Since \(E < E_v\) for electrons in this band, then the parameter \(C_2\) must be a positive quantity.

Taking the second derivative of \(E\) with respect to \(k\) from Equation (3.53), we obtain

\[\frac{d^2 E}{dk^2} = -2C_2 \quad (3.54)\]

We may rearrange this equation so that

\[\frac{1}{\hbar^2} \frac{d^2 E}{dk^2} = -2C_2 \quad (3.55)\]

Figure 3.18 | (a) Valence band with conventional electron-filled states and empty states. (b) Concept of positive charges occupying the original empty states.
Comparing Equation (3.55) with Equation (3.41), we may write

\[ \frac{1}{h^2} \frac{d^2 E}{dk^2} = \frac{-2C_2}{h^2} = \frac{1}{m^*} \]  

(3.56)

where \( m^* \) is again an effective mass. We have argued that \( C_2 \) is a positive quantity, which now implies that \( m^* \) is a negative quantity. An electron moving near the top of an allowed energy band behaves as if it has a negative mass.

We must keep in mind that the effective mass parameter is used to relate quantum mechanics and classical mechanics. The attempt to relate these two theories leads to this strange result of a negative effective mass. However, we must recall that solutions to Schrödinger's wave equation also led to results that contradicted classical mechanics. The negative effective mass is another such example.

In discussing the concept of effective mass in the last section, we used an analogy of marbles moving through two liquids. Now consider placing an ice cube in the center of a container filled with water: the ice cube will move upward toward the surface in a direction opposite to the gravitational force. The ice cube appears to have a negative effective mass since its acceleration is opposite to the external force. The effective mass parameter takes into account all internal forces acting on the particle.

If we again consider an electron near the top of an allowed energy band and use Newton's force equation for an applied electric field, we will have

\[ F = m^*a = -eE \]  

(3.57)

However, \( m^* \) is now a negative quantity, so we may write

\[ a = \frac{-eE}{-|m^*|} = \frac{+eE}{|m^*|} \]  

(3.58)

An electron moving near the top of an allowed energy band moves in the same direction as the applied electric field.

The net motion of electrons in a nearly full band can be described by considering just the empty states, provided that a positive electronic charge is associated with each state and that the negative of \( m^* \) from Equation (3.56) is associated with each state. We now can model this band as having particles with a positive electronic charge and a positive effective mass. The density of these particles in the valence band is the same as the density of empty electronic energy states. This new particle is the **hole**. The hole, then, has a positive effective mass denoted by \( m_p^* \) and a positive electronic charge, so it will move in the same direction as an applied field.

### 3.2.5 Metals, Insulators, and Semiconductors

Each crystal has its own energy-band structure. We noted that the splitting of the energy states in silicon, for example, to form the valence and conduction bands, was complex. Complex band splitting occurs in other crystals, leading to large variations in band structures between various solids and to a wide range of electrical characteristics observed in these various materials. We can qualitatively begin to understand...
some basic differences in electrical characteristics caused by variations in band structure by considering some simplified energy bands.

There are several possible energy-band conditions to consider. Figure 3.19a shows an allowed energy band that is completely empty of electrons. If an electric field is applied, there are no particles to move, so there will be no current. Figure 3.19b shows another allowed energy band whose energy states are completely full of electrons. We argued in the previous section that a completely full energy band will also not give rise to a current. A material that has energy bands either completely empty or completely full is an insulator. The resistivity of an insulator is very large or, conversely, the conductivity of an insulator is very small. There are essentially no charged particles that can contribute to a drift current. Figure 3.19c shows a simplified energy-band diagram of an insulator. The bandgap energy $E_g$ of an insulator is usually on the order of 3.5 to 6 eV or larger, so that at room temperature, there are essentially no electrons in the conduction band and the valence band remains completely full. There are very few thermally generated electrons and holes in an insulator.

Figure 3.20a shows an energy band with relatively few electrons near the bottom of the band. Now, if an electric field is applied, the electrons can gain energy, move to

![Figure 3.19](image1) ![Figure 3.20](image2)

*Figure 3.19* Allowed energy bands showing (a) an empty band, (b) a completely full band, and (c) the bandgap energy between the two allowed bands.  
*Figure 3.20* Allowed energy bands showing (a) an almost empty band, (b) an almost full band, and (c) the bandgap energy between the two allowed bands.
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Figure 3.21  Two possible energy bands of a metal showing (a) a partially filled band and (b) overlapping allowed energy bands.

higher energy states, and move through the crystal. The net flow of charge is a current. Figure 3.20b shows an allowed energy band that is almost full of electrons, which means that we can consider the holes in this band. If an electric field is applied, the holes can move and give rise to a current. Figure 3.20c shows the simplified energy-band diagram for this case. The bandgap energy may be on the order of 1 eV. This energy-band diagram represents a semiconductor for $T > 0$ K. The resistivity of a semiconductor, as we will see in the next chapter, can be controlled and varied over many orders of magnitude.

The characteristics of a metal include a very low resistivity. The energy-band diagram for a metal may be in one of two forms. Figure 3.21a shows the case of a partially full band in which there are many electrons available for conduction, so that the material can exhibit a large electrical conductivity. Figure 3.21b shows another possible energy-band diagram of a metal. The band splitting into allowed and forbidden energy bands is a complex phenomenon and Figure 3.21b shows a case in which the conduction and valence bands overlap at the equilibrium interatomic distance. As in the case shown in Figure 3.21a, there are large numbers of electrons as well as large numbers of empty energy states into which the electrons can move, so this material can also exhibit a very high electrical conductivity.

3.3  EXTENSION TO THREE DIMENSIONS

The basic concept of allowed and forbidden energy bands and the basic concept of effective mass have been developed in the last sections. In this section, we will extend these concepts to three dimensions and to real crystals. We will qualitatively consider particular characteristics of the three-dimensional crystal in terms of the $E$ versus $k$ plots, bandgap energy, and effective mass. We must emphasize that we will only briefly touch on the basic three-dimensional concepts; therefore, many details will not be considered.

One problem encountered in extending the potential function to a three-dimensional crystal is that the distance between atoms varies as the direction through the crystal changes. Figure 3.22 shows a face-centered cubic structure with the [100] and [110] directions indicated. Electrons traveling in different directions encounter different potential patterns and therefore different $k$-space boundaries. The $E$ versus $k$ diagrams are in general a function of the $k$-space direction in a crystal.
3.3 Extension to Three Dimensions

![Diagram showing crystal directions](image)

Figure 3.22 | The (100) plane of a face-centered cubic crystal showing the [100] and [110] directions.

3.3.1 The $k$-Space Diagrams of Si and GaAs

Figure 3.23 shows an $E$ versus $k$ diagram of gallium arsenide and of silicon. These simplified diagrams show the basic properties considered in this text, but do not show many of the details more appropriate for advanced-level courses.

Note that in place of the usual positive and negative $k$ axes, we now show two different crystal directions. The $E$ versus $k$ diagram for the one-dimensional model

![Graphs showing energy band structures](image)

Figure 3.23 | Energy band structures of (a) GaAs and (b) Si. (From Sze [11].)
was symmetric in $k$ so that no new information is obtained by displaying the negative axis. It is normal practice to plot the [100] direction along the normal $+k$ axis and to plot the [111] portion of the diagram so the $+k$ points to the left. In the case of diamond or zincblende lattices, the maxima in the valence band energy and minima in the conduction band energy occur at $k = 0$ or along one of these two directions.

Figure 3.23a shows the $E$ versus $k$ diagram for GaAs. The valence band maximum and the conduction band minimum both occur at $k = 0$. The electrons in the conduction band tend to settle at the minimum conduction band energy which is at $k = 0$. Similarly, holes in the valence band tend to congregate at the uppermost valence band energy. In GaAs, the minimum conduction band energy and maximum valence band energy occur at the same $k$ value. A semiconductor with this property is said to be a direct bandgap semiconductor; transitions between the two allowed bands can take place with no change in crystal momentum. This direct nature has significant effect on the optical properties of the material. GaAs and other direct bandgap materials are ideally suited for use in semiconductor lasers and other optical devices.

The $E$ versus $k$ diagram for silicon is shown in Figure 3.23b. The maximum in the valence band energy occurs at $k = 0$ as before. The minimum in the conduction band energy occurs not at $k = 0$, but along the [100] direction. The difference between the minimum conduction band energy and the maximum valence band energy is still defined as the bandgap energy $E_g$. A semiconductor whose maximum valence band energy and minimum conduction band energy do not occur at the same $k$ value is called an indirect bandgap semiconductor. When electrons make a transition between the conduction and valence bands, we must invoke the law of conservation of momentum. A transition in an indirect bandgap material must necessarily include an interaction with the crystal so that crystal momentum is conserved.

Germanium is also an indirect bandgap material, whose valence band maximum occurs at $k = 0$ and whose conduction band minimum occurs along the [111] direction. GaAs is a direct bandgap semiconductor, but other compound semiconductors, such as GaP and AlAs, have indirect bandgaps.

### 3.3.2 Additional Effective Mass Concepts

The curvature of the $E$ versus $k$ diagrams near the minimum of the conduction band energy is related to the effective mass of the electron. We may note from Figure 3.23a that the curvature of the conduction band at its minimum value for GaAs is larger than that of silicon, so the effective mass of an electron in the conduction band of GaAs will be smaller than that in silicon.

For the one-dimensional $E$ versus $k$ diagram, the effective mass was defined by Equation (3.41) as $1/m^* = 1/\hbar^2 \cdot d^2 E/dk^2$. A complication occurs in the effective mass concept in a real crystal. A three-dimensional crystal can be described by three $k$ vectors. The curvature of the $E$ versus $k$ diagram at the conduction band minimum may not be the same in the three $k$ directions. We will not consider the details of the various effective mass parameters here. In later sections and chapters, the effective mass parameters used in calculations will be a kind of statistical average that is adequate for most device calculations.
3.4 DENSITY OF STATES FUNCTION

As we have stated, we eventually wish to describe the current-voltage characteristics of semiconductor devices. Since current is due to the flow of charge, an important step in the process is to determine the number of electrons and holes in the semiconductor that will be available for conduction. The number of carriers that can contribute to the conduction process is a function of the number of available energy or quantum states since, by the Pauli exclusion principle, only one electron can occupy a given quantum state. When we discussed the splitting of energy levels into bands of allowed and forbidden energies, we indicated that the band of allowed energies was actually made up of discrete energy levels. We must determine the density of these allowed energy states as a function of energy in order to calculate the electron and hole concentrations.

3.4.1 Mathematical Derivation

To determine the density of allowed quantum states as a function of energy, we need to consider an appropriate mathematical model. Electrons are allowed to move relatively freely in the conduction band of a semiconductor, but are confined to the crystal. As a first step, we will consider a free electron confined to a three-dimensional infinite potential well, where the potential well represents the crystal. The potential of the infinite potential well is defined as

\[ V(x, y, z) = 0 \quad \text{for } 0 < x < a \]

\[ 0 < y < a \]

\[ 0 < z < a \]

\[ V(x, y, z) = \infty \quad \text{elsewhere} \]

where the crystal is assumed to be a cube with length \( a \). Schrödinger's wave equation in three dimensions can be solved using the separation of variables technique. Extrapolating the results from the one-dimensional infinite potential well, we can show (see Problem 3.21) that

\[ \frac{2mE}{\hbar^2} = k^2 = k_x^2 + k_y^2 + k_z^2 = (n_x^2 + n_y^2 + n_z^2) \left( \frac{\pi^2}{a^2} \right) \]

where \( n_x, n_y, \) and \( n_z \) are positive integers. (Negative values of \( n_x, n_y, \) and \( n_z \) yield the same wave function, except for the sign, as the positive integer values, resulting in the same probability function and energy, so the negative integers do not represent a different quantum state.)

We can schematically plot the allowed quantum states in \( k \) space. Figure 3.24a shows a two-dimensional plot as a function of \( k_x \) and \( k_y \). Each point represents an allowed quantum state corresponding to various integral values of \( n_x \) and \( n_y \). Positive and negative values of \( k_x, k_y, \) or \( k_z \) have the same energy and represent the same
energy state. Since negative values of $k_x$, $k_y$, or $k_z$ do not represent additional quantum states, the density of quantum states will be determined by considering only the positive one-eighth of the spherical $k$ space as shown in Figure 3.24b.

The distance between two quantum states in the $k_x$ direction, for example, is given by

$$k_{x+1} - k_x = (n_x + 1)\left(\frac{\pi}{a}\right) - n_x\left(\frac{\pi}{a}\right) = \frac{\pi}{a}$$

(3.61)

Generalizing this result to three dimensions, the volume $V_k$ of a single quantum state is

$$V_k = \left(\frac{\pi}{a}\right)^3$$

(3.62)

We can now determine the density of quantum states in $k$ space. A differential volume in $k$ space is shown in Figure 3.24b and is given by $4\pi k^2 \, dk$, so the differential density of quantum states in $k$ space can be written as

$$g_T(k) \, dk = 2\left(\frac{1}{8}\right)\frac{4\pi k^2 \, dk}{\left(\frac{\pi}{a}\right)^3}$$

(3.63)

The first factor, 2, takes into account the two spin states allowed for each quantum state; the next factor, $\frac{1}{8}$, takes into account that we are considering only the quantum states for positive values of $k_x$, $k_y$, and $k_z$. The factor $4\pi k^2 \, dk$ is again the differential volume and the factor $(\pi/a)^3$ is the volume of one quantum state. Equation (3.63) may be simplified to

$$g_T(k) \, dk = \frac{\pi k^2 \, dk}{\pi^3 \cdot a^3}$$

(3.64)
Equation (3.64) gives the density of quantum states as a function of momentum, through the parameter \( k \). We can now determine the density of quantum states as a function of energy \( E \). For a free electron, the parameters \( E \) and \( k \) are related by

\[
k^2 = \frac{2mE}{\hbar^2}
\]

or

\[
k = \frac{1}{\hbar} \sqrt{2mE}
\]

The differential \( dk \) is

\[
dk = \frac{1}{\hbar} \sqrt{\frac{m}{2E}} \, dE
\]

Then, substituting the expressions for \( k^2 \) and \( dk \) into Equation (3.64), the number of energy states between \( E \) and \( E + dE \) is given by

\[
g_T(E) \, dE = \frac{\pi a^3}{\pi^3} \left( \frac{2mE}{\hbar^2} \right) \cdot \frac{1}{\hbar} \sqrt{\frac{m}{2E}} \, dE
\]

Since \( \hbar = \hbar/2\pi \), Equation (3.67) becomes

\[
g_T(E) \, dE = \frac{4\pi a^3}{\hbar^3} \cdot (2m)^{3/2} \cdot \sqrt{E} \, dE
\]

Equation (3.68) gives the total number of quantum states between the energy \( E \) and \( E + dE \) in the crystal space volume of \( a^3 \). If we divide by the volume \( a^3 \), then we will obtain the density of quantum states per unit volume of the crystal. Equation (3.68) then becomes

\[
g(E) = \frac{4\pi (2m)^{3/2}}{\hbar^3} \sqrt{E}
\]

The density of quantum states is a function of energy \( E \). As the energy of this free electron becomes small, the number of available quantum states decreases. This density function is really a double density, in that the units are given in terms of states per unit energy per unit volume.

**Objective**

To calculate the density of states per unit volume over a particular energy range.

**EXAMPLE 3.3**

Consider the density of states for a free electron given by Equation (3.69). Calculate the density of states per unit volume with energies between 0 and 1 eV.
Solution
The volume density of quantum states, from Equation (3.69), is

\[ N = \int_{0}^{1} e^{\gamma} g(E) dE = \frac{4\pi (2m)^{3/2}}{\hbar^3} \cdot \int_{0}^{1} \sqrt{E} dE \]

or

\[ N = \frac{4\pi (2m)^{3/2}}{\hbar^3} \cdot \frac{2}{3} \cdot E^{3/2} \]

The density of states is now

\[ N = \frac{4\pi [2(9.11 \times 10^{-31})]^{3/2}}{(6.625 \times 10^{-34})^3} \cdot \frac{2}{3} \cdot (1.6 \times 10^{-19})^{3/2} = 4.5 \times 10^{27} \text{ m}^{-3} \]

or

\[ N = 4.5 \times 10^{21} \text{ states/cm}^3 \]

Comment
The density of quantum states is typically a large number. An effective density of states in a semiconductor, as we will see in the following sections and in the next chapter, is also a large number, but is usually less than the density of atoms in the semiconductor crystal.

3.4.2 Extension to Semiconductors
In the last section, we derived a general expression for the density of allowed electron quantum states using the model of a free electron with mass \( m \) bounded in a three-dimensional infinite potential well. We can extend this same general model to a semiconductor to determine the density of quantum states in the conduction band and the density of quantum states in the valence band. Electrons and holes are confined within the semiconductor crystal so we will again use the basic model of the infinite potential well.

The parabolic relationship between energy and momentum of a free electron was given in Equation (3.28) as \( E = p^2/2m = \hbar^2 k^2/2m \). Figure 3.16a showed the conduction energy band in the reduced \( k \) space. The \( E \) versus \( k \) curve near \( k = 0 \) at the bottom of the conduction band can be approximated as a parabola, so we may write

\[ E = E_c + \frac{\hbar^2 k^2}{2m_n^*} \]

(3.70)

where \( E_c \) is the bottom edge of the conduction band and \( m_n^* \) is the electron effective mass. Equation (3.70) may be rewritten to give

\[ E - E_c = \frac{\hbar^2 k^2}{2m_n^*} \]

(3.71)
The general form of the $E$ versus $k$ relation for an electron in the bottom of a conduction band is the same as the free electron, except the mass is replaced by the effective mass. We can then think of the electron in the bottom of the conduction band as being a "free" electron with its own particular mass. The right side of Equation (3.71) is of the same form as the right side of Equation (3.28), which was used in the derivation of the density of states function. Because of this similarity, which yields the "free" conduction electron model, we may generalize the free electron results of Equation (3.69) and write the density of allowed electronic energy states in the conduction band as

$$g_c(E) = \frac{4\pi(2m^*_n)^{3/2}}{\hbar^3} \sqrt{E - E_c}$$  \hspace{1cm} (3.72)$$

Equation (3.72) is valid for $E \geq E_c$. As the energy of the electron in the conduction band decreases, the number of available quantum states also decreases.

The density of quantum states in the valence band can be obtained by using the same infinite potential well model, since the hole is also confined in the semiconductor crystal and can be treated as a "free" particle. The effective mass of the hole is $m^*_p$. Figure 3.16b showed the valence energy band in the reduced $k$ space. We may also approximate the $E$ versus $k$ curve near $k = 0$ by a parabola for a "free" hole, so that

$$E = E_v - \frac{\hbar^2 k^2}{2m^*_p}$$  \hspace{1cm} (3.73)$$

Equation (3.73) may be rewritten to give

$$E_v - E = \frac{\hbar^2 k^2}{2m^*_p}$$  \hspace{1cm} (3.74)$$

Again, the right side of Equation (3.74) is of the same form used in the general derivation of the density of states function. We may then generalize the density of states function from Equation (3.69) to apply to the valence band, so that

$$g_v(E) = \frac{4\pi(2m^*_p)^{3/2}}{\hbar^3} \sqrt{E_v - E}$$  \hspace{1cm} (3.75)$$

Equation (3.75) is valid for $E \leq E_v$.

We have argued that quantum states do not exist within the forbidden energy band, so $g(E) = 0$ for $E_v < E < E_c$. Figure 3.25 shows the plot of the density of quantum states as a function of energy. If the electron and hole effective masses were equal, then the functions $g_c(E)$ and $g_v(E)$ would be symmetrical about the energy midway between $E_c$ and $E_v$, or the midgap energy, $E_{midgap}$.
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Figure 3.25 | The density of energy states in the conduction band and the density of energy states in the valence band as a function of energy.

TEST YOUR UNDERSTANDING

E3.2 Determine the total number of energy states in silicon between \( E_c \) and \( E_c + kT \) at \( T = 300 \text{ K} \).

E3.3 Determine the total number of energy states in silicon between \( E_v \) and \( E_v - kT \) at \( T = 300 \text{ K} \).

3.5 | STATISTICAL MECHANICS

In dealing with large numbers of particles, we are interested only in the statistical behavior of the group as a whole rather than in the behavior of each individual particle. For example, gas within a container will exert an average pressure on the walls of the vessel. The pressure is actually due to the collisions of the individual gas molecules with the walls, but we do not follow each individual molecule as it collides with the wall. Likewise in a crystal, the electrical characteristics will be determined by the statistical behavior of a large number of electrons.

3.5.1 Statistical Laws

In determining the statistical behavior of particles, we must consider the laws that the particles obey. There are three distribution laws determining the distribution of particles among available energy states.
One distribution law is the Maxwell–Boltzmann probability function. In this case, the particles are considered to be distinguishable by being numbered, for example, from 1 to \( N \), with no limit to the number of particles allowed in each energy state. The behavior of gas molecules in a container at fairly low pressure is an example of this distribution.

A second distribution law is the Bose–Einstein function. The particles in this case are indistinguishable and, again, there is no limit to the number of particles permitted in each quantum state. The behavior of photons, or black body radiation, is an example of this law.

The third distribution law is the Fermi–Dirac probability function. In this case, the particles are again indistinguishable, but now only one particle is permitted in each quantum state. Electrons in a crystal obey this law. In each case, the particles are assumed to be noninteracting.

### 3.5.2 The Fermi–Dirac Probability Function

Figure 3.26 shows the \( i \)th energy level with \( g_i \) quantum states. A maximum of one particle is allowed in each quantum state by the Pauli exclusion principle. There are \( g_i \) ways of choosing where to place the first particle, \( (g_i - 1) \) ways of choosing where to place the second particle, \( (g_i - 2) \) ways of choosing where to place the third particle, and so on. Then the total number of ways of arranging \( N_i \) particles in the \( i \)th energy level (where \( N_i \leq g_i \)) is

\[
\frac{g_i!}{(g_i - N_i)!}
\]

This expression includes all permutations of the \( N_i \) particles among themselves.

However, since the particles are indistinguishable, the \( N_i! \) number of permutations that the particles have among themselves in any given arrangement do not count as separate arrangements. The interchange of any two electrons, for example, does not produce a new arrangement. Therefore, the actual number of independent ways of realizing a distribution of \( N_i \) particles in the \( i \)th level is

\[
W_i = \frac{g_i!}{N_i!(g_i - N_i)!} 
\]

Figure 3.26 | The \( i \)th energy level with \( g_i \) quantum states.
EXAMPLE 3.4

Objective
To determine the possible number of ways of realizing a particular distribution.

Let $g_i = N_i = 10$. Then $(g_i - N_i)! = 1$.

Solution
Equation (3.77) becomes

$$\frac{g_i!}{N_i!(g_i - N_i)!} = \frac{10!}{10!} = 1$$

Comment
If we have 10 particles to be arranged in 10 quantum states, there is only one possible arrangement. Each quantum state contains one particle.

EXAMPLE 3.5

Objective
To again determine the possible number of ways of realizing a particular distribution.

Let $g_i = 10$ and $N_i = 9$. In this case $g_i - N_i = 1$ so that $(g_i - N_i)! = 1$.

Solution
Equation (3.77) becomes

$$\frac{g_i!}{N_i!(g_i - N_i)!} = \frac{10!}{(9!)(1)} = \frac{(10)(9)!}{9!} = 10$$

Comment
In this case, if we have 10 quantum states and 9 particles, there is one empty quantum state. There are 10 possible arrangements, or positions, for the one empty state.

Equation (3.77) gives the number of independent ways of realizing a distribution of $N_i$ particles in the $i$th level. The total number of ways of arranging $(N_1, N_2, N_3, \ldots, N_n)$ indistinguishable particles among $n$ energy levels is the product of all distributions, or

$$W = \prod_{i=1}^{n} \frac{g_i!}{N_i!(g_i - N_i)!}$$

(3.78)

The parameter $W$ is the total number of ways in which $N$ electrons can be arranged in this system, where $N = \sum_{i=1}^{n} N_i$ is the total number of electrons in the system. We want to find the most probable distribution, which means that we want to find the maximum $W$. The maximum $W$ is found by varying $N_i$ among the $E_i$ levels, which varies the distribution, but at the same time, we will keep the total number of particles and total energy constant.
We may write the most probable distribution function as

\[
\frac{N(E)}{g(E)} = f_F(E) = \frac{1}{1 + \exp\left(\frac{E - E_F}{kT}\right)}
\]  

(3.79)

where \(E_F\) is called the Fermi energy. The number density \(N(E)\) is the number of particles per unit volume per unit energy and the function \(g(E)\) is the number of quantum states per unit volume per unit energy. The function \(f_F(E)\) is called the Fermi-Dirac distribution or probability function and gives the probability that a quantum state at the energy \(E\) will be occupied by an electron. Another interpretation of the distribution function is that \(f_F(E)\) is the ratio of filled to total quantum states at any energy \(E\).

### 3.5.3 The Distribution Function and the Fermi Energy

To begin to understand the meaning of the distribution function and the Fermi energy, we can plot the distribution function versus energy. Initially, let \(T = 0 \text{ K}\) and consider the case when \(E < E_F\). The exponential term in Equation (3.79) becomes \(\exp[(E - E_F)/kT] \to \exp(-\infty) = 0\). The resulting distribution function is \(f_F(E < E_F) = 1\). Again let \(T = 0 \text{ K}\) and consider the case when \(E > E_F\). The exponential term in the distribution function becomes \(\exp[(E - E_F)/kT] \to \exp(+\infty) \to +\infty\). The resulting Fermi-Dirac distribution function now becomes \(f_F(E > E_F) = 0\).

The Fermi-Dirac distribution function for \(T = 0 \text{ K}\) is plotted in Figure 3.27. This result shows that, for \(T = 0 \text{ K}\), the electrons are in their lowest possible energy states. The probability of a quantum state being occupied is unity for \(E < E_F\) and the probability of a state being occupied is zero for \(E > E_F\). All electrons have energies below the Fermi energy at \(T = 0 \text{ K}\).

Figure 3.28 shows discrete energy levels of a particular system as well as the number of available quantum states at each energy. If we assume, for this case, that

---

**Figure 3.27** | The Fermi probability function versus energy for \(T = 0 \text{ K}\).

**Figure 3.28** | Discrete energy states and quantum states for a particular system at \(T = 0 \text{ K}\).
the system contains 13 electrons, then Figure 3.28 shows how these electrons are distributed among the various quantum states at $T = 0$ K. The electrons will be in the lowest possible energy state, so the probability of a quantum state being occupied in energy levels $E_1$ through $E_4$ is unity, and the probability of a quantum state being occupied in energy level $E_5$ is zero. The Fermi energy, for this case, must be above $E_4$ but less than $E_5$. The Fermi energy determines the statistical distribution of electrons and does not have to correspond to an allowed energy level.

Now consider a case in which the density of quantum states $g(E)$ is a continuous function of energy as shown in Figure 3.29. If we have $N_0$ electrons in this system, then the distribution of these electrons among the quantum states at $T = 0$ K is shown by the dashed line. The electrons are in the lowest possible energy state so that all states below $E_F$ are filled and all states above $E_F$ are empty. If $g(E)$ and $N_0$ are known for this particular system, then the Fermi energy $E_F$ can be determined.

Consider the situation when the temperature increases above $T = 0$ K. Electrons gain a certain amount of thermal energy so that some electrons can jump to higher energy levels, which means that the distribution of electrons among the available energy states will change. Figure 3.30 shows the same discrete energy levels and quantum states as in Figure 3.28. The distribution of electrons among the quantum states has changed from the $T = 0$ K case. Two electrons from the $E_4$ level have gained enough energy to jump to $E_5$, and one electron from $E_3$ has jumped to $E_4$. As the temperature changes, the distribution of electrons versus energy changes.

The change in the electron distribution among energy levels for $T > 0$ K can be seen by plotting the Fermi–Dirac distribution function. If we let $E = E_F$ and $T > 0$ K, then Equation (3.79) becomes

$$f_F(E = E_F) = \frac{1}{1 + \exp(0)} = \frac{1}{1 + 1} = \frac{1}{2}$$

The probability of a state being occupied at $E = E_F$ is $\frac{1}{2}$. Figure 3.31 shows the Fermi–Dirac distribution function plotted for several temperatures, assuming the Fermi energy is independent of temperature.

---

**Figure 3.29** Density of quantum states and electrons in a continuous energy system at $T = 0$ K.

**Figure 3.30** Discrete energy states and quantum states for the same system shown in Figure 3.28 for $T > 0$ K.
We can see that for temperatures above absolute zero, there is a nonzero probability that some energy states above $E_F$ will be occupied by electrons and some energy states below $E_F$ will be empty. This result again means that some electrons have jumped to higher energy levels with increasing thermal energy.

**Objective**

**EXAMPLE 3.6**

To calculate the probability that an energy state above $E_F$ is occupied by an electron.

Let $T = 300$ K. Determine the probability that an energy level $3kT$ above the Fermi energy is occupied by an electron.

**Solution**

From Equation (3.79), we can write

$$f_F(E) = \frac{1}{1 + \exp \left( \frac{E - E_F}{kT} \right)} = \frac{1}{1 + \exp \left( \frac{3kT}{kT} \right)}$$

which becomes

$$f_F(E) = \frac{1}{1 + 20.09} = 0.0474 = 4.74\%$$

**Comment**

At energies above $E_F$, the probability of a state being occupied by an electron can become significantly less than unity, or the ratio of electrons to available quantum states can be quite small.

**TEST YOUR UNDERSTANDING**

**E3.4** Assume the Fermi energy level is 0.30 eV below the conduction band energy.

(a) Determine the probability of a state being occupied by an electron at $E_c$.

(b) Repeat part (a) for an energy state at $E_c + kT$. Assume $T = 300$ K.

\[ 0.01 \times \Xi \varepsilon (Q) \quad 0.01 \times \Xi \varepsilon (\sigma) \]
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E3.5  Assume the Fermi energy level is 0.35 eV above the valence band energy.
   (a) Determine the probability of a state being empty of an electron at \( E_v \). (b) Repeat
   part (a) for an energy state at \( E_v - kT \). Assume \( T = 300 \) K.

We can see from Figure 3.31 that the probability of an energy above \( E_F \) being
occupied increases as the temperature increases and the probability of a state below
\( E_F \) being empty increases as the temperature increases.

EXAMPLE 3.7  
Objective

To determine the temperature at which there is a 1 percent probability that an energy state
is empty.

Assume that the Fermi energy level for a particular material is 6.25 eV and that the elec-
trons in this material follow the Fermi–Dirac distribution function. Calculate the tempera-
ture at which there is a 1 percent probability that a state 0.30 eV below the Fermi energy level
will not contain an electron.

Solution
The probability that a state is empty is

\[
1 - f_F(E) = 1 - \frac{1}{1 + \exp\left( \frac{E - E_F}{kT} \right)}
\]

Then

\[
0.01 = 1 - \frac{1}{1 + \exp\left( \frac{5.95 - 6.25}{kT} \right)}
\]

Solving for \( kT \), we find \( kT = 0.06529 \) eV, so that the temperature is \( T = 756 \) K.

Comment
The Fermi probability function is a strong function of temperature.

TEST YOUR UNDERSTANDING

E3.6  Repeat Exercise E3.4 for \( T = 400 \) K.
E3.7  Repeat Exercise E3.5 for \( T = 400 \) K.

We may note that the probability of a state a distance \( dE \) above \( E_F \) being
occupied is the same as the probability of a state a distance \( dE \) below \( E_F \) being
empty. The function \( f_F(E) \) is symmetrical with the function \( 1 - f_F(E) \) about the
Fermi energy, \( E_F \). This symmetry effect is shown in Figure 3.32 and will be used
in the next chapter.
Consider the case when $E - E_F \gg kT$, where the exponential term in the denominator of Equation (3.79) is much greater than unity. We may neglect the 1 in the denominator, so the Fermi-Dirac distribution function becomes

$$f_F(E) \approx \exp\left[\frac{-(E - E_F)}{kT}\right]$$

Equation (3.80) is known as the Maxwell-Boltzmann approximation, or simply the Boltzmann approximation, to the Fermi-Dirac distribution function. Figure 3.33 shows the Fermi-Dirac probability function and the Boltzmann approximation. This figure gives an indication of the range of energies over which the approximation is valid.

**EXAMPLE 3.8**

To determine the energy at which the Boltzmann approximation may be considered valid.

Calculate the energy, in terms of $kT$ and $E_F$, at which the difference between the Boltzmann approximation and the Fermi-Dirac function is 5 percent of the Fermi function.
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Solution

We can write

$$\exp\left[\frac{-(E - E_F)}{kT}\right] = \frac{1}{1 + \exp\left(\frac{E - E_F}{kT}\right)}$$

If we multiply both numerator and denominator by the $1 + \exp(\cdot)$ function, we have

$$\exp\left[\frac{-(E - E_F)}{kT}\right] \cdot \left\{1 + \exp\left[\frac{E - E_F}{kT}\right]\right\} - 1 = 0.05$$

which becomes

$$\exp\left[\frac{-(E - E_F)}{kT}\right] = 0.05$$

or

$$(E - E_F) = kT \ln\left(\frac{1}{0.05}\right) \approx 3kT$$

Comment

As seen in this example and in Figure 3.33, the $E - E_F \gg kT$ notation is somewhat misleading. The Maxwell-Boltzmann and Fermi-Dirac functions are within 5 percent of each other when $E - E_F \approx 3kT$.

The actual Boltzmann approximation is valid when $\exp\left[(E - E_F)/kT\right] \gg 1$. However, it is still common practice to use the $E - E_F \gg kT$ notation when applying the Boltzmann approximation. We will use this Boltzmann approximation in our discussion of semiconductors in the next chapter.

3.6 SUMMARY

- Discrete allowed electron energies split into a band of allowed energies as atoms are brought together to form a crystal.
- The concept of allowed and forbidden energy bands was developed more rigorously by considering quantum mechanics and Schrödinger's wave equation using the Kronig-Penney model representing the potential function of a single crystal material. This result forms the basis of the energy band theory of semiconductors.
- The concept of effective mass was developed. Effective mass relates the motion of a particle in a crystal to an externally applied force and takes into account the effect of the crystal lattice on the motion of the particle.
- Two charged particles exist in a semiconductor. An electron is a negatively charged particle with a positive effective mass existing at the bottom of an allowed energy band. A hole is a positively charged particle with a positive effective mass existing at the top of an allowed energy band.
The $E$ versus $k$ diagram of silicon and gallium arsenide were given and the concept of direct and indirect bandgap semiconductors was discussed.

- Energies within an allowed energy band are actually at discrete levels and each contains a finite number of quantum states. The density per unit energy of quantum states was determined by using the three-dimensional infinite potential well as a model.
- In dealing with large numbers of electrons and holes, we must consider the statistical behavior of these particles. The Fermi–Dirac probability function was developed, which gives the probability of a quantum state at an energy $E$ of being occupied by an electron. The Fermi energy was defined.

**GLOSSARY OF IMPORTANT TERMS**

<table>
<thead>
<tr>
<th>Term</th>
<th>Definition</th>
</tr>
</thead>
<tbody>
<tr>
<td>allowed energy band</td>
<td>A band or range of energy levels that an electron in a crystal is allowed to occupy based on quantum mechanics.</td>
</tr>
<tr>
<td>density of states function</td>
<td>The density of available quantum states as a function of energy, given in units of number per unit energy per unit volume.</td>
</tr>
<tr>
<td>electron effective mass</td>
<td>The parameter that relates the acceleration of an electron in the conduction band of a crystal to an external force; a parameter that takes into account the effect of internal forces in the crystal.</td>
</tr>
<tr>
<td>Fermi–Dirac probability function</td>
<td>The function describing the statistical distribution of electrons among available energy states and the probability that an allowed energy state is occupied by an electron.</td>
</tr>
<tr>
<td>fermi energy</td>
<td>In the simplest definition, the energy below which all states are filled with electrons and above which all states are empty at $T = 0 \text{K}$.</td>
</tr>
<tr>
<td>forbidden energy band</td>
<td>A band or range of energy levels that an electron in a crystal is not allowed to occupy based on quantum mechanics.</td>
</tr>
<tr>
<td>hole</td>
<td>The positively charged “particle” associated with an empty state in the top of the valence band.</td>
</tr>
<tr>
<td>hole effective mass</td>
<td>The parameter that relates the acceleration of a hole in the valence band of a crystal to an applied external force (a positive quantity); a parameter that takes into account the effect of internal forces in a crystal.</td>
</tr>
<tr>
<td>$k$-space diagram</td>
<td>The plot of electron energy in a crystal versus $k$, where $k$ is the momentum-related constant of the motion that incorporates the crystal interaction.</td>
</tr>
<tr>
<td>Kronig-Penney model</td>
<td>The mathematical model of a periodic potential function representing a one-dimensional single-crystal lattice by a series of periodic step functions.</td>
</tr>
<tr>
<td>Maxwell-Boltzmann approximtaion</td>
<td>The condition in which the energy is several $kT$ above the Fermi energy or several $kT$ below the Fermi energy so that the Fermi–Dirac probability function can be approximated by a simple exponential function.</td>
</tr>
<tr>
<td>Pauli exclusion principle</td>
<td>The principle which states that no two electrons can occupy the same quantum state.</td>
</tr>
</tbody>
</table>

**CHECKPOINT**

After studying this chapter, the reader should have the ability to:

- Discuss the concept of allowed and forbidden energy bands in a single crystal both qualitatively and more rigorously from the results of using the Kronig–Penney model.
Discuss the splitting of energy bands in silicon.

State the definition of effective mass from the $E$ versus $k$ diagram and discuss its meaning in terms of the movement of a particle in a crystal.

Discuss the concept of a hole.

Qualitatively, in terms of energy bands, discuss the difference between a metal, insulator, and semiconductor.

Discuss the effective density of states function.

Understand the meaning of the Fermi-Dirac distribution function and the Fermi energy.

**REVIEW QUESTIONS**

1. What is the Kronig-Penney model?
2. State two results of using the Kronig-Penney model with Schrodinger’s wave equation.
3. What is effective mass?
4. What is a direct bandgap semiconductor? What is an indirect bandgap semiconductor?
5. What is the meaning of the density of states function?
6. What was the mathematical model used in deriving the density of states function?
7. In general, what is the relation between density of states and energy?
8. What is the meaning of the Fermi-Dirac probability function?
9. What is the Fermi energy?

**PROBLEMS**

**Section 3.1 Allowed and Forbidden Energy Bands**

3.1 Consider Figure 3.4b, which shows the energy-band splitting of silicon. If the equilibrium lattice spacing were to change by a small amount, discuss how you would expect the electrical properties of silicon to change. Determine at what point the material would behave like an insulator or like a metal.

3.2 Show that Equations (3.4) and (3.6) are derived from Schrodinger’s wave equation, using the form of solution given by Equation (3.3).

3.3 Show that Equations (3.9) and (3.10) are solutions of the differential equations given by Equations (3.4) and (3.8), respectively.

3.4 Show that Equations (3.12), (3.14), (3.16), and (3.18) result from the boundary conditions in the Kronig-Penney model.

3.5 Plot the function $f(\alpha a) = 9 \sin (\alpha a) + \cos (\alpha a)$ for $0 \leq \alpha a \leq 6\pi$. Also, given the function $f(\alpha a) = \cos (\alpha a)$, indicate the allowed values of $\alpha a$ which will satisfy this equation.

3.6 Repeat Problem 3.5 for the function

\[ f(\alpha a) = 6 \sin (\alpha a) + \cos (\alpha a) = \cos (\alpha a) \]

3.7 Using Equation (3.24), show that $dE/dk = 0$ at $k = n\pi/a$, where $n = 0, 1, 2, \ldots$.

3.8 Using the parameters in Problem 3.5 and letting $a = 5$ Å, determine the width (in eV) of the forbidden energy bands that exist at (a) $ka = \pi$, (b) $ka = 2\pi$, (c) $ka = 3\pi$, and (d) $ka = 4\pi$. Refer to Figure 3.8c.
3.9 Using the parameters in Problem 3.5 and letting \( a = 5 \text{ Å} \), determine the width (in eV) of the allowed energy bands that exist for (a) \( 0 < ka < \pi \), (b) \( \pi < ka < 2\pi \), (c) \( 2\pi < ka < 3\pi \), and (d) \( 3\pi < ka < 4\pi \).

3.10 Repeat Problem 3.8 using the parameters in Problem 3.6.

3.11 Repeat Problem 3.9 using the parameters in Problem 3.6.

3.12 The bandgap energy in a semiconductor is usually a slight function of temperature. In some cases, the bandgap energy versus temperature can be modeled by

\[
E_g = E_g(0) - \frac{\alpha T^2}{(\beta + T)}
\]

where \( E_g(0) \) is the value of the bandgap energy at \( T = 0 \text{ K} \). For silicon, the parameter values are \( E_g(0) = 1.170 \text{ eV} \), \( \alpha = 4.73 \times 10^{-4} \text{ eV/K} \), and \( \beta = 636 \text{ K} \). Plot \( E_g \) versus \( T \) over the range \( 0 \leq T \leq 600 \text{ K} \). In particular, note the value at \( T = 300 \text{ K} \).

Section 3.2 Electrical Conduction in Solids

3.13 Two possible conduction bands are shown in the \( E \) versus \( k \) diagram given in Figure 3.34. State which band will result in the heavier electron effective mass; state why.

3.14 Two possible valence bands are shown in the \( E \) versus \( k \) diagram given in Figure 3.35. State which band will result in the heavier hole effective mass; state why.

3.15 The \( E \) versus \( k \) diagram for a particular allowed energy band is shown in Figure 3.36. Determine (a) the sign of the effective mass and (b) the direction of velocity for a particle at each of the four positions shown.

3.16 Figure 3.37 shows the parabolic \( E \) versus \( k \) relationship in the conduction band for an electron in two particular semiconductor materials. Determine the effective mass (in units of the free electron mass) of the two electrons.

3.17 Figure 3.38 shows the parabolic \( E \) versus \( k \) relationship in the valence band for a hole in two particular semiconductor materials. Determine the effective mass (in units of the free electron mass) of the two holes.

3.18 The forbidden energy band of GaAs is 1.42 eV. (a) Determine the minimum frequency of an incident photon that can interact with a valence electron and elevate the electron to the conduction band. (b) What is the corresponding wavelength?

3.19 The \( E \) versus \( k \) diagrams for a free electron (curve A) and for an electron in a semiconductor (curve B) are shown in Figure 3.39. Sketch (a) \( dE/dk \) versus \( k \) and

![Figure 3.34](image) Conduction bands for Problem 3.13.

![Figure 3.35](image) Valence bands for Problem 3.14.
(b) $d^2E/dk^2$ versus $k$ for each curve. (c) What conclusion can you make concerning a comparison in effective masses for the two cases?

**Section 3.3 Extension to Three Dimensions**

3.20 The energy band diagram for silicon is shown in Figure 3.23b. The minimum energy in the conduction band is in the [100] direction. The energy in this one-dimensional direction near the minimum value can be approximated by

$$E = E_0 - E_1 \cos \alpha(k - k_0)$$

where $k_0$ is the value of $k$ at the minimum energy. Determine the effective mass of the particle at $k = k_0$ in terms of the equation parameters.

**Section 3.4 Density of States Function**

3.21 Starting with the three-dimensional infinite potential well function given by Equation (3.59) and using the separation of variables technique, derive Equation (3.60).

3.22 Show that Equation (3.69) can be derived from Equation (3.64).

3.23 Determine the total number of energy states in GaAs between $E_c$ and $E_c + kT$ at $T = 300$ K.
3.24 Determine the total number of energy states in GaAs between \( E_\text{F} \) and \( E_v - kT \) at 
\( T = 300 \text{ K} \).

3.25 (a) Plot the density of states in the conduction band for silicon over the range 
\( E_c \leq E \leq E_c + 0.2 \text{ eV} \). (b) Repeat part (a) for the density of states in the valence 
band over the range \( E_v - 0.2 \text{ eV} \leq E \leq E_v \).

3.26 Find the ratio of the effective density of states in the conduction band at \( E_c + kT \) to 
the effective density of states in the valence band at \( E_v - kT \).

**Section 3.5 Statistical Mechanics**

3.27 Plot the Fermi-Dirac probability function, given by Equation (3.79), over the range 
\(-0.2 \leq (E - E_\text{F}) \leq 0.2 \text{ eV} \) for (a) \( T = 200 \text{ K} \), (b) \( T = 300 \text{ K} \), and (c) \( T = 400 \text{ K} \).

3.28 Repeat Example 3.4 for the case when \( g = 10 \) and \( N_i = 8 \).

3.29 (a) If \( E_F = E_c \), find the probability of a state being occupied at \( E = E_c + kT \). (b) If 
\( E_F = E_v \), find the probability of a state being empty at \( E = E_v - kT \).

3.30 Determine the probability that an energy level is occupied by an electron if the state is 
above the Fermi level by (a) \( kT \), (b) \( 5kT \), and (c) \( 10kT \).

3.31 Determine the probability that an energy level is empty of an electron if the state is 
below the Fermi level by (a) \( kT \), (b) \( 5kT \), and (c) \( 10kT \).

3.32 The Fermi energy in silicon is 0.25 \text{ eV} below the conduction band energy \( E_c \). (a) Plot 
the probability of a state being occupied by an electron over the range 
\( E_c \leq E \leq E_c + 2kT \). Assume \( T = 300 \text{ K} \). (b) Repeat part (a) for \( T = 400 \text{ K} \).

3.33 Four electrons exist in a one-dimensional infinite potential well of width \( a = 10 \text{ Å} \). 
Assuming the free electron mass, what is the Fermi energy at \( T = 0 \text{ K} \).

3.34 (a) Five electrons exist in a three-dimensional infinite potential well with all three 
widths equal to \( a = 10 \text{ Å} \). Assuming the free electron mass, what is the Fermi energy 
at \( T = 0 \text{ K} \). (b) Repeat part (a) for 13 electrons.

3.35 Show that the probability of an energy state being occupied \( \Delta E \) above the Fermi 
energy is the same as the probability of a state being empty \( \Delta E \) below the Fermi level.

3.36 (a) Determine for what energy above \( E_F \) (in terms of \( kT \)) the Fermi-Dirac probabil-
ity function is within 1 percent of the Boltzmann approximation. (b) Give the value of the 
probability function at this energy.

3.37 The Fermi energy level for a particular material at \( T = 300 \text{ K} \) is 6.25 \text{ eV}. The elec-
trons in this material follow the Fermi-Dirac distribution function. (a) Find the 
probability of an energy level at 6.50 \text{ eV} being occupied by an electron. (b) Repeat 
part (a) if the temperature is increased to \( T = 950 \text{ K} \). (Assume that \( E_F \) is a constant.) 
(c) Calculate the temperature at which there is a 1 percent probability that a state 
0.30 \text{ eV} below the Fermi level will be empty of an electron.

3.38 The Fermi energy for copper at \( T = 300 \text{ K} \) is 7.0 \text{ eV}. The electrons in copper follow 
the Fermi-Dirac distribution function. (a) Find the probability of an energy level at 
7.15 \text{ eV} being occupied by an electron. (b) Repeat part (a) for \( T = 1000 \text{ K} \). (Assume 
that \( E_F \) is a constant.) (c) Repeat part (a) for \( E = 6.85 \text{ eV} \) and \( T = 300 \text{ K} \). (d) De-
termin the probability of the energy state at \( E = E_F \) being occupied at \( T = 300 \text{ K} \) 
and \( T = 1000 \text{ K} \).

3.39 Consider the energy levels shown in Figure 3.40. Let \( T = 300 \text{ K} \). (a) If \( E_1 - E_F = 
0.30 \text{ eV} \), determine the probability that an energy state at \( E = E_1 \) is occupied by an 
electron and the probability that an energy state at \( E = E_2 \) is empty. (b) Repeat part 
(a) if \( E_F - E_2 = 0.40 \text{ eV} \).
3.40 Repeat problem 3.39 for the case when $E_1 - E_2 = 1.42$ eV.

3.41 Determine the derivative with respect to energy of the Fermi–Dirac distribution function. Plot the derivative with respect to energy for (a) $T = 0$ K, (b) $T = 300$ K, and (c) $T = 500$ K.

3.42 Assume the Fermi energy level is exactly in the center of the bandgap energy of a semiconductor at $T = 300$ K. (a) Calculate the probability that an energy state in the bottom of the conduction band is occupied by an electron for Si, Ge, and GaAs. (b) Calculate the probability that an energy state in the top of the valence band is empty for Si, Ge, and GaAs.

3.43 Calculate the temperature at which there is a $10^{-6}$ probability that an energy state 0.55 eV above the Fermi energy level is occupied by an electron.

3.44 Calculate the energy range (in eV) between $f_f(E) = 0.95$ and $f_f(E) = 0.05$ for $E_f = 7.0$ eV and for (a) $T = 300$ K and (b) $T = 500$ K.

**READING LIST**

The Semiconductor in Equilibrium

PREVIEW

So far, we have been considering a general crystal and applying to it the concepts of quantum mechanics in order to determine a few of the characteristics of electrons in a single-crystal lattice. In this chapter, we will apply these concepts specifically to a semiconductor material. In particular, we will use the density of quantum states in the conduction band and the density of quantum states in the valence band along with the Fermi-Dirac probability function to determine the concentration of electrons and holes in the conduction and valence bands, respectively. We will also apply the concept of the Fermi energy to the semiconductor material.

This chapter deals with the semiconductor in equilibrium. Equilibrium, or thermal equilibrium, implies that no external forces such as voltages, electric fields, magnetic fields, or temperature gradients are acting on the semiconductor. All properties of the semiconductor will be independent of time in this case. Equilibrium is our starting point for developing the physics of the semiconductor. We will then be able to determine the characteristics that result when deviations from equilibrium occur, such as when a voltage is applied to a semiconductor device.

We will initially consider the properties of an intrinsic semiconductor, that is, a pure crystal with no impurity atoms or defects. We will see that the electrical properties of a semiconductor can be altered in desirable ways by adding controlled amounts of specific impurity atoms, called dopant atoms, to the crystal. Depending upon the type of dopant atom added, the dominant charge carrier in the semiconductor will be either electrons in the conduction band or holes in the valence band. Adding dopant atoms changes the distribution of electrons among the available energy states, so the Fermi energy becomes a function of the type and concentration of impurity atoms.

Finally, as part of this discussion, we will attempt to add more insight into the significance of the Fermi energy.
4.1 | CHARGE CARRIERS IN SEMICONDUCTORS

Current is the rate at which charge flows. In a semiconductor, two types of charge carrier, the electron and the hole, can contribute to a current. Since the current in a semiconductor is determined largely by the number of electrons in the conduction band and the number of holes in the valence band, an important characteristic of the semiconductor is the density of these charge carriers. The density of electrons and holes is related to the density of states function and the Fermi distribution function, both of which we have considered. A qualitative discussion of these relationships will be followed by a more rigorous mathematical derivation of the thermal-equilibrium concentration of electrons and holes.

4.1.1 Equilibrium Distribution of Electrons and Holes

The distribution (with respect to energy) of electrons in the conduction band is given by the density of allowed quantum states times the probability that a state is occupied by an electron. This statement is written in equation form as

\[ n(E) = g_c(E) f_F(E) \]  \hspace{1cm} (4.1)

where \( f_F(E) \) is the Fermi–Dirac probability function and \( g_c(E) \) is the density of quantum states in the conduction band. The total electron concentration per unit volume in the conduction band is then found by integrating Equation (4.1) over the entire conduction-band energy.

Similarly, the distribution (with respect to energy) of holes in the valence band is the density of allowed quantum states in the valence band multiplied by the probability that a state is not occupied by an electron. We may express this as

\[ p(E) = g_v(E)[1 - f_F(E)] \]  \hspace{1cm} (4.2)

The total hole concentration per unit volume is found by integrating this function over the entire valence-band energy.

To find the thermal-equilibrium electron and hole concentrations, we need to determine the position of the Fermi energy \( E_F \) with respect to the bottom of the conduction-band energy \( E_c \) and the top of the valence-band energy \( E_v \). To address this question, we will initially consider an intrinsic semiconductor. An ideal intrinsic semiconductor is a pure semiconductor with no impurity atoms and no lattice defects in the crystal (e.g., pure silicon). We have argued in the previous chapter that, for an intrinsic semiconductor at \( T = 0 \) K, all energy states in the valence band are filled with electrons and all energy states in the conduction band are empty of electrons. The Fermi energy must, therefore, be somewhere between \( E_c \) and \( E_v \). (The Fermi energy does not need to correspond to an allowed energy.)

As the temperature begins to increase above 0 K, the valence electrons will gain thermal energy. A few electrons in the valence band may gain sufficient energy to jump to the conduction band. As an electron jumps from the valence band to the conduction band, an empty state, or hole, is created in the valence band. In an intrinsic semiconductor, then, electrons and holes are created in pairs by the thermal energy so
4.1 Charge Carriers in Semiconductors

Figure 4.11 (a) Density of states functions, Fermi-Dirac probability function, and areas representing electron and hole concentrations for the case when $E_F$ is near the midgap energy; (b) expanded view near the conduction band energy; and (c) expanded view near the valence band energy.

that the number of electrons in the conduction band is equal to the number of holes in the valence band.

Figure 4.1a shows a plot of the density of states function in the conduction band $g_c(E)$, the density of states function in the valence band $g_v(E)$, and the Fermi-Dirac probability function for $T > 0$ K when $E_F$ is approximately halfway between $E_c$ and $E_v$. If we assume, for the moment, that the electron and hole effective masses are equal, then $g_c(E)$ and $g_v(E)$ are symmetrical functions about the midgap energy (the energy midway between $E_c$ and $E_v$). We noted previously that the function $f_F(E)$ for $E > E_F$ is symmetrical to the function $1 - f_F(E)$ for $E < E_F$ about the energy $E = E_F$. This also means that the function $f_F(E)$ for $E = E_F + dE$ is equal to the function $1 - f_F(E)$ for $E = E_F - dE$. 
Figure 4.1b is an expanded view of the plot in Figure 4.1a showing \( f_F(E) \) and \( g_c(E) \) above the conduction band energy \( E_c \). The product of \( g_c(E) \) and \( f_F(E) \) is the distribution of electrons \( n(E) \) in the conduction band given by Equation (4.1). This product is plotted in Figure 4.1a. Figure 4.1c is an expanded view of the plot in Figure 4.1a showing \( [1 - f_F(E)] \) and \( g_v(E) \) below the valence band energy \( E_v \). The product of \( g_v(E) \) and \( [1 - f_F(E)] \) is the distribution of holes \( p(E) \) in the valence band given by Equation (4.2). This product is also plotted in Figure 4.1a. The areas under these curves are then the total density of electrons in the conduction band and the total density of holes in the valence band. From this we see that if \( g_c(E) \) and \( g_v(E) \) are symmetrical, the Fermi energy must be at the midgap energy in order to obtain equal electron and hole concentrations. If the effective masses of the electron and hole are not exactly equal, then the effective density of states functions \( g_c(E) \) and \( g_v(E) \) will not be exactly symmetrical about the midgap energy. The Fermi level for the intrinsic semiconductor will then shift slightly from the midgap energy in order to obtain equal electron and hole concentrations.

4.1.2 The \( n_0 \) and \( p_0 \) Equations

We have argued that the Fermi energy for an intrinsic semiconductor is near midgap. In deriving the equations for the thermal-equilibrium concentration of electrons \( n_0 \) and the thermal-equilibrium concentration of holes \( p_0 \), we will not be quite so restrictive. We will see later that, in particular situations, the Fermi energy can deviate from this midgap energy. We will assume initially, however, that the Fermi level remains within the bandgap energy.

The equation for the thermal-equilibrium concentration of electrons may be found by integrating Equation (4.1) over the conduction band energy, or

\[
n_0 = \int g_c(E) f_F(E) \, dE
\]

The lower limit of integration is \( E_c \) and the upper limit of integration should be the top of the allowed conduction band energy. However, since the Fermi probability function rapidly approaches zero with increasing energy as indicated in Figure 4.1a, we can take the upper limit of integration to be infinity.

We are assuming that the Fermi energy is within the forbidden-energy bandgap. For electrons in the conduction band, we have \( E > E_c \). If \( (E_c - E_F) \gg kT \), then \( (E - E_F) \gg kT \), so that the Fermi probability function reduces to the Boltzmann approximation,\(^1\) which is

\[
f_F(E) = \frac{1}{1 + \exp \left( \frac{E - E_F}{kT} \right)} \approx \exp \left[ -\frac{(E - E_F)}{kT} \right]
\]

\(^1\)The Maxwell-Boltzmann and Fermi-Dirac distribution functions are within 5 percent of each other when \( E - E_F \approx 3kT \) (see Figure 3.33). The \( \gg \) notation is then somewhat misleading to indicate when the Boltzmann approximation is valid, although it is commonly used.
Applying the Boltzmann approximation to Equation (4.3), the thermal-equilibrium density of electrons in the conduction band is found from

\[ n_0 = \int_{E_c}^{\infty} \frac{4\pi (2m^*_n)^{3/2}}{h^3} \sqrt{E - E_c} \exp \left[ -\frac{(E - E_F)}{kT} \right] dE \]  

(4.5)

The integral of Equation (4.5) may be solved more easily by making a change of variable. If we let

\[ \eta = \frac{E - E_c}{kT} \]

(4.6)

then Equation (4.5) becomes

\[ n_0 = \frac{4\pi (2m^*_n kT)^{3/2}}{h^3} \exp \left[ -\frac{(E_c - E_F)}{kT} \right] \int_{0}^{\infty} \eta^{1/2} \exp (-\eta) d\eta \]  

(4.7)

The integral is the gamma function, with a value of

\[ \int_{0}^{\infty} \eta^{1/2} \exp (-\eta) d\eta = \frac{1}{2} \sqrt{\pi} \]  

(4.8)

Then Equation (4.7) becomes

\[ n_0 = 2 \left( \frac{2\pi m^*_n kT}{h^2} \right)^{3/2} \exp \left[ -\frac{(E_c - E_F)}{kT} \right] \]  

(4.9)

We may define a parameter \( N_c \) as

\[ N_c = 2 \left( \frac{2\pi m^*_n kT}{h^2} \right)^{3/2} \]

(4.10)

so that the thermal-equilibrium electron concentration in the conduction band can be written as

\[ n_0 = N_c \exp \left[ -\frac{(E_c - E_F)}{kT} \right] \]  

(4.11)

The parameter \( N_c \) is called the effective density of states function in the conduction band. If we were to assume that \( m^*_n = m_0 \), then the value of the effective density of states function at \( T = 300 \) K is \( N_c = 2.5 \times 10^{19} \) cm\(^{-3} \), which is the order of magnitude of \( N_c \) for most semiconductors. If the effective mass of the electron is larger or smaller than \( m_0 \), then the value of the effective density of states function changes accordingly, but is still of the same order of magnitude.

**Objective**

Calculate the probability that a state in the conduction band is occupied by an electron and calculate the thermal equilibrium electron concentration in silicon at \( T = 300 \) K.

Assume the Fermi energy is 0.25 eV below the conduction band. The value of \( N_c \) for silicon at \( T = 300 \) K is \( N_c = 2.8 \times 10^{19} \) cm\(^{-3} \).
**Solution**

The probability that an energy state at \( E = E_c \) is occupied by an electron is given by

\[
f_F(E_c) = \frac{1}{1 + \exp \left( \frac{E_c - E_F}{kT} \right)} \approx \exp \left[ -\frac{(E_c - E_F)}{kT} \right]
\]

or

\[
f_F(E_c) = \exp \left( \frac{-0.25}{0.0259} \right) = 6.43 \times 10^{-5}
\]

The electron concentration is given by

\[
n_0 = N_e \exp \left[ -\frac{(E_c - E_F)}{kT} \right] = (2.8 \times 10^{19}) \exp \left( \frac{-0.25}{0.0259} \right)
\]

or

\[
n_0 = 1.8 \times 10^{15} \text{ cm}^{-3}
\]

**Comment**

The probability of a state being occupied can be quite small, but the fact that there are a large number of states means that the electron concentration is a reasonable value.

The thermal-equilibrium concentration of holes in the valence band is found by integrating Equation (4.2) over the valence band energy, or

\[
p_0 = \int g_v(E) [1 - f_F(E)] \, dE
\]  

(4.12)

We may note that

\[
1 - f_F(E) = \frac{1}{1 + \exp \left( \frac{E_F - E}{kT} \right)}
\]  

(4.13a)

For energy states in the valence band, \( E < E_0 \). If \( (E_F - E_v) \gg kT \) (the Fermi function is still assumed to be within the bandgap), then we have a slightly different form of the Boltzmann approximation. Equation (4.13a) may be written as

\[
1 - f_F(E) = \frac{1}{1 + \exp \left( \frac{E_F - E}{kT} \right)} \approx \exp \left[ -\frac{(E_F - E)}{kT} \right]
\]  

(4.13b)

Applying the Boltzmann approximation of Equation (4.13b) to Equation (4.12), we find the thermal-equilibrium concentration of holes in the valence band is

\[
p_0 = \int_{-\infty}^{E_v} \frac{4\pi(2m_p^*)^{3/2}}{\hbar^3} \sqrt{E_v - E} \exp \left[ -\frac{(E_F - E)}{kT} \right] \, dE
\]  

(4.14)
where the lower limit of integration is taken as minus infinity instead of the bottom of the valence band. The exponential term decays fast enough so that this approximation is valid.

Equation (4.14) may be solved more easily by again making a change of variable. If we let

\[ \eta' = \frac{E_v - E}{kT} \]  

(4.15)

then Equation (4.14) becomes

\[ p_0 = \frac{-4\pi (2m^*_p kT)^{3/2}}{h^3} \exp \left[ \frac{-\left(E_F - E_v\right)}{kT} \right] \int_{\eta'}^{\infty} (\eta')^{1/2} \exp (-\eta') d\eta' \]  

(4.16)

where the negative sign comes from the differential \( dE = -kT d\eta' \). Note that the lower limit of \( \eta' \) becomes \(+\infty\) when \( E = -\infty \). If we change the order of integration, we introduce another minus sign. From Equation (4.8), Equation (4.16) becomes

\[ p_0 = 2 \left( \frac{2\pi m^*_p kT}{h^2} \right)^{3/2} \exp \left[ \frac{-\left(E_F - E_v\right)}{kT} \right] \]  

(4.17)

We may define a parameter \( N_v \) as

\[ N_v = 2 \left( \frac{2\pi m^*_p kT}{h^2} \right)^{3/2} \]  

(4.18)

which is called the effective density of states function in the valence band. The thermal-equilibrium concentration of holes in the valence band may now be written as

\[ p_0 = N_v \exp \left[ \frac{-\left(E_F - E_v\right)}{kT} \right] \]  

(4.19)

The magnitude of \( N_v \) is also on the order of \( 10^{19} \text{ cm}^{-3} \) at \( T = 300 \text{ K} \) for most semiconductors.

---

**Objective**

**EXAMPLE 4.2**

Calculate the thermal equilibrium hole concentration in silicon at \( T = 400 \text{ K} \).

Assume that the Fermi energy is 0.27 eV above the valence band energy. The value of \( N_v \) for silicon at \( T = 300 \text{ K} \) is \( N_v = 1.04 \times 10^{19} \text{ cm}^{-3} \).

**Solution**

The parameter values at \( T = 400 \text{ K} \) are found as:

\[ N_v = (1.04 \times 10^{19}) \left( \frac{400}{300} \right)^{3/2} = 1.60 \times 10^{19} \text{ cm}^{-3} \]

and

\[ kT = (0.0259) \left( \frac{400}{300} \right) = 0.03453 \text{ eV} \]
The hole concentration is then
\[ p_0 = N_c \exp \left[ \frac{-(E_c - E_v)}{kT} \right] = (1.60 \times 10^{19}) \exp \left( \frac{-0.27}{0.03453} \right) \]
or
\[ p_0 = 6.43 \times 10^{15} \text{ cm}^{-3} \]

**Comment**

The parameter values at any temperature can easily be found by using the 300 K values and the temperature dependence.

The effective density of states functions, \( N_c \) and \( N_v \), are constant for a given semiconductor material at a fixed temperature. Table 4.1 gives the values of the density of states function and of the effective masses for silicon, gallium arsenide, and germanium. Note that the value of \( N_c \) for gallium arsenide is smaller than the typical \( 10^{19} \text{ cm}^{-3} \) value. This difference is due to the small electron effective mass in gallium arsenide.

The thermal equilibrium concentrations of electrons in the conduction band and of holes in the valence band are directly related to the effective density of states constants and to the Fermi energy level.

**TEST YOUR UNDERSTANDING**

**E4.1** Calculate the thermal equilibrium electron and hole concentration in silicon at \( T = 300 \text{ K} \) for the case when the Fermi energy level is 0.22 eV below the conduction band energy \( E_c \). The value of \( E_c \) is given in Appendix B.4.

**E4.2** Determine the thermal equilibrium electron and hole concentration in GaAs at \( T = 300 \text{ K} \) for the case when the Fermi energy level is 0.30 eV above the valence band energy \( E_v \). The value of \( E_v \) is given in Appendix B.4.

**4.1.3 The Intrinsic Carrier Concentration**

For an intrinsic semiconductor, the concentration of electrons in the conduction band is equal to the concentration of holes in the valence band. We may denote \( n_i \) and \( p_i \).

<table>
<thead>
<tr>
<th><strong>Table 4.1</strong></th>
<th>Effective density of states function and effective mass values</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>( N_c ) (cm(^{-3}))</td>
</tr>
<tr>
<td>Silicon</td>
<td>( 2.8 \times 10^{19} )</td>
</tr>
<tr>
<td>Gallium arsenide</td>
<td>( 4.7 \times 10^{17} )</td>
</tr>
<tr>
<td>Germanium</td>
<td>( 1.04 \times 10^{19} )</td>
</tr>
</tbody>
</table>
as the electron and hole concentrations, respectively, in the intrinsic semiconductor. These parameters are usually referred to as the intrinsic electron concentration and intrinsic hole concentration. However, \( n_i = p_i \), so normally we simply use the parameter \( n_i \) as the intrinsic carrier concentration, which refers to either the intrinsic electron or hole concentration.

The Fermi energy level for the intrinsic semiconductor is called the intrinsic Fermi energy, or \( E_F = E_{Fi} \). If we apply Equations (4.11) and (4.19) to the intrinsic semiconductor, then we can write

\[
n_0 = n_i = N_c \exp \left[ \frac{-(E_c - E_{Fi})}{kT} \right] \tag{4.20}
\]

and

\[
p_0 = p_i = n_i = N_v \exp \left[ \frac{-(E_{Fi} - E_v)}{kT} \right] \tag{4.21}
\]

If we take the product of Equations (4.20) and (4.21), we obtain

\[
n_i^2 = N_c N_v \exp \left[ \frac{-(E_c - E_{Fi})}{kT} \right] \exp \left[ \frac{-(E_{Fi} - E_v)}{kT} \right] \tag{4.22}
\]

or

\[
n_i^2 = N_c N_v \exp \left[ \frac{-(E_c - E_{Fi})}{kT} \right] = N_c N_v \exp \left[ \frac{E_g}{kT} \right] \tag{4.23}
\]

where \( E_g \) is the bandgap energy. For a given semiconductor material at a constant temperature, the value of \( n_i \) is a constant, and independent of the Fermi energy.

The intrinsic carrier concentration for silicon at \( T = 300 \) K may be calculated by using the effective density of states function values from Table 4.1. The value of \( n_i \) calculated from Equation (4.23) for \( E_g = 1.12 \) eV is \( n_i = 6.95 \times 10^{10} \) cm\(^{-3}\). The commonly accepted value\(^2\) of \( n_i \) for silicon at \( T = 300 \) K is approximately \( 1.5 \times 10^{10} \) cm\(^{-3}\). This discrepancy may arise from several sources. First, the values of the effective masses are determined at a low temperature where the cyclotron resonance experiments are performed. Since the effective mass is an experimentally determined parameter, and since the effective mass is a measure of how well a particle moves in a crystal, this parameter may be a slight function of temperature. Next, the density of states function for a semiconductor was obtained by generalizing the model of an electron in a three-dimensional infinite potential well. This theoretical function may also not agree exactly with experiment. However, the difference between the theoretical value and the experimental value of \( n_i \) is approximately a factor

\(\text{\footnote{Various references may list slightly different values of the intrinsic silicon concentration at room temperature. In general, they are all between }1 \times 10^{10}\text{ and }1.5 \times 10^{10}\text{ cm}^{-3}. \text{ This difference is, in most cases, not significant.}}\)
Table 4.2 | Commonly accepted values of $n_i$ at $T = 300$ K

<table>
<thead>
<tr>
<th></th>
<th>$n_i$</th>
</tr>
</thead>
<tbody>
<tr>
<td>Silicon</td>
<td>$1.5 \times 10^{10}$ cm$^{-3}$</td>
</tr>
<tr>
<td>Gallium arsenide</td>
<td>$1.8 \times 10^{6}$ cm$^{-3}$</td>
</tr>
<tr>
<td>Germanium</td>
<td>$2.4 \times 10^{13}$ cm$^{-3}$</td>
</tr>
</tbody>
</table>

of 2, which, in many cases, is not significant. Table 4.2 lists the commonly accepted values of $n_i$ for silicon, gallium arsenide, and germanium at $T = 300$ K.

The intrinsic carrier concentration is a very strong function of temperature.

**EXAMPLE 4.3**

**Objective**

To calculate the intrinsic carrier concentration in gallium arsenide at $T = 300$ K and at $T = 450$ K.

The values of $N_c$ and $N_v$ at 300 K for gallium arsenide are $4.7 \times 10^{17}$ cm$^{-3}$ and $7.0 \times 10^{18}$ cm$^{-3}$, respectively. Both $N_c$ and $N_v$ vary as $T^{3/2}$. Assume the bandgap energy of gallium arsenide is 1.42 eV and does not vary with temperature over this range. The value of $kT$ at 450 K is

$$kT = (0.0259) \left(\frac{450}{300}\right) = 0.03885 \text{ eV}$$

**Solution**

Using Equation (4.23), we find for $T = 300$ K

$$n_i^2 = (4.7 \times 10^{17})(7.0 \times 10^{18}) \exp\left(\frac{-1.42}{0.0259}\right) = 5.09 \times 10^{12}$$

so that

$$n_i = 2.26 \times 10^6 \text{ cm}^{-3}$$

At $T = 450$ K, we find

$$n_i^2 = (4.7 \times 10^{17})(7.0 \times 10^{18}) \left(\frac{450}{300}\right)^3 \exp\left(\frac{-1.42}{0.03885}\right) = 1.48 \times 10^{21}$$

so that

$$n_i = 3.85 \times 10^{10} \text{ cm}^{-3}$$

**Comment**

We may note from this example that the intrinsic carrier concentration increased by over 4 orders of magnitude as the temperature increased by 150°C.

Figure 4.2 is a plot of $n_i$ from Equation (4.23) for silicon, gallium arsenide, and germanium as a function of temperature. As seen in the figure, the value of $n_i$ for these semiconductors may easily vary over several orders of magnitude as the temperature changes over a reasonable range.
4.1 Charge Carriers in Semiconductors

Figure 4.2 The intrinsic carrier concentration of Ge, Si, and GaAs as a function of temperature.

(From Sze [13].)

**TEST YOUR UNDERSTANDING**

E4.3 Find the intrinsic carrier concentration in silicon at (a) \( T = 200 \text{ K} \) and (b) \( T = 400 \text{ K} \).

\[
\left[ n_{\text{Si}} \right] \times 8 \times 10^7 (\text{cm}^{-3})
\]

E4.4 Repeat E4.3 for GaAs.

\[
\left[ n_{\text{GaAs}} \right] \times 8 \times 10^7 (\text{cm}^{-3})
\]

E4.5 Repeat E4.3 for Ge.

\[
\left[ n_{\text{Ge}} \right] \times 9 \times 10^7 (\text{cm}^{-3})
\]

4.1.4 The Intrinsic Fermi-Level Position

We have qualitatively argued that the Fermi energy level is located near the center of the forbidden bandgap for the intrinsic semiconductor. We can specifically calculate
the intrinsic Fermi-level position. Since the electron and hole concentrations are equal, setting Equations (4.20) and (4.21) equal to each other, we have

$$N_c \exp\left[\frac{-(E_c - E_{F_i})}{kT}\right] = N_v \exp\left[\frac{-(E_{F_i} - E_v)}{kT}\right]$$

(4.24)

If we take the natural log of both sides of this equation and solve for $E_{F_i}$, we obtain

$$E_{F_i} = \frac{1}{2} (E_c + E_v) + \frac{1}{2} kT \ln \left(\frac{N_v}{N_c}\right)$$

(4.25)

From the definitions for $N_c$ and $N_v$ given by Equations (4.10) and (4.18), respectively, Equation (4.25) may be written as

$$E_{F_i} = \frac{1}{2} (E_c + E_v) + \frac{3}{4} kT \ln \left(\frac{m_p^*}{m_n^*}\right)$$

(4.26a)

The first term, $\frac{1}{2} (E_c + E_v)$, is the energy exactly midway between $E_c$ and $E_v$, or the midgap energy. We can define

$$\frac{1}{2} (E_c + E_v) = E_{\text{midgap}}$$

so that

$$E_{F_i} - E_{\text{midgap}} = \frac{3}{4} kT \ln \left(\frac{m_p^*}{m_n^*}\right)$$

(4.26b)

If the electron and hole effective masses are equal so that $m_p^* = m_n^*$, then the intrinsic Fermi level is exactly in the center of the bandgap. If $m_p^* > m_n^*$, the intrinsic Fermi level is slightly above the center, and if $m_p^* < m_n^*$, it is slightly below the center of the bandgap. The density of states function is directly related to the carrier effective mass; thus a larger effective mass means a larger density of states function. The intrinsic Fermi level must shift away from the band with the larger density of states in order to maintain equal numbers of electrons and holes.

**Example 4.4**

**Objective**

To calculate the position of the intrinsic Fermi level with respect to the center of the bandgap in silicon at $T = 300$ K.

The density of states effective carrier masses in silicon are $m_p^* = 1.08m_0$ and $m_n^* = 0.56m_0$.

**Solution**

The intrinsic Fermi level with respect to the center of the bandgap is

$$E_{F_i} - E_{\text{midgap}} = \frac{3}{4} kT \ln \left(\frac{m_p^*}{m_n^*}\right) = \frac{3}{4} (0.0259) \ln \left(\frac{0.56}{1.08}\right)$$
or

\[ E_{F_i} - E_{\text{midgap}} = -0.0128 \, \text{eV} = -12.8 \, \text{meV} \]

**Comment**
The intrinsic Fermi level in silicon is 12.8 meV below the midgap energy. If we compare 12.8 meV to 560 meV, which is one-half of the bandgap energy of silicon, we can, in many applications, simply approximate the intrinsic Fermi level to be in the center of the bandgap.

---

**TEST YOUR UNDERSTANDING**

**E4.6** Determine the position of the intrinsic Fermi level with respect to the center of the bandgap in GaAs at \( T = 300 \, \text{K} \). (Answer: 0.25 \text{eV})

---

### 4.2 | DOPANT ATOMS AND ENERGY LEVELS

The intrinsic semiconductor may be an interesting material, but the real power of semiconductors is realized by adding small, controlled amounts of specific dopant, or impurity, atoms. This doping process, described briefly in Chapter 1, can greatly alter the electrical characteristics of the semiconductor. The doped semiconductor, called an extrinsic material, is the primary reason we can fabricate the various semiconductor devices that we will consider in later chapters.

#### 4.2.1 Qualitative Description

In Chapter 3, we discussed the covalent bonding of silicon and considered the simple two-dimensional representation of the single-crystal silicon lattice as shown in Figure 4.3. Now consider adding a group V element, such as phosphorus, as a substitutional impurity. The group V element has five valence electrons. Four of these will contribute to the covalent bonding with the silicon atoms, leaving the fifth more loosely bound to the phosphorus atom. This effect is schematically shown in Figure 4.4. We refer to the fifth valence electron as a donor electron.

![Figure 4.3](image1.png) Two-dimensional representation of the intrinsic silicon lattice.

![Figure 4.4](image2.png) Two-dimensional representation of the silicon lattice doped with a phosphorus atom.
The phosphorus atom without the donor electron is positively charged. At very low temperatures, the donor electron is bound to the phosphorus atom. However, by intuition, it should seem clear that the energy required to elevate the donor electron into the conduction band is considerably less than that for the electrons involved in the covalent bonding. Figure 4.5 shows the energy-band diagram that we would expect. The energy level, $E_d$, is the energy state of the donor electron.

If a small amount of energy, such as thermal energy, is added to the donor electron, it can be elevated into the conduction band, leaving behind a positively charged phosphorus ion. The electron in the conduction band can now move through the crystal generating a current, while the positively charged ion is fixed in the crystal. This type of impurity atom donates an electron to the conduction band and so is called a donor impurity atom. The donor impurity atoms add electrons to the conduction band without creating holes in the valence band. The resulting material is referred to as an $n$-type semiconductor ($n$ for the negatively charged electron).

Now consider adding a group III element, such as boron, as a substitutional impurity to silicon. The group III element has three valence electrons, which are all taken up in the covalent bonding. As shown in Figure 4.6a, one covalent bonding position appears to be empty. If an electron were to occupy this “empty” position, its
4.2 Dopant Atoms and Energy Levels

Figure 4.6b shows how valence electrons may gain a small amount of thermal energy and move about in the crystal. The "empty" position associated with the boron atom becomes occupied, and other valence electron positions become vacated. These other vacated electron positions can be thought of as holes in the semiconductor material.

Figure 4.7 shows the expected energy state of the "empty" position and also the formation of a hole in the valence band. The hole can move through the crystal generating a current, while the negatively charged boron atom is fixed in the crystal. The group III atom accepts an electron from the valence band and so is referred to as an acceptor impurity atom. The acceptor atom can generate holes in the valence band without generating electrons in the conduction band. This type of semiconductor material is referred to as a p-type material (p for the positively charged hole).

The pure single-crystal semiconductor material is called an intrinsic material. Adding controlled amounts of dopant atoms, either donors or acceptors, creates a material called an extrinsic semiconductor. An extrinsic semiconductor will have either a preponderance of electrons (n type) or a preponderance of holes (p type).

4.2.2 Ionization Energy

We can calculate the approximate distance of the donor electron from the donor impurity ion, and also the approximate energy required to elevate the donor electron into the conduction band. This energy is referred to as the ionization energy. We will use the Bohr model of the atom for these calculations. The justification for using this model is that the most probable distance of an electron from the nucleus in a hydrogen atom, determined from quantum mechanics, is the same as the Bohr radius. The energy levels in the hydrogen atom determined from quantum mechanics are also the same as obtained from the Bohr theory.

In the case of the donor impurity atom, we may visualize the donor electron orbiting the donor ion, which is embedded in the semiconductor material. We will need to use the permittivity of the semiconductor material in the calculations rather than...
the permittivity of free space as is used in the case of the hydrogen atom. We will use the effective mass of the electron in the calculations.

The analysis begins by setting the coulomb force of attraction between the electron and ion equal to the centripetal force of the orbiting electron. This condition will give a steady orbit. We have

\[ \frac{e^2}{4\pi \varepsilon r_n^2} = \frac{m^* v^2}{r_n} \]  

(4.28)

where \( v \) is the magnitude of the velocity and \( r_n \) is the radius of the orbit. If we assume the angular momentum is also quantized, then we can write

\[ m^* r_n v = n\hbar \]

(4.27)

where \( n \) is a positive integer. Solving for \( v \) from Equation (4.28), substituting in Equation (4.27), and solving for the radius, we obtain

\[ r_n = \frac{n^2 \hbar^2 4\pi \varepsilon}{m^* e^2} \]

(4.29)

The assumption of the angular momentum being quantized leads to the radius also being quantized.

The Bohr radius is defined as

\[ a_0 = \frac{4\pi \varepsilon_0 \hbar^2}{m_0 e^2} = 0.53 \, \text{Å} \]

(4.30)

We can normalize the radius of the donor orbital to that of the Bohr radius, which gives

\[ \frac{r_n}{a_0} = n^2 \varepsilon_r \left( \frac{m_0}{m^*} \right) \]

(4.31)

where \( \varepsilon_r \) is the relative dielectric constant of the semiconductor material, \( m_0 \) is the rest mass of an electron, and \( m^* \) is the conductivity effective mass of the electron in the semiconductor.

If we consider the lowest energy state in which \( n = 1 \), and if we consider silicon in which \( \varepsilon_r = 11.7 \) and the conductivity effective mass is \( m^*/m_0 = 0.26 \), then we have that

\[ \frac{r_1}{a_0} = 45 \]

(4.32)

or \( r_1 = 23.9 \, \text{Å} \). This radius corresponds to approximately four lattice constants in silicon. Recall that one unit cell in silicon effectively contains eight atoms, so the radius of the orbiting donor electron encompasses many silicon atoms. The donor electron is not tightly bound to the donor atom.

The total energy of the orbiting electron is given by

\[ E = T + V \]

(4.33)
where $T$ is the kinetic energy and $V$ is the potential energy of the electron. The kinetic energy is

$$T = \frac{1}{2} m^* u^2$$  \hspace{1cm} (4.34)

Using the velocity $u$ from Equation (4.28) and the radius $r_n$ from Equation (4.29), the kinetic energy becomes

$$T = -\frac{m^* e^4}{2(n\hbar)^2 (4\pi \epsilon)^2}$$  \hspace{1cm} (4.35)

The potential energy is

$$V = -\frac{e^2}{4\pi \epsilon r_n} = -\frac{m^* e^4}{(n\hbar)^2 (4\pi \epsilon)^2}$$  \hspace{1cm} (4.36)

The total energy is the sum of the kinetic and potential energies, so that

$$E = T + V = -\frac{m^* e^4}{2(n\hbar)^2 (4\pi \epsilon)^2}$$  \hspace{1cm} (4.37)

For the hydrogen atom, $m^* = m_0$ and $\epsilon = \epsilon_0$. The ionization energy of the hydrogen atom in the lowest energy state is then $E = -13.6$ eV. If we consider silicon, the ionization energy is $E = -25.8$ meV, much less than the bandgap energy of silicon. This energy is the approximate ionization energy of the donor atom, or the energy required to elevate the donor electron into the conduction band.

For ordinary donor impurities such as phosphorus or arsenic in silicon or germanium, this hydrogenic model works quite well and gives some indication of the magnitudes of the ionization energies involved. Table 4.3 lists the actual experimentally measured ionization energies for a few impurities in silicon and germanium. Germanium and silicon have different relative dielectric constants and effective masses; thus we expect the ionization energies to differ.

**4.2.3 Group III–V Semiconductors**

In the previous sections, we have been discussing the donor and acceptor impurities in a group IV semiconductor, such as silicon. The situation in the group III–V

<table>
<thead>
<tr>
<th>Impurity</th>
<th>Ionization energy (eV)</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Donors</strong></td>
<td>Si</td>
</tr>
<tr>
<td>Phosphorus</td>
<td>0.045</td>
</tr>
<tr>
<td>Arsenic</td>
<td>0.05</td>
</tr>
<tr>
<td><strong>Acceptors</strong></td>
<td></td>
</tr>
<tr>
<td>Boron</td>
<td>0.045</td>
</tr>
<tr>
<td>Aluminum</td>
<td>0.06</td>
</tr>
</tbody>
</table>
CHAPTER 4 The Semiconductor in Equilibrium

Table 4.4 | Impurity ionization energies in gallium arsenide

<table>
<thead>
<tr>
<th>Impurity</th>
<th>Ionization energy (eV)</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Donors</strong></td>
<td></td>
</tr>
<tr>
<td>Selenium</td>
<td>0.0059</td>
</tr>
<tr>
<td>Tellurium</td>
<td>0.0058</td>
</tr>
<tr>
<td>Silicon</td>
<td>0.0058</td>
</tr>
<tr>
<td>Germanium</td>
<td>0.0061</td>
</tr>
<tr>
<td><strong>Acceptors</strong></td>
<td></td>
</tr>
<tr>
<td>Beryllium</td>
<td>0.028</td>
</tr>
<tr>
<td>Zinc</td>
<td>0.0307</td>
</tr>
<tr>
<td>Cadmium</td>
<td>0.0347</td>
</tr>
<tr>
<td>Silicon</td>
<td>0.0345</td>
</tr>
<tr>
<td>Germanium</td>
<td>0.0404</td>
</tr>
</tbody>
</table>

compound semiconductors, such as gallium arsenide, is more complicated. Group III elements, such as beryllium, zinc, and cadmium, can enter the lattice as substitutional impurities, replacing the group III gallium element to become acceptor impurities. Similarly, group VI elements, such as selenium and tellurium, can enter the lattice substitutionally, replacing the group V arsenic element to become donor impurities. The corresponding ionization energies for these impurities are smaller than for the impurities in silicon. The ionization energies for the donors in gallium arsenide are also smaller than the ionization energies for the acceptors, because of the smaller effective mass of the electron compared to that of the hole.

Group IV elements, such as silicon and germanium, can also be impurity atoms in gallium arsenide. If a silicon atom replaces a gallium atom, the silicon impurity will act as a donor, but if the silicon atom replaces an arsenic atom, then the silicon impurity will act as an acceptor. The same is true for germanium as an impurity atom. Such impurities are called *amphoteric*. Experimentally in gallium arsenide, it is found that germanium is predominantly an acceptor and silicon is predominantly a donor. Table 4.4 lists the ionization energies for the various impurity atoms in gallium arsenide.

TEST YOUR UNDERSTANDING

E4.7 Calculate the radius (normalized to a Bohr radius) of a donor electron in its lowest energy state in GaAs. (5.61 Å)

4.3 | THE EXTRINSIC SEMICONDUCTOR

We defined an intrinsic semiconductor as a material with no impurity atoms present in the crystal. An *extrinsic semiconductor* is defined as a semiconductor in which controlled amounts of specific dopant or impurity atoms have been added so that the thermal-equilibrium electron and hole concentrations are different from the intrinsic...
4.3 The Extrinsic Semiconductor

4.3.1 Equilibrium Distribution of Electrons and Holes

Adding donor or acceptor impurity atoms to a semiconductor will change the distribution of electrons and holes in the material. Since the Fermi energy is related to the distribution function, the Fermi energy will change as dopant atoms are added. If the Fermi energy changes from near the midgap value, the density of electrons in the conduction band and the density of holes in the valence band will change. These effects are shown in Figures 4.8 and 4.9. Figure 4.8 shows the case for $E_F > E_{Fi}$ and Figure 4.9 shows the case for $E_F < E_{Fi}$. When $E_F > E_{Fi}$, the electron concentration is larger than the hole concentration, and when $E_F < E_{Fi}$, the hole concentration...
is larger than the electron concentration. When the density of electrons is greater than the density of holes, the semiconductor is n type; donor impurity atoms have been added. When the density of holes is greater than the density of electrons, the semiconductor is p type; acceptor impurity atoms have been added. The Fermi energy level in a semiconductor changes as the electron and hole concentrations change and, again, the Fermi energy changes as donor or acceptor impurities are added. The change in the Fermi level as a function of impurity concentrations will be considered in Section 4.6.

The expressions previously derived for the thermal-equilibrium concentration of electrons and holes, given by Equations (4.11) and (4.19) are general equations for \( n_0 \) and \( p_0 \) in terms of the Fermi energy. These equations are again given as

\[
\begin{align*}
n_0 &= N_c \exp \left[ \frac{-\left( E_c - E_F \right)}{kT} \right] \\
p_0 &= N_v \exp \left[ \frac{-\left( E_v - E_F \right)}{kT} \right]
\end{align*}
\]
and

\[ p_0 = N_b \exp \left[ -\frac{(E_F - E_c)}{kT} \right] \]

As we just discussed, the Fermi energy may vary through the bandgap energy, which will then change the values of \( n_0 \) and \( p_0 \).

---

**Objective**

To calculate the thermal equilibrium concentrations of electrons and holes for a given Fermi energy.

Consider silicon at \( T = 300 \text{ K} \) so that \( N_c = 2.8 \times 10^{19} \text{ cm}^{-3} \) and \( N_v = 1.04 \times 10^{15} \text{ cm}^{-3} \). Assume that the Fermi energy is 0.25 eV below the conduction band. If we assume that the bandgap energy of silicon is 1.12 eV, then the Fermi energy will be 0.87 eV above the valence band.

**Solution**

Using Equation (4.11), we have

\[ n_0 = (2.8 \times 10^{19}) \exp \left( \frac{-0.25}{0.0259} \right) = 1.8 \times 10^{15} \text{ cm}^{-3} \]

From Equation (4.19), we can write

\[ p_0 = (1.04 \times 10^{16}) \exp \left( \frac{-0.87}{0.0259} \right) = 2.7 \times 10^{4} \text{ cm}^{-3} \]

**Comment**

The change in the Fermi level is actually a function of the donor or acceptor impurity concentrations that are added to the semiconductor. However, this example shows that electron and hole concentrations change by orders of magnitude from the intrinsic carrier concentration as the Fermi energy changes by a few tenths of an electron-volt.

In this example, since \( n_0 > p_0 \), the semiconductor is n type. In an n-type semiconductor, electrons are referred to as the majority carrier and holes as the minority carrier. By comparing the relative values of \( n_0 \) and \( p_0 \) in the example, it is easy to see how this designation came about. Similarly, in a p-type semiconductor where \( p_0 > n_0 \), holes are the majority carrier and electrons are the minority carrier.

We may derive another form of the equations for the thermal-equilibrium concentrations of electrons and holes. If we add and subtract an intrinsic Fermi energy in the exponent of Equation (4.11), we can write

\[ n_0 = N_c \exp \left[ \frac{-(E_c - E_{Fi}) + (E_F - E_{Fi})}{kT} \right] \]  

(4.38a)

or

\[ n_0 = N_c \exp \left[ -\frac{(E_c - E_{Fi})}{kT} \right] \exp \left[ \frac{(E_F - E_{Fi})}{kT} \right] \]  

(4.38b)
The intrinsic carrier concentration is given by Equation (4.20) as

\[ n_i = N_c \exp \left( \frac{- (E_c - E_{Fi})}{kT} \right) \]

so that the thermal-equilibrium electron concentration can be written as

\[ n_0 = n_i \exp \left( \frac{E_F - E_{Fi}}{kT} \right) \quad (4.39) \]

Similarly, if we add and subtract an intrinsic Fermi energy in the exponent of Equation (4.19), we will obtain

\[ p_0 = n_i \exp \left( \frac{- (E_F - E_{Fi})}{kT} \right) \quad (4.40) \]

As we will see, the Fermi level changes when donors and acceptors are added, but Equations (4.39) and (4.40) show that, as the Fermi level changes from the intrinsic Fermi level, \( n_0 \) and \( p_0 \) change from the \( n_i \) value. If \( E_F > E_{Fi} \), then we will have \( n_0 > n_i \) and \( p_0 < n_i \). One characteristic of an n-type semiconductor is that \( E_F > E_{Fi} \) so that \( n_0 > p_0 \). Similarly, in a p-type semiconductor, \( E_F < E_{Fi} \) so that \( p_0 > n_i \) and \( n_0 < n_i \); thus \( p_0 > n_0 \).

We can see the functional dependence of \( n_0 \) and \( p_0 \) with \( E_F \) in Figures 4.8 and 4.9. As \( E_F \) moves above or below \( E_{Fi} \), the overlapping probability function with the density of states functions in the conduction band and valence band changes. As \( E_F \) moves above \( E_{Fi} \), the probability function in the conduction band increases, while the probability, \( 1 - f_F(E) \), of an empty state (hole) in the valence band decreases. As \( E_F \) moves below \( E_{Fi} \), the opposite occurs.

### 4.3.2 The \( n_0p_0 \) Product

We may take the product of the general expressions for \( n_0 \) and \( p_0 \) as given in Equations (4.11) and (4.19), respectively. The result is

\[ n_0p_0 = N_cN_v \exp \left[ \frac{- (E_c - E_F)}{kT} \right] \exp \left[ \frac{- (E_F - E_v)}{kT} \right] \quad (4.41) \]

which may be written as

\[ n_0p_0 = N_cN_v \exp \left[ \frac{-E_g}{kT} \right] \quad (4.42) \]

As Equation (4.42) was derived for a general value of Fermi energy, the values of \( n_0 \) and \( p_0 \) are not necessarily equal. However, Equation (4.42) is exactly the same as Equation (4.23), which we derived for the case of an intrinsic semiconductor. We
4.3 The Extrinsic Semiconductor

Then have that, for the semiconductor in thermal equilibrium,

\[ n_0 p_0 = n_i^2 \]  

(4.43)

Equation (4.43) states that the product of \( n_0 \) and \( p_0 \) is always a constant for a given semiconductor material at a given temperature. Although this equation seems very simple, it is one of the fundamental principles of semiconductors in thermal equilibrium. The significance of this relation will become more apparent in the chapters that follow. It is important to keep in mind that Equation (4.43) was derived using the Boltzmann approximation. If the Boltzmann approximation is not valid, then likewise, Equation (4.43) is not valid.

An extrinsic semiconductor in thermal equilibrium does not, strictly speaking, contain an intrinsic carrier concentration, although some thermally generated carriers are present. The intrinsic electron and hole carrier concentrations are modified by the donor or acceptor impurities. However, we may think of the intrinsic concentration \( n_i \) in Equation (4.43) simply as a parameter of the semiconductor material.

*4.3.3 The Fermi-Dirac Integral

In the derivation of the Equations (4.11) and (4.19) for the thermal equilibrium electron and hole concentrations, we assumed that the Boltzmann approximation was valid. If the Boltzmann approximation does not hold, the thermal equilibrium electron concentration is written from Equation (4.3) as

\[ n_0 = \frac{4\pi}{\hbar^3 (2m_n^*)^{3/2}} \int_{E_c}^{\infty} \frac{(E - E_c)^{1/2}}{1 + \exp \left( \frac{E - E_F}{kT} \right)} dE \]  

(4.44)

If we again make a change of variable and let

\[ \eta = \frac{E - E_c}{kT} \]  

(4.45a)

and also define

\[ \eta_F = \frac{E_F - E_c}{kT} \]  

(4.45b)

then we can rewrite Equation (4.44) as

\[ n_0 = 4\pi \left( \frac{2m_n^* kT}{\hbar^2} \right)^{3/2} \int_0^{\infty} \frac{\eta^{1/2}}{1 + \exp (\eta - \eta_F)} d\eta \]  

(4.46)

The integral is defined as

\[ F_{1/2}(\eta_F) = \int_0^{\infty} \frac{\eta^{1/2} d\eta}{1 + \exp (\eta - \eta_F)} \]  

(4.47)
CHAPTER 4 The Semiconductor in Equilibrium

This function, called the Fermi–Dirac integral, is a tabulated function of the variable $\eta_F$. Figure 4.10 is a plot of the Fermi–Dirac integral. Note that if $\eta_F > 0$, the $E_F > E_c$; thus the Fermi energy is actually in the conduction band.

**EXAMPLE 4.6**

**Objective**

To calculate the electron concentration using the Fermi–Dirac integral.

Let $\eta_F = 2$ so that the Fermi energy is above the conduction band by approximate 52 meV at $T = 300$ K.

**Solution**

Equation (4.46) can be written as

$$n_0 = \frac{2}{\sqrt{\pi}} N_c F_{1/2}(\eta_F)$$

For silicon at 300 K, $N_c = 2.8 \times 10^{19}$ cm$^{-3}$ and, from Figure 4.10, the Fermi–Dirac integral has a value of $F_{1/2}(2) = 2.3$. Then

$$n_0 = \frac{2}{\sqrt{\pi}} (2.8 \times 10^{19})(2.3) = 7.27 \times 10^{19} \text{ cm}^{-3}$$
Comment

Note that if we had used Equation (4.11), the thermal equilibrium value of $n_0$ would be $n_0 = 2.08 \times 10^{20} \text{ cm}^{-3}$, which is incorrect since the Boltzmann approximation is not valid for this case.

We may use the same general method to calculate the thermal equilibrium concentration of holes. We obtain

$$n_0 = 4\pi \left( \frac{2m_p kT}{\hbar^2} \right)^{3/2} \int_0^\infty \frac{(\eta')^{1/2} d\eta'}{1 + \exp(\eta' - \eta'_F)}$$

(4.48)

where

$$\eta' = \frac{E_F - E}{kT}$$

(4.49a)

and

$$\eta'_F = \frac{E_F - E_F}{kT}$$

(4.49b)

The integral in Equation (4.48) is the same Fermi-Dirac integral defined by Equation (4.47), although the variables have slightly different definitions. We may note that if $\eta'_F > 0$, then the Fermi level is in the valence band.

TEST YOUR UNDERSTANDING

E4.8 Calculate the thermal equilibrium electron concentration in silicon for the case when $E_F = E_v$ and $T = 300 \text{ K}$.

4.3.4 Degenerate and Nondegenerate Semiconductors

In our discussion of adding dopant atoms to a semiconductor, we have implicitly assumed that the concentration of dopant atoms added is small when compared to the density of host or semiconductor atoms. The small number of impurity atoms are spread far enough apart so that there is no interaction between donor electrons, for example, in an n-type material. We have assumed that the impurities introduce discrete, noninteracting donor energy states in the n-type semiconductor and discrete, noninteracting acceptor states in the p-type semiconductor. These types of semiconductors are referred to as nondegenerate semiconductors.

If the impurity concentration increases, the distance between the impurity atoms decreases and a point will be reached when donor electrons, for example, will begin to interact with each other. When this occurs, the single discrete donor energy will split into a band of energies. As the donor concentration further increases, the band of donor states widens and may overlap the bottom of the conduction band. This overlap occurs when the donor concentration becomes comparable with the effective density of states. When the concentration of electrons in the conduction band exceeds
the density of states \( N_e \), the Fermi energy lies within the conduction band. This type of semiconductor is called a degenerate n-type semiconductor.

In a similar way, as the acceptor doping concentration increases in a p-type semiconductor, the discrete acceptor energy states will split into a band of energy and may overlap the top of the valence band. The Fermi energy will lie in the valence band when the concentration of holes exceeds the density of states \( N_p \). This type of semiconductor is called a degenerate p-type semiconductor.

Schematic models of the energy-band diagrams for a degenerate n-type and p-type semiconductor are shown in Figure 4.11. The energy states below \( E_F \) are mostly filled with electrons and the energy states above \( E_F \) are mostly empty. In the degenerate n-type semiconductor, the states between \( E_F \) and \( E_c \) are mostly filled with electrons; thus, the electron concentration in the conduction band is very large. Similarly, in the degenerate p-type semiconductor, the energy states between \( E_v \) and \( E_F \) are mostly empty; thus, the hole concentration in the valence band is very large.

### 4.4 STATISTICS OF DONORS AND ACCEPTORS

In the last chapter, we discussed the Fermi-Dirac distribution function, which gives the probability that a particular energy state will be occupied by an electron. We need to reconsider this function and apply the probability statistics to the donor and acceptor energy states.

#### 4.4.1 Probability Function

One postulate used in the derivation of the Fermi-Dirac probability function was the Pauli exclusion principle, which states that only one particle is permitted in each quantum state. The Pauli exclusion principle also applies to the donor and acceptor states.

Suppose we have \( N_i \) electrons and \( g_i \) quantum states, where the subscript \( i \) indicates the \( i \)th energy level. There are \( g_i \) ways of choosing where to put the first particle. Each donor level has two possible spin orientations for the donor electron; thus, each donor level has two quantum states. The insertion of an electron into one quantum state, however, precludes putting an electron into the second quantum state. B
adding one electron, the vacancy requirement of the atom is satisfied, and the addition of a second electron in the donor level is not possible. The distribution function of donor electrons in the donor energy states is then slightly different than the Fermi-Dirac function.

The probability function of electrons occupying the donor state is

$$n_d = \frac{N_d}{1 + \frac{1}{2} \exp \left( \frac{E_d - E_F}{kT} \right)}$$  \hspace{1cm} (4.50)

where $n_d$ is the density of electrons occupying the donor level and $E_d$ is the energy of the donor level. The factor $\frac{1}{2}$ in this equation is a direct result of the spin factor just mentioned. The $\frac{1}{2}$ factor is sometimes written as $1/g$, where $g$ is called a degeneracy factor.

Equation (4.50) can also be written in the form

$$n_d = N_d - N_d^+$$  \hspace{1cm} (4.51)

where $N_d^+$ is the concentration of ionized donors. In many applications, we will be interested more in the concentration of ionized donors than in the concentration of electrons remaining in the donor states.

If we do the same type of analysis for acceptor atoms, we obtain the expression

$$p_a = \frac{N_a}{1 + \frac{1}{g} \exp \left( \frac{E_F - E_a}{kT} \right)} = N_a - N_a^-$$  \hspace{1cm} (4.52)

where $N_a$ is the concentration of acceptor atoms, $E_a$ is the acceptor energy level, $p_a$ is the concentration of holes in the acceptor states, and $N_a^-$ is the concentration of ionized acceptors. A hole in an acceptor state corresponds to an acceptor atom that is neutrally charged and still has an "empty" bonding position as we discussed in Section 4.2.1. The parameter $g$ is, again, a degeneracy factor. The ground state degeneracy factor $g$ is normally taken as four for the acceptor level in silicon and gallium arsenide because of the detailed band structure.

### 4.4.2 Complete Ionization and Freeze-Out

The probability function for electrons in the donor energy state was just given by Equation (4.50). If we assume that $(E_d - E_F) \gg kT$, then

$$n_d \approx \frac{N_d}{\frac{1}{2} \exp \left( \frac{E_d - E_F}{kT} \right)} = 2N_d \exp \left[ \frac{-(E_d - E_F)}{kT} \right]$$  \hspace{1cm} (4.53)

If $(E_d - E_F) \gg kT$, then the Boltzmann approximation is also valid for the electrons in the conduction band so that, from Equation (4.11),

$$n_0 = N_c \exp \left[ \frac{-(E_c - E_F)}{kT} \right]$$
We can determine the relative number of electrons in the donor state compared with the total number of electrons; therefore we can consider the ratio of electrons in the donor state to the total number of electrons in the conduction band plus donor state. Using the expressions of Equations (4.53) and (4.11), we write

\[
\frac{n_d}{n_d + n_0} = \frac{2N_d \exp\left(\frac{-\left(E_d - E_F\right)}{kT}\right)}{2N_d \exp\left(\frac{-\left(E_d - E_F\right)}{kT}\right) + N_c \exp\left(\frac{-\left(E_c - E_F\right)}{kT}\right)}
\]

(4.5)

The Fermi energy cancels out of this expression. Dividing by the numerator term, we obtain

\[
\frac{n_d}{n_d + n_0} = \frac{1}{1 + \frac{N_c}{2N_d} \exp\left(\frac{-\left(E_c - E_d\right)}{kT}\right)}
\]

(4.55)

The factor \((E_c - E_d)\) is just the ionization energy of the donor electrons.

**EXAMPLE 4.7**

**Objective**

To determine the fraction of total electrons still in the donor states at \(T = 300\) K.

Consider phosphorus doping in silicon, for \(T = 300\) K, at a concentration of \(N_d = 10^{16}\) cm\(^{-3}\).

**Solution**

Using Equation (4.55), we find

\[
\frac{n_d}{n_0 + n_d} = \frac{1}{1 + \frac{2.8 \times 10^{19}}{2 \times 10^{16}} \exp\left(\frac{-0.045}{0.0259}\right)} = 0.0041 = 0.41\%
\]

**Comment**

This example shows that there are very few electrons in the donor state compared with the conduction band. Essentially all of the electrons from the donor states are in the conduction band and, since only about 0.4 percent of the donor states contain electrons, the donor state are said to be completely ionized.

At room temperature, then, the donor states are essentially completely ionized and, for a typical doping of \(10^{16}\) cm\(^{-3}\), almost all donor impurity atoms have donated an electron to the conduction band.

At room temperature, there is also essentially complete ionization of the acceptor atoms. This means that each acceptor atom has accepted an electron from the valence band so that \(p_d\) is zero. At typical acceptor doping concentrations, a hole is created in the valence band for each acceptor atom. This ionization effect and the creation of electrons and holes in the conduction band and valence band, respectively, are shown in Figure 4.12.
The opposite of complete ionization occurs at $T = 0$ K. At absolute zero degrees, all electrons are in their lowest possible energy state; that is, for an n-type semiconductor, each donor state must contain an electron, therefore $n_d = N_d$ or $N_d^+ = 0$. We must have, then, from Equation (4.50) that $\exp \left[ \frac{(E_d - E_F)}{kT} \right] = 0$. Since $T = 0$ K, this will occur for $\exp (-\infty) = 0$, which means that $E_F > E_d$. The Fermi energy level must be above the donor energy level at absolute zero. In the case of a p-type semiconductor at absolute zero temperature, the impurity atoms will not contain any electrons, so that the Fermi energy level must be below the acceptor energy state. The distribution of electrons among the various energy states, and hence the Fermi energy, is a function of temperature.

A detailed analysis, not given in this text, shows that at $T = 0$ K, the Fermi energy is halfway between $E_c$ and $E_d$ for the n-type material and halfway between $E_a$ and $E_v$ for the p-type material. Figure 4.13 shows these effects. No electrons from the donor state are thermally elevated into the conduction band; this effect is called freeze-out. Similarly, when no electrons from the valance band are elevated into the acceptor states, the effect is also called freeze-out.
Between \( T = 0 \) K, freeze-out, and \( T = 300 \) K, complete ionization, we have partial ionization of donor or acceptor atoms.

### EXAMPLE 4.8

**Objective**

To determine the temperature at which 90 percent of acceptor atoms are ionized.

Consider p-type silicon doped with boron at a concentration of \( N_a = 10^{16} \) cm\(^{-3}\).

**Solution**

Find the ratio of holes in the acceptor state to the total number of holes in the valence band plus acceptor state. Taking into account the Boltzmann approximation and assuming the degeneracy factor is \( g = 4 \), we write

\[
\frac{p_a}{p_0 + p_a} = \frac{1}{1 + \frac{N_v}{4N_a} \exp \left( \frac{-(E_a - E_v)}{kT} \right)}
\]

For 90 percent ionization,

\[
\frac{p_a}{p_0 + p_a} = 0.10 = \frac{1}{1 + \frac{1.04 \times 10^{19}}{4(10^{16})} \exp \left( \frac{-0.045}{0.0259 \left( \frac{T}{300} \right)} \right)}
\]

Using trial and error, we find that \( T = 193 \) K.

**Comment**

This example shows that at approximately 100\(^\circ\)C below room temperature, we still have 90 percent of the acceptor atoms ionized; in other words, 90 percent of the acceptor atoms have "donated" a hole to the valence band.

### TEST YOUR UNDERSTANDING

**E4.9** Determine the fraction of total holes still in the acceptor states in silicon at \( T = 300 \) K for a boron impurity concentration of \( N_a = 10^{17} \) cm\(^{-3}\). (6L10 \(^{15}\) cm\(^{-3}\))

**E4.10** Consider silicon with a phosphorus impurity concentration of \( N_p = 5 \times 10^{15} \) cm\(^{-3}\). Plot the percent of ionized impurity atoms versus temperature over the range \( 100 \leq T \leq 400 \) K.

### 4.5 | CHARGE NEUTRALITY

In thermal equilibrium, the semiconductor crystal is electrically neutral. The electrons are distributed among the various energy states, creating negative and positive charges, but the net charge density is zero. This charge-neutrality condition is used to determine the thermal-equilibrium electron and hole concentrations as a function of...
the impurity doping concentration. We will define a compensated semiconductor and then determine the electron and hole concentrations as a function of the donor and acceptor concentrations.

4.5.1 Compensated Semiconductors
A compensated semiconductor is one that contains both donor and acceptor impurity atoms in the same region. A compensated semiconductor can be formed, for example, by diffusing acceptor impurities into an n-type material, or by diffusing donor impurities into a p-type material. An n-type compensated semiconductor occurs when \( N_d > N_a \), and a p-type compensated semiconductor occurs when \( N_a > N_d \). If \( N_a = N_d \), we have a completely compensated semiconductor that has, as we will show, the characteristics of an intrinsic material. Compensated semiconductors are created quite naturally during device fabrication as we will see later.

4.5.2 Equilibrium Electron and Hole Concentrations
Figure 4.14 shows the energy-band diagram of a semiconductor when both donor and acceptor impurity atoms are added to the same region to form a compensated semiconductor.
semiconductor. The figure shows how the electrons and holes can be distributed among the various states.

The charge neutrality condition is expressed by equating the density of negative charges to the density of positive charges. We then have

\[ n_0 + N_a^- = p_0 + N_d^+ \]  \hspace{1cm} (4.56)

or

\[ n_0 + (N_a - p_a) = p_0 + (N_d - n_d) \]  \hspace{1cm} (4.57)

where \( n_0 \) and \( p_0 \) are the thermal-equilibrium concentrations of electrons and holes in the conduction band and valence band, respectively. The parameter \( n_d \) is the concentration of electrons in the donor energy states, so \( N_d^+ = N_d - n_d \) is the concentration of positively charged donor states. Similarly, \( p_a \) is the concentration of holes in the acceptor states, so \( N_a^- = N_a - p_a \) is the concentration of negatively charged acceptor states. We have expressions for \( n_0, p_0, n_d, \) and \( p_a \) in terms of the Fermi energy and temperature.

If we assume complete ionization, \( n_d \) and \( p_a \) are both zero, and Equation (4.57) becomes

\[ n_0 + N_a = p_0 + N_d \]  \hspace{1cm} (4.58)

If we express \( p_0 \) as \( n_f^2 / n_0 \), then Equation (4.58) can be written as

\[ n_0 + N_a = \frac{n_f^2}{n_0} + N_d \]  \hspace{1cm} (4.59a)

which in turn can be written as

\[ n_0^2 - (N_d - N_a)n_0 - n_f^2 = 0 \]  \hspace{1cm} (4.59b)

The electron concentration \( n_0 \) can be determined using the quadratic formula, or

\[ n_0 = \frac{(N_d - N_a)}{2} + \sqrt{\left( \frac{N_d - N_a}{2} \right)^2 + n_f^2} \]  \hspace{1cm} (4.60)

The positive sign in the quadratic formula must be used, since, in the limit of an intrinsic semiconductor when \( N_a = N_d = 0 \), the electron concentration must be a positive quantity, or \( n_0 = n_i \).

Equation (4.60) is used to calculate the electron concentration in an n-type semiconductor, or when \( N_d > N_a \). Although Equation (4.60) was derived for a compensated semiconductor, the equation is also valid for \( N_a = 0 \).

EXAMPLE 4.9

Objective

To determine the thermal equilibrium electron and hole concentrations for a given doping concentration.

Consider an n-type silicon semiconductor at \( T = 300 \) K in which \( N_d = 10^{16} \) cm\(^{-3} \) and \( N_a = 0 \). The intrinsic carrier concentration is assumed to be \( n_i = 1.5 \times 10^{10} \) cm\(^{-3} \).
**Solution**

From Equation (4.60), the majority carrier electron concentration is

\[ n_0 = \frac{10^{16}}{2} + \sqrt{\left(\frac{10^{16}}{2}\right)^2 + (1.5 \times 10^{10})^2} \approx 10^{16} \text{ cm}^{-3} \]

The minority carrier hole concentration is found as

\[ p_0 = \frac{n_i^2}{n_0} = \frac{(1.5 \times 10^{10})^2}{1 \times 10^{16}} = 2.25 \times 10^4 \text{ cm}^{-3} \]

**Comment**

In this example, \( N_d \gg n_i \), so that the thermal-equilibrium majority carrier electron concentration is essentially equal to the donor impurity concentration. The thermal-equilibrium majority and minority carrier concentrations can differ by many orders of magnitude.

We have argued in our discussion and we may note from the results of Example 4.9 that the concentration of electrons in the conduction band increases above the intrinsic carrier concentration as we add donor impurity atoms. At the same time, the minority carrier hole concentration decreases below the intrinsic carrier concentration as we add donor atoms. We must keep in mind that as we add donor impurity atoms and the corresponding donor electrons, there is a redistribution of electrons among available energy states. Figure 4.15 shows a schematic of this physical redistribution. A few of the donor electrons will fall into the empty states in the valence

![Figure 4.15](image-url)
band and, in doing so, will annihilate some of the intrinsic holes. The minority carrier hole concentration will therefore decrease as we have seen in Example 4.9. At the same time, because of this redistribution, the net electron concentration in the conduction band is not simply equal to the donor concentration plus the intrinsic electron concentration.

EXAMPLE 4.10

Objective

To calculate the thermal-equilibrium electron and hole concentrations in a germanium sample for a given doping density.

Consider a germanium sample at \( T = 300 \text{ K} \) in which \( N_d = 5 \times 10^{13} \text{ cm}^{-3} \) and \( N_a = \). Assume that \( n_i = 2.4 \times 10^{13} \text{ cm}^{-3} \).

**Solution**

Again, from Equation (4.60), the majority carrier electron concentration is

\[
\rho_0 = \frac{5 \times 10^{13}}{2} + \sqrt{\left(\frac{5 \times 10^{13}}{2}\right)^2 + (2.4 \times 10^{13})^2} = 5.97 \times 10^{13} \text{ cm}^{-3}
\]

The minority carrier hole concentration is

\[
\rho_0 = \frac{n_i^2}{n_0} = \frac{(2.4 \times 10^{13})^2}{5.97 \times 10^{13}} = 9.65 \times 10^{12} \text{ cm}^{-3}
\]

**Comment**

If the donor impurity concentration is not too different in magnitude from the intrinsic carrier concentration, then the thermal-equilibrium majority carrier electron concentration is influenced by the intrinsic concentration.

We have seen that the intrinsic carrier concentration \( n_i \) is a very strong function of temperature. As the temperature increases, additional electron-hole pairs are thermally generated so that the \( n_i^2 \) term in Equation (4.60) may begin to dominate. The semiconductor will eventually lose its extrinsic characteristics. Figure 4.16 shows the electron concentration versus temperature in silicon doped with \( 5 \times 10^{14} \) donors per cm\(^3\). As the temperature increases, we can see where the intrinsic concentration begins to dominate. Also shown is the partial ionization, or the onset of freeze-out, at the low temperature.

If we reconsider Equation (4.58) and express \( n_0 \) as \( n_i^2 \rho_0 \), then we have

\[
\frac{n_i^2}{\rho_0} + N_a = \rho_0 + N_d
\]

which we can write as

\[
p_0^2 - (N_a - N_d) \rho_0 - n_i^2 = 0
\]
Using the quadratic formula, the hole concentration is given by

$$p_0 = \frac{N_a - N_d}{2} + \sqrt{\left(\frac{N_a - N_d}{2}\right)^2 + n_i^2}$$  \hspace{1cm} (4.62)

where the positive sign, again, must be used. Equation (4.62) is used to calculate the thermal-equilibrium majority carrier hole concentration in a p-type semiconductor, or when $N_a > N_d$. This equation also applies for $N_d = 0$.

---

**Objective**

**EXAMPLE 4.11**

To calculate the thermal-equilibrium electron and hole concentrations in a compensated p-type semiconductor.

Consider a silicon semiconductor at $T = 300$ K in which $N_a = 10^{16}$ cm$^{-3}$ and $N_d = 3 \times 10^{15}$ cm$^{-3}$. Assume $n_i = 1.5 \times 10^{10}$ cm$^{-3}$.

**Solution**

Since $N_a > N_d$, the compensated semiconductor is p-type and the thermal-equilibrium majority carrier hole concentration is given by Equation (4.62) as

$$p_0 = \frac{10^{16} - 3 \times 10^{15}}{2} + \sqrt{\left(\frac{10^{16} - 3 \times 10^{15}}{2}\right)^2 + (1.5 \times 10^{10})^2}$$

so that

$$p_0 \approx 7 \times 10^{15} \text{ cm}^{-3}$$
The minority carrier electron concentration is

\[ n_0 = \frac{n_i^2}{p_0} = \frac{(1.5 \times 10^{19})^2}{7 \times 10^{15}} = 3.21 \times 10^4 \text{ cm}^{-3} \]

**Comment**

If we assume complete ionization and if \((N_a - N_d) \gg n_i\), then the majority carrier hole concentration is, to a very good approximation, just the difference between the acceptor and donor concentrations.

We may note that, for a compensated p-type semiconductor, the minority carrier electron concentration is determined from

\[ n_0 = \frac{n_i^2}{p_0} = \frac{n_i^2}{(N_a - N_d)} \]

### DESIGN EXAMPLE 4.12

**Objective**

To determine the required impurity doping concentration in a semiconductor material.

A silicon device with n-type material is to be operated at \(T = 550 \text{ K}\). At this temperature, the intrinsic carrier concentration must contribute no more than 5 percent of the total electron concentration. Determine the minimum donor concentration required to meet this specification.

**Solution**

At \(T = 550 \text{ K}\), the intrinsic carrier concentration is found from Equation (4.23) as

\[ n_i^2 = N_c N_v \exp \left( \frac{-E_g}{kT} \right) = (2.8 \times 10^{19})(1.04 \times 10^{19}) \left( \frac{550}{300} \right)^3 \exp \left[ -\frac{1.12}{0.0259} \left( \frac{300}{550} \right) \right] \]

or

\[ n_i^2 = 1.02 \times 10^{29} \]

so that

\[ n_i = 3.20 \times 10^{14} \text{ cm}^{-3} \]

For the intrinsic carrier concentration to contribute no more than 5 percent of the total electron concentration, we set \(n_0 = 1.05n_i\).

From Equation (4.60), we have

\[ n_0 = \frac{N_d}{2} + \sqrt{\left( \frac{N_d}{2} \right)^2 + n_i^2} \]

or

\[ 1.05N_d = \frac{N_d}{2} + \sqrt{\left( \frac{N_d}{2} \right)^2 + (3.20 \times 10^{14})^2} \]

which yields

\[ N_d = 1.39 \times 10^{15} \text{ cm}^{-3} \]

**Comment**

If the temperature remains less than \( T = 550 \text{ K} \), then the intrinsic carrier concentration will contribute less than 5 percent of the total electron concentration for this donor impurity concentration.

Equations (4.60) and (4.62) are used to calculate the majority carrier electron concentration in an n-type semiconductor and majority carrier hole concentration in a p-type semiconductor, respectively. The minority carrier hole concentration in an n-type semiconductor could, theoretically, be calculated from Equation (4.62). However, we would be subtracting two numbers on the order of \( 10^{16} \text{ cm}^{-3} \), for example, to obtain a number on the order of \( 10^4 \text{ cm}^{-3} \), which from a practical point of view is not possible. The minority carrier concentrations are calculated from \( n_0 p_0 = n_i^2 \) once the majority carrier concentration has been determined.

**TEST YOUR UNDERSTANDING**

**E4.11** Consider a compensated GaAs semiconductor at \( T = 300 \text{ K} \) doped at \( N_d = 5 \times 10^{15} \text{ cm}^{-3} \) and \( N_a = 2 \times 10^{16} \text{ cm}^{-3} \). Calculate the thermal equilibrium electron and hole concentrations. \( (\text{Note: } \exp[-(E_c - E_F)/kT]) \)

**E4.12** Silicon is doped at \( N_d = 10^{15} \text{ cm}^{-3} \) and \( N_a = 0 \). (a) Plot the concentration of electrons versus temperature over the range \( 300 \leq T \leq 600 \text{ K} \). (b) Calculate the temperature at which the electron concentration is equal to \( 1.1 \times 10^{15} \text{ cm}^{-3} \). \( (K \approx 1.38 \times 10^{-23}) \)

### 4.6 | POSITION OF FERMI ENERGY LEVEL

We discussed qualitatively in Section 4.3.1 how the electron and hole concentrations change as the Fermi energy level moves through the bandgap energy. Then, in Section 4.5, we calculated the electron and hole concentrations as a function of donor and acceptor impurity concentrations. We can now determine the position of the Fermi energy level as a function of the doping concentrations and as a function of temperature. The relevance of the Fermi energy level will be further discussed after the mathematical derivations.

### 4.6.1 Mathematical Derivation

The position of the Fermi energy level within the bandgap can be determined by using the equations already developed for the thermal-equilibrium electron and hole concentrations. If we assume the Boltzmann approximation to be valid, then from Equation (4.11) we have \( n_0 = N_c \exp[-(E_c - E_F)/kT] \). We can solve for \( E_c = E_F \)
from this equation and obtain

\[ E_c - E_F = kT \ln \left( \frac{N_c}{n_0} \right) \]  (4.63)

where \( n_0 \) is given by Equation (4.60). If we consider an n-type semiconductor in which \( N_d \gg n_i \), then \( n_0 \approx N_d \), so that

\[ E_c - E_F = kT \ln \left( \frac{N_c}{N_d} \right) \]  (4.64)

The distance between the bottom of the conduction band and the Fermi energy is a logarithmic function of the donor concentration. As the donor concentration increases, the Fermi level moves closer to the conduction band. Conversely, if the Fermi level moves closer to the conduction band, then the electron concentration in the conduction band is increasing. We may note that if we have a compensated semiconductor, then the \( N_d \) term in Equation (4.64) is simply replaced by \( N_d - N_a \), or the net effective donor concentration.

**DESIGN EXAMPLE 4.13**

**Objective**

To determine the required donor impurity concentration to obtain a specified Fermi energy. Silicon at \( T = 300 \) K contains an acceptor impurity concentration of \( N_a = 10^{16} \) cm\(^{-3}\). Determining the concentration of donor impurity atoms that must be added so that the silicon is n-type and the Fermi energy is 0.20 eV below the conduction band edge.

**Solution**

From Equation (4.64), we have

\[ E_c - E_F = kT \ln \left( \frac{N_c}{N_d - N_a} \right) \]

which can be rewritten as

\[ N_d - N_a = N_c \exp \left[ \frac{- (E_c - E_F)}{kT} \right] \]

Then

\[ N_d - N_a = 2.8 \times 10^{19} \exp \left[ \frac{-0.20}{0.0259} \right] = 1.24 \times 10^{16} \text{ cm}^{-3} \]

or

\[ N_d = 1.24 \times 10^{16} + N_a = 2.24 \times 10^{16} \text{ cm}^{-3} \]

**Comment**

A compensated semiconductor can be fabricated to provide a specific Fermi energy level.
4.6 Position of Fermi Energy Level

We may develop a slightly different expression for the position of the Fermi level. We had from Equation (4.39) that 

\[ n_0 = n_i \exp \left( \frac{E_F - E_{Fi}}{kT} \right) \]

We can solve for \( E_F - E_{Fi} \) as

\[ E_F - E_{Fi} = kT \ln \left( \frac{n_0}{n_i} \right) \] \hspace{1cm} (4.65)

Equation (4.65) can be used specifically for an n-type semiconductor, where \( n_0 \) is given by Equation (4.60), to find the difference between the Fermi level and the intrinsic Fermi level as a function of the donor concentration. We may note that, if the net effective donor concentration is zero, that is, \( N_d - N_a = 0 \), then \( n_0 = n_i \) and \( E_F = E_{Fi} \). A completely compensated semiconductor has the characteristics of an intrinsic material in terms of carrier concentration and Fermi level position.

We can derive the same types of equations for a p-type semiconductor. From Equation (4.19), we have

\[ p_0 = N_v \exp \left( \frac{-E_F - E_v}{kT} \right) \]

so that

\[ E_F - E_v = kT \ln \left( \frac{N_v}{p_0} \right) \] \hspace{1cm} (4.66)

If we assume that \( N_a \gg n_i \), then Equation (4.66) can be written as

\[ E_F - E_v = kT \ln \left( \frac{N_v}{N_a} \right) \] \hspace{1cm} (4.67)

The distance between the Fermi level and the top of the valence-band energy for a p-type semiconductor is a logarithmic function of the acceptor concentration: as the acceptor concentration increases, the Fermi level moves closer to the valence band. Equation (4.67) still assumes that the Boltzmann approximation is valid. Again, if we have a compensated p-type semiconductor, then the \( N_a \) term in Equation (4.67) is replaced by \( N_a - N_d \), or the net effective acceptor concentration.

We can also derive an expression for the relationship between the Fermi level and the intrinsic Fermi level in terms of the hole concentration. We have from Equation (4.40) that

\[ p_0 = n_i \exp \left( \frac{-E_F - E_{Fi}}{kT} \right) \]

which yields

\[ E_{Fi} - E_F = kT \ln \left( \frac{p_0}{n_i} \right) \] \hspace{1cm} (4.68)

Equation (4.68) can be used to find the difference between the intrinsic Fermi level and the Fermi energy in terms of the acceptor concentration. The hole concentration \( p_0 \) in Equation (4.68) is given by Equation (4.62).

We may again note from Equation (4.65) that, for an n-type semiconductor, \( n_0 > n_i \) and \( E_F > E_{Fi} \). The Fermi level for an n-type semiconductor is above \( E_{Fi} \). For a p-type semiconductor, \( p_0 > n_i \), and from Equation (4.68) we see that
$E_{Fi} > E_F$. The Fermi level for a p-type semiconductor is below $E_{Fi}$. These results are shown in Figure 4.17.

### 4.6.2 Variation of $E_F$ with Doping Concentration and Temperature

We may plot the position of the Fermi energy level as a function of the doping concentration. Figure 4.18 shows the Fermi energy level as a function of donor concentration (n type) and as a function of acceptor concentration (p type) for silicon at $T = 300$ K. As the doping levels increase, the Fermi energy level moves closer to the conduction band for the n-type material and closer to the valence band for the p-type material. Keep in mind that the equations for the Fermi energy level that we have derived assume that the Boltzmann approximation is valid.
To determine the Fermi-level position and the maximum doping at which the Boltzmann approximation is still valid.

Consider p-type silicon, at \( T = 300 \) K, doped with boron. We may assume that the limit of the Boltzmann approximation occurs when \( E_F - E_a = 3kT \). (See Section 4.1.2.)

**Example 4.14**

To determine the Fermi-level position and the maximum doping at which the Boltzmann approximation is still valid.

**Solution**

From Table 4.3, we find the ionization energy is \( E_a - E_v = 0.045 \) eV for boron in silicon. If we assume that \( E_F \approx E_{\text{midgap}} \), then from Equation (4.68), the position of the Fermi level at the maximum doping is given by

\[
E_{F1} - E_F = \frac{E_g}{2} - (E_v - E_v) - (E_F - E_a) = kT \ln \left( \frac{N_a}{n_i} \right)
\]

or

\[
0.56 - 0.045 - 3(0.0259) = 0.437 = (0.0259) \ln \left( \frac{N_a}{n_i} \right)
\]

We can then solve for the doping as

\[
N_a = n_i \exp \left( \frac{0.437}{0.0259} \right) = 3.2 \times 10^{17} \text{ cm}^{-3}
\]

**Comment**

If the acceptor (or donor) concentration in silicon is greater than approximately \( 3 \times 10^{17} \) cm\(^{-3} \), then the Boltzmann approximation of the distribution function becomes less valid and the equations for the Fermi-level position are no longer quite as accurate.

---

**Test Your Understanding**

**E4.13** Determine the position of the Fermi level with respect to the valence band energy in p-type GaAs at \( T = 300 \) K. The doping concentrations are \( N_a = 5 \times 10^{16} \) cm\(^{-3} \) and \( N_d = 4 \times 10^{15} \) cm\(^{-3} \). (Appendix 4.1: \( \hbar = \frac{1}{2m^*} \)

**E4.14** Calculate the position of the Fermi energy level in n-type silicon at \( T = 300 \) K with respect to the intrinsic Fermi energy level. The doping concentrations are \( N_d = 2 \times 10^{17} \) cm\(^{-3} \) and \( N_a = 3 \times 10^{16} \) cm\(^{-3} \). (Appendix 4.1: \( \hbar = \frac{1}{2m^*} \))

The intrinsic carrier concentration \( n_i \), in Equations (4.65) and (4.68), is a strong function of temperature, so that \( E_F \) is a function of temperature also. Figure 4.19 shows the variation of the Fermi energy level in silicon with temperature for several donor and acceptor concentrations. As the temperature increases, \( n_i \) increases, and \( E_F \) moves closer to the intrinsic Fermi level. At high temperature, the semiconductor material begins to lose its extrinsic characteristics and begins to behave more like an intrinsic semiconductor. At the very low temperature, freeze-out occurs; the Boltzmann approximation is no longer valid and the equations we derived for the
Fermi-level position no longer apply. At the low temperature where freeze-out occurs, the Fermi level goes above $E_d$ for the n-type material and below $E_a$ for the p-type material. At absolute zero degrees, all energy states below $E_F$ are full and all energy states above $E_F$ are empty.

### 4.6.3 Relevance of the Fermi Energy

We have been calculating the position of the Fermi energy level as a function of doping concentrations and temperature. This analysis may seem somewhat arbitrary and fictitious. However, these relations do become significant later in our discussion of pn junctions and the other semiconductor devices we consider. An important point is that, in thermal equilibrium, the Fermi energy level is a constant throughout a system. We will not prove this statement, but we can intuitively see its validity by considering the following example.

Suppose we have a particular material, A, whose electrons are distributed in the energy states of an allowed band as shown in Figure 4.20a. Most of the energy states below $E_{FA}$ contain electrons and most of the energy states above $E_{FA}$ are empty of electrons. Consider another material, B, whose electrons are distributed in the energy states of an allowed band as shown in Figure 4.20b. The energy states below $E_{FB}$ are mostly full and the energy states above $E_{FB}$ are mostly empty. If these two materials are brought into intimate contact, the electrons in the entire system will tend to seek the lowest possible energy. Electrons from material A will flow into the lower energy states of material B, as indicated in Figure 4.20c, until thermal equilibrium is reached. Thermal equilibrium occurs when the distribution of electrons,
4.7 Summary

The Fermi energy of (a) material A in thermal equilibrium, (b) material B in thermal equilibrium, (c) materials A and B at the instant they are placed in contact, and (d) materials A and B in contact at thermal equilibrium.

Figure 4.20 The Fermi energy of (a) material A in thermal equilibrium, (b) material B in thermal equilibrium, (c) materials A and B at the instant they are placed in contact, and (d) materials A and B in contact at thermal equilibrium.

A function of energy, is the same in the two materials. This equilibrium state occurs when the Fermi energy is the same in the two materials as shown in Figure 4.20d. The Fermi energy, important in the physics of the semiconductor, also provides a good pictorial representation of the characteristics of the semiconductor materials and devices.

4.7 SUMMARY

- The concentration of electrons in the conduction band is the integral over the conduction band energy of the product of the density of states function in the conduction band and the Fermi–Dirac probability function.
- The concentration of holes in the valence band is the integral over the valence band energy of the product of the density of states function in the valence band and the probability of a state being empty, which is \( 1 - f_F(E) \).
- Using the Maxwell–Boltzmann approximation, the thermal equilibrium concentration of electrons in the conduction band is given by

\[
n_0 = N_e \exp \left[ \frac{-(E_c - E_F)}{kT} \right]
\]

where \( N_e \) is the effective density of states in the conduction band.
Using the Maxwell-Boltzmann approximation, the thermal equilibrium concentration of holes in the valence band is given by

$$p_0 = N_v \exp \left[ \frac{-(E_F - E_v)}{kT} \right]$$

where $N_v$ is the effective density of states in the valence band.

The intrinsic carrier concentration is found from

$$n_i^2 = N_e N_v \exp \left[ \frac{-E_g}{kT} \right]$$

The concept of doping the semiconductor with donor (group V elements) impurities and acceptor (group III elements) impurities to form n-type and p-type extrinsic semiconductors was discussed.

The fundamental relationship of $n_0 p_0 = n_i^2$ was derived.

Using the concepts of complete ionization and charge neutrality, equations for the electron and hole concentrations as a function of impurity doping concentrations were derived.

The position of the Fermi energy level as a function of impurity doping concentrations was derived.

The relevance of the Fermi energy was discussed. The Fermi energy is a constant throughout a semiconductor that is in thermal equilibrium.

**GLOSSARY OF IMPORTANT TERMS**

**acceptor atoms** Impurity atoms added to a semiconductor to create a p-type material.

**charge carrier** The electron and/or hole that moves inside the semiconductor and gives rise to electrical currents.

**compensated semiconductor** A semiconductor that contains both donors and acceptors in the same semiconductor region.

**complete ionization** The condition when all donor atoms are positively charged by giving up their donor electrons and all acceptor atoms are negatively charged by accepting electrons.

**degenerate semiconductor** A semiconductor whose electron concentration or hole concentration is greater than the effective density of states, so that the Fermi level is in the conduction band (n-type) or in the valence band (p-type).

**donor atoms** Impurity atoms added to a semiconductor to create an n-type material.

**effective density of states** The parameter $N_e$, which results from integrating the density of quantum states $g(E)$ times the Fermi function $f_F(E)$ over the conduction-band energy, or the parameter $N_v$, which results from integrating the density of quantum states $g_v(E)$ times $[1 - f_F(E)]$ over the valence-band energy.

**extrinsic semiconductor** A semiconductor in which controlled amounts of donors and acceptors have been added so that the electron and hole concentrations change from the intrinsic carrier concentration and a preponderance of either electrons (n-type) or holes (p-type) is created.

**freeze-out** The condition that occurs in a semiconductor when the temperature is lowered and the donors and acceptors become neutrally charged. The electron and hole concentrations become very small.
Checkpoint

After studying this chapter, the reader should have the ability to:

- Derive the equations for the thermal equilibrium concentrations of electrons and holes in terms of the Fermi energy.
- Derive the equation for the intrinsic carrier concentration.
- State the value of the intrinsic carrier concentration for silicon at \( T = 300 \) K.
- Derive the expression for the intrinsic Fermi level.
- Describe the effect of adding donor and acceptor impurity atoms to a semiconductor.
- Understand the concept of complete ionization.
- Understand the derivation of the fundamental relationship \( n_0 p_0 = n_i^2 \).
- Describe the meaning of degenerate and nondegenerate semiconductors.
- Discuss the concept of charge neutrality.
- Derive the equations for \( n_0 \) and \( p_0 \) in terms of impurity doping concentrations.
- Discuss the variation of the Fermi energy with doping concentration and temperature.

Review Questions

1. Write the equation for \( n(E) \) as a function of the density of states and the Fermi probability function. Repeat for the function \( p(E) \).
2. In deriving the equation for \( n_0 \) in terms of the Fermi function, the upper limit of the integral should be the energy at the top of the conduction band. Justify using infinity instead.
3. Assuming the Boltzmann approximation applies, write the equations for \( n_0 \) and \( p_0 \) in terms of the Fermi energy.
4. What is the value of the intrinsic carrier concentration in silicon at \( T = 300 \) K?
5. Under what condition would the intrinsic Fermi level be at the midgap energy?
6. What is a donor impurity? What is an acceptor impurity?
7. What is meant by complete ionization? What is meant by freeze-out?
8. What is the product of \( n_0 \) and \( p_0 \) equal to?
9. Write the equation for charge neutrality for the condition of complete ionization.
10. Sketch a graph of \( n_0 \) versus temperature for an n-type material.
11. Sketch graphs of the Fermi energy versus donor impurity concentration and versus temperature.
PROBLEMS

Section 4.1 Charge Carriers in Semiconductors

4.1 Calculate the intrinsic carrier concentration, \( n_i \), at \( T = 200, 400, \) and \( 600 \) K for (a) silicon, (b) germanium, and (c) gallium arsenide.

4.2 The intrinsic carrier concentration in silicon is to be no greater than \( n_i = 1 \times 10^{12} \text{ cm}^{-3} \). Assume \( E_g = 1.12 \text{ eV} \). Determine the maximum temperature allowed for the silicon.

4.3 Calculate the intrinsic carrier concentration, \( n_i \), for a temperature range of \( 200 \leq T \leq 600 \) K for (a) silicon, (b) germanium, and (c) gallium arsenide. (Use a log scale for \( n_i \).)

4.4 In a particular semiconductor material, the effective density of states functions are given by \( N_c = N_{c0} (T)^{3/2} \) and \( N_v = N_{v0} (T)^{3/2} \) where \( N_{c0} \) and \( N_{v0} \) are constants independent of temperature. The experimentally determined intrinsic carrier concentrations as a function of temperature are given in Table 4.5. Determine the product \( N_{c0} N_{v0} \) and the bandgap energy \( E_g \). (Assume \( E_g \) is independent of temperature.)

4.5 (a) The magnitude of the product \( g_c(E) f_c(E) \) in the conduction band is a function of energy as shown in Figure 4.1. Assume the Boltzmann approximation is valid. Determine the energy with respect to \( E_c \) at which the maximum occurs. (b) Repeat part (a) for the magnitude of the product \( g_v(E) [1 - f_v(E)] \) in the valence band.

4.6 Assume the Boltzmann approximation in a semiconductor is valid. Determine the ratio of \( n(E) = g_c(E) f_c(E) \) to \( n = g_c(E) f_c(E) \) at \( E = E_c + kT/2 \) to that at \( E = E_c + kT/2 \).

4.7 Assume that \( E_c - E_F = 0.20 \text{ eV} \) in silicon. Plot \( n(E) = g_c(E) f_c(E) \) over the range \( E_c \leq E \leq E_c - 0.10 \text{ eV} \) for (a) \( T = 200 \text{ K} \) and (b) \( T = 400 \text{ K} \).

4.8 Two semiconductor materials have exactly the same properties except that material A has a bandgap energy of 1.0 eV and material B has a bandgap energy of 1.2 eV. Determine the ratio of \( n_i \) of material A to that of material B for \( T = 300 \text{ K} \).

4.9 (a) Consider silicon at \( T = 300 \text{ K} \). Plot the thermal equilibrium electron concentration \( n_0 \) (on a log scale) over the energy range \( 0.2 \leq E_c - E_F \leq 0.4 \text{ eV} \). (b) Repeat part (a) for the hole concentration over the range \( 0.2 \leq E_F - E_c \leq 0.4 \text{ eV} \).

4.10 Given the effective masses of electrons and holes in silicon, germanium, and gallium arsenide, calculate the position of the intrinsic Fermi energy level with respect to the center of the bandgap for each semiconductor at \( T = 300 \text{ K} \).

4.11 (a) The carrier effective masses in a semiconductor are \( m_n^* = 0.62 m_0 \) and \( m_p^* = 1.4 m_0 \). Determine the position of the intrinsic Fermi level with respect to the center of the bandgap at \( T = 300 \text{ K} \). (b) Repeat part (a) if \( m_n^* = 1.10 m_0 \) and \( m_p^* = 0.25 m_0 \).

<table>
<thead>
<tr>
<th>Table 4.5</th>
<th>Intrinsic concentration as a function of temperature</th>
</tr>
</thead>
<tbody>
<tr>
<td>( T (\text{K}) )</td>
<td>( n_i ) (( \text{cm}^{-3} ))</td>
</tr>
<tr>
<td>200</td>
<td>( 1.82 \times 10^5 )</td>
</tr>
<tr>
<td>300</td>
<td>( 5.83 \times 10^7 )</td>
</tr>
<tr>
<td>400</td>
<td>( 3.74 \times 10^{10} )</td>
</tr>
<tr>
<td>500</td>
<td>( 1.95 \times 10^{12} )</td>
</tr>
</tbody>
</table>
4.12 Calculate $E_F$ with respect to the center of the bandgap in silicon for $T = 200, 400,$ and $600$ K.

4.13 Plot the intrinsic Fermi energy $E_{Fi}$ with respect to the center of the bandgap in silicon for $200 \leq T \leq 600$ K.

4.14 If the density of states function in the conduction band of a particular semiconductor is a constant equal to $K$, derive the expression for the thermal-equilibrium concentration of electrons in the conduction band, assuming Fermi-Dirac statistics and assuming the Boltzmann approximation is valid.

4.15 Repeat Problem 4.14 if the density of states function is given by $g_c(E) = C_1(E - E_c)$ for $E \geq E_c$ where $C_1$ is a constant.

**Section 4.2 Dopant Atoms and Energy Levels**

4.16 Calculate the ionization energy and radius of the donor electron in germanium using the Bohr theory. (Use the density of states effective mass as a first approximation.)

4.17 Repeat Problem 4.16 for gallium arsenide.

**Section 4.3 The Extrinsic Semiconductor**

4.18 The electron concentration in silicon at $T = 300$ K is $n_0 = 5 \times 10^{14}$ cm$^{-3}$. (a) Determine $p_0$. Is this n- or p-type material? (b) Determine the position of the Fermi level with respect to the intrinsic Fermi level.

4.19 Determine the values of $n_0$ and $p_0$ for silicon at $T = 300$ K if the Fermi energy is $0.22$ eV above the valence band energy.

4.20 (a) If $E_c - E_F = 0.25$ eV in gallium arsenide at $T = 400$ K, calculate the values of $n_0$ and $p_0$. (b) Assuming the value of $n_0$ from part (a) remains constant, determine $E_c - E_F$ and $p_0$ at $T = 300$ K.

4.21 The value of $p_0$ in silicon at $T = 300$ K is $10^{15}$ cm$^{-3}$. Determine (a) $E_c - E_F$ and (b) $n_0$.

4.22 (a) Consider silicon at $T = 300$ K. Determine $p_0$ if $E_{Fi} - E_F = 0.35$ eV. (b) Assuming that $p_0$ from part (a) remains constant, determine the value of $E_{Fi} - E_F$ when $T = 400$ K. (c) Find the value of $n_0$ in both parts (a) and (b).

4.23 Repeat problem 4.22 for GaAs.

*4.24 Assume that $E_F = E_c$ at $T = 300$ K in silicon. Determine $p_0$.

*4.25 Consider silicon at $T = 300$ K, which has $n_0 = 5 \times 10^{19}$ cm$^{-3}$. Determine $E_c - E_F$.

**Section 4.4 Statistics of Donors and Acceptors**

*4.26 The electron and hole concentrations as a function of energy in the conduction band and valence band peak at a particular energy as shown in Figure 4.8. Consider silicon and assume $E_c - E_F = 0.20$ eV. Determine the energy, relative to the band edges, at which the concentrations peak.

*4.27 For the Boltzmann approximation to be valid for a semiconductor, the Fermi level must be at least $3kT$ below the donor level in an n-type material and at least $3kT$ above the acceptor level in a p-type material. If $T = 300$ K, determine the maximum electron concentration in an n-type semiconductor and the maximum hole concentration
in a p-type semiconductor for the Boltzmann approximation to be valid in (a) silicon and (b) gallium arsenide.

4.28 Plot the ratio of un-ionized donor atoms to the total electron concentration versus temperature for silicon over the range $50 \leq T \leq 200$ K.

Section 4.5 Charge Neutrality

4.29 Consider a germanium semiconductor at $T = 300$ K. Calculate the thermal equilibrium concentrations of $n_0$ and $p_0$ for (a) $N_d = 10^{13}$ cm$^{-3}$, $N_a = 0$, and (b) $N_d = 5 \times 10^{15}$ cm$^{-3}$, $N_a = 0$.

*4.30 The Fermi level in n-type silicon at $T = 300$ K is 245 meV below the conduction band and 200 meV below the donor level. Determine the probability of finding an electron (a) in the donor level and (b) in a state in the conduction band $kT$ above the conduction band edge.

4.31 Determine the equilibrium electron and hole concentrations in silicon for the following conditions:

(a) $T = 300$ K, $N_d = 2 \times 10^{15}$ cm$^{-3}$, $N_a = 0$
(b) $T = 300$ K, $N_d = 0$, $N_a = 10^{16}$ cm$^{-3}$
(c) $T = 300$ K, $N_d = N_a = 10^{15}$ cm$^{-3}$
(d) $T = 400$ K, $N_d = 0$, $N_a = 10^{14}$ cm$^{-3}$
(e) $T = 500$ K, $N_d = 10^{14}$ cm$^{-3}$, $N_a = 0$

4.32 Repeat problem 4.31 for GaAs.

4.33 Assume that silicon, germanium, and gallium arsenide each have dopant concentrations of $N_d = 1 \times 10^{13}$ cm$^{-3}$ and $N_a = 2.5 \times 10^{13}$ cm$^{-3}$ at $T = 300$ K. For each of the three materials (a) Is this material n-type or p-type? (b) Calculate $n_0$ and $p_0$.

4.34 A sample of silicon at $T = 450$ K is doped with boron at a concentration of $1.5 \times 10^{15}$ cm$^{-3}$ and with arsenic at a concentration of $8 \times 10^{14}$ cm$^{-3}$. (a) Is the material n-type or p-type? (b) Determine the electron and hole concentrations. (c) Calculate the total ionized impurity concentration.

4.35 The thermal equilibrium hole concentration in silicon at $T = 300$ K is $p_0 = 2 \times 10^5$ cm$^{-3}$. Determine the thermal equilibrium electron concentration. Is the material n-type or p-type?

4.36 In a sample of GaAs at $T = 200$ K, we have experimentally determined that $n_0 = 5 \times 10^5$ and that $N_a = 0$. Calculate $n_0$, $p_0$, and $N_d$.

4.37 Consider a sample of silicon doped at $N_d = 0$ and $N_a = 10^{14}$ cm$^{-3}$. Plot the majority carrier concentration versus temperature over the range $200 \leq T \leq 500$ K.

4.38 The temperature of a sample of silicon is $T = 300$ K and the acceptor doping concentration is $N_a = 0$. Plot the minority carrier concentration (on a log-log plot) versus $N_d$ over the range $10^{13} \leq N_d \leq 10^{18}$ cm$^{-3}$.

4.39 Repeat problem 4.38 for GaAs.

4.40 A particular semiconductor material is doped at $N_d = 2 \times 10^{13}$ cm$^{-3}$, $N_a = 0$, and the intrinsic carrier concentration is $n_i = 2 \times 10^{13}$ cm$^{-3}$. Assume complete ionization. Determine the thermal equilibrium majority and minority carrier concentrations.

4.41 (a) Silicon at $T = 300$ K is uniformly doped with arsenic atoms at a concentration of $2 \times 10^{16}$ cm$^{-3}$ and boron atoms at a concentration of $1 \times 10^{16}$ cm$^{-3}$. Determine the thermal equilibrium concentrations of majority and minority carriers. (b) Repeat
part (a) if the impurity concentrations are $2 \times 10^{15}$ cm$^{-3}$ phosphorus atoms and $3 \times 10^{16}$ cm$^{-3}$ boron atoms.

4.42 In silicon at $T = 300$ K, we have experimentally found that $n_0 = 4.5 \times 10^4$ cm$^{-3}$ and $N_d = 5 \times 10^{15}$ cm$^{-3}$. (a) Is the material n type or p type? (b) Determine the majority and minority carrier concentrations. (c) What types and concentrations of impurity atoms exist in the material?

Section 4.6 Position of Fermi Energy Level

4.43 Consider germanium with an acceptor concentration of $N_a = 10^{15}$ cm$^{-3}$ and a donor concentration of $N_d = 0$. Consider temperatures of $T = 200$, $400$, and $600$ K. Calculate the position of the Fermi energy with respect to the intrinsic Fermi level at these temperatures.

4.44 Consider germanium at $T = 300$ K with donor concentrations of $N_d = 10^{14}$, $10^{16}$, and $10^{18}$ cm$^{-3}$. Let $N_a = 0$. Calculate the position of the Fermi energy level with respect to the intrinsic Fermi level for these doping concentrations.

4.45 A GaAs device is doped with a donor concentration of $3 \times 10^{15}$ cm$^{-3}$. For the device to operate properly, the intrinsic carrier concentration must remain less than 5 percent of the total electron concentration. What is the maximum temperature that the device may operate?

4.46 Consider germanium with an acceptor concentration of $N_a = 10^{15}$ cm$^{-3}$ and a donor concentration of $N_d = 0$. Plot the position of the Fermi energy with respect to the intrinsic Fermi level as a function of temperature over the range $200 \leq T \leq 600$ K.

4.47 Consider silicon at $T = 300$ K with $N_a = 0$. Plot the position of the Fermi energy level with respect to the intrinsic Fermi energy level as a function of the donor doping concentration over the range $10^{14} \leq N_d \leq 10^{18}$ cm$^{-3}$.

4.48 For a particular semiconductor, $E_g = 1.50$ eV, $m_e^* = 10m_0^*$, $T = 300$ K, and $n_i = 1 \times 10^9$ cm$^{-3}$. (a) Determine the position of the intrinsic Fermi energy level with respect to the center of the bandgap. (b) Impurity atoms are added so that the Fermi energy level is 0.45 eV below the center of the bandgap. (i) Are acceptor or donor atoms added? (ii) What is the concentration of impurity atoms added?

4.49 Silicon at $T = 300$ K contains acceptor atoms at a concentration of $N_a = 5 \times 10^{15}$ cm$^{-3}$. Donor atoms are added forming an n-type compensated semiconductor such that the Fermi level is 0.215 eV below the conduction band edge. What concentration of donor atoms are added?

4.50 Silicon at $T = 300$ K is doped with acceptor atoms at a concentration of $N_a = 7 \times 10^{15}$ cm$^{-3}$. (a) Determine $E_F - E_g$. (b) Calculate the concentration of additional acceptor atoms that must be added to move the Fermi level a distance $kT$ closer to the valence-band edge.

4.51 (a) Determine the position of the Fermi level with respect to the intrinsic Fermi level in silicon at $T = 300$ K that is doped with phosphorus atoms at a concentration of $10^{15}$ cm$^{-3}$. (b) Repeat part (a) if the silicon is doped with boron atoms at a concentration of $10^{15}$ cm$^{-3}$. (c) Calculate the electron concentration in the silicon for parts (a) and (b).

4.52 Gallium arsenide at $T = 300$ K contains acceptor impurity atoms at a density of $10^{15}$ cm$^{-3}$. Additional impurity atoms are to be added so that the Fermi level is 0.45 eV below the intrinsic level. Determine the concentration and type (donor or acceptor) of impurity atoms to be added.
4.53 Determine the Fermi energy level with respect to the intrinsic Fermi level for each condition given in Problem 4.31.

4.54 Find the Fermi energy level with respect to the valence band energy for the condition given in Problem 4.32.

4.55 Calculate the position of the Fermi energy level with respect to the intrinsic Fermi level for the conditions given in Problem 4.42.

Summary and Review

4.56 A special semiconductor material is to be "designed." The semiconductor is to be n-type and doped with $1 \times 10^{15}$ cm$^{-3}$ donor atoms. Assume complete ionization and assume $N_a = 0$. The effective density of states functions are given by $N_e = N_v = 1.5 \times 10^{19}$ cm$^{-3}$ and are independent of temperature. A particular semiconductor device fabricated with this material requires the electron concentration to be no greater than $1.01 \times 10^{15}$ cm$^{-3}$ at $T = 400$ K. What is the minimum value of the bandgap energy?

4.57 Silicon atoms, at a concentration of $10^{10}$ cm$^{-3}$, are added to gallium arsenide. Assume that the silicon atoms act as fully ionized dopant atoms and that 5 percent of the concentration added replace gallium atoms and 95 percent replace arsenic atoms. Let $T = 300$ K. (a) Determine the donor and acceptor concentrations. (b) Calculate the electron and hole concentrations and the position of the Fermi level with respect to $E_F$.

4.58 Defects in a semiconductor material introduce allowed energy states within the forbidden bandgap. Assume that a particular defect in silicon introduces two discrete levels: a donor level 0.25 eV above the top of the valence band, and an acceptor level 0.65 eV above the top of the valence band. The charge state of each defect is a function of the position of the Fermi level. (a) Sketch the charge density of each defect as the Fermi level moves from $E_v$ to $E_c$. Which defect level dominates in heavily doped n-type material? In heavily doped p-type material? (b) Determine the electron and hole concentrations and the location of the Fermi level in (i) an n-type sample doped at $N_a = 10^{17}$ cm$^{-3}$ and (ii) in a p-type sample doped at $N_d = 10^{17}$ cm$^{-3}$. (c) Determine the Fermi level position if no dopant atoms are added. Is the material n-type, p-type, or intrinsic?

READING LIST


Carrier Transport Phenomena

PREVIEW

In the previous chapter, we considered the semiconductor in equilibrium and determined electron and hole concentrations in the conduction and valence bands, respectively. A knowledge of the densities of these charged particles is important toward an understanding of the electrical properties of a semiconductor material. The net flow of the electrons and holes in a semiconductor will generate currents. The process by which these charged particles move is called transport. In this chapter we will consider the two basic transport mechanisms in a semiconductor crystal: drift—the movement of charge due to electric fields, and diffusion—the flow of charge due to density gradients. We should mention, in passing, that temperature gradients in a semiconductor can also lead to carrier movement. However, as the semiconductor device size becomes smaller, this effect can usually be ignored. The carrier transport phenomena are the foundation for finally determining the current-voltage characteristics of semiconductor devices. We will implicitly assume in this chapter that, though there will be a net flow of electrons and holes due to the transport processes, thermal equilibrium will not be substantially disturbed. Nonequilibrium processes will be considered in the next chapter.

5.1 CARRIER DRIFT

An electric field applied to a semiconductor will produce a force on electrons and holes so that they will experience a net acceleration and net movement, provided there are available energy states in the conduction and valence bands. This net movement of charge due to an electric field is called drift. The net drift of charge gives rise to a drift current.
5.1.1 Drift Current Density

If we have a positive volume charge density \( \rho \) moving at an average drift velocity \( v_d \), the drift current density is given by

\[
J_{\text{dr}} = \rho v_d
\]

(5.1)

where \( J \) is in units of C/cm\(^2\)-s or amps/cm\(^2\). If the volume charge density is due to positively charged holes, then

\[
J_{p\text{dr}} = (e\rho)v_{dp}
\]

(5.2)

where \( J_{p\text{dr}} \) is the drift current density due to holes and \( v_{dp} \) is the average drift velocity of the holes.

The equation of motion of a positively charged hole in the presence of an electric field is

\[
F = m_p^* a = eE
\]

(5.3)

where \( e \) is the magnitude of the electronic charge, \( a \) is the acceleration, \( E \) is the electric field, and \( m_p^* \) is the effective mass of the hole. If the electric field is constant, then we expect the velocity to increase linearly with time. However, charged particles in a semiconductor are involved in collisions with ionized impurity atoms and with thermally vibrating lattice atoms. These collisions, or scattering events, alter the velocity characteristics of the particle.

As the hole accelerates in a crystal due to the electric field, the velocity increases. When the charged particle collides with an atom in the crystal, for example, the particle loses most, or all, of its energy. The particle will again begin to accelerate and gain energy until it is again involved in a scattering process. This continues over and over again. Throughout this process, the particle will gain an average drift velocity which, for low electric fields, is directly proportional to the electric field. We may then write

\[
v_{dp} = \mu_p E
\]

(5.4)

where \( \mu_p \) is the proportionality factor and is called the hole mobility. The mobility is an important parameter of the semiconductor since it describes how well a particle will move due to an electric field. The unit of mobility is usually expressed in terms of cm\(^2\)/V-s.

By combining Equations (5.2) and (5.4), we may write the drift current density due to holes as

\[
J_{p\text{dr}} = (e\rho)v_{dp} = e\mu_p pE
\]

(5.5)

The drift current due to holes is in the same direction as the applied electric field.

The same discussion of drift applies to electrons. We may write

\[
J_{n\text{dr}} = \rho v_{dn} = (-en)v_{dn}
\]

(5.6)

where \( J_{n\text{dr}} \) is the drift current density due to electrons and \( v_{dn} \) is the average drift velocity of electrons. The net charge density of electrons is negative.
Table 5.1 | Typical mobility values at $T = 300$ K and low doping concentrations

<table>
<thead>
<tr>
<th>Material</th>
<th>$\mu_n$ (cm$^2$/V-s)</th>
<th>$\mu_p$ (cm$^2$/V-s)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Silicon</td>
<td>1350</td>
<td>480</td>
</tr>
<tr>
<td>Gallium arsenide</td>
<td>8500</td>
<td>400</td>
</tr>
<tr>
<td>Germanium</td>
<td>3900</td>
<td>1900</td>
</tr>
</tbody>
</table>

The average drift velocity of an electron is also proportional to the electric field for small fields. However, since the electron is negatively charged, the net motion of the electron is opposite to the electric field direction. We can then write

$$v_{dn} = -\mu_n E$$

where $\mu_n$ is the electron mobility and is a positive quantity. Equation (5.6) may be written as

$$J_{n\text{drf}} = (-en)(-\mu_n E) = e\mu_n n E$$

The conventional drift current due to electrons is also in the same direction as the applied electric field even though the electron movement is in the opposite direction.

Electron and hole mobilities are functions of temperature and doping concentrations, as we will see in the next section. Table 5.1 shows some typical mobility values at $T = 300$ K for low doping concentrations.

Since both electrons and holes contribute to the drift current, the total drift current density is the sum of the individual electron and hole drift current densities, so we may write

$$J_{df} = e(\mu_n n + \mu_p p)E$$

EXAMPLE 5.1

Objective

To calculate the drift current density in a semiconductor for a given electric field.

Consider a gallium arsenide sample at $T = 300$ K with doping concentrations of $N_a = 10^{16}$ and $N_d = 10^{16}$ cm$^{-3}$. Assume complete ionization and assume electron and hole mobilities given in Table 5.1. Calculate the drift current density if the applied electric field is $E = 10$ V/cm.

Solution

Since $N_d > N_a$, the semiconductor is $n$ type and the majority carrier electron concentration from Chapter 4 is given by

$$n = \frac{N_d - N_a}{2} + \sqrt{\left(\frac{N_d - N_a}{2}\right)^2 + n_i^2} \approx 10^{16} \text{ cm}^{-3}$$

The minority carrier hole concentration is

$$p = \frac{n_i^2}{n} = \frac{(1.8 \times 10^6)^2}{10^{16}} = 3.24 \times 10^{-4} \text{ cm}^{-3}$$
For this extrinsic n-type semiconductor, the drift current density is

\[ J_{dr} = e(\mu_n n + \mu_p p)E \approx e\mu_n n d E \]

Then

\[ J_{dr} = (1.6 \times 10^{-19})(8500)(10^{16})(10) = 136 \text{ A/cm}^2 \]

**Comment**

Significant drift current densities can be obtained in a semiconductor applying relatively small electric fields. We may note from this example that the drift current will usually be due primarily to the majority carrier in an extrinsic semiconductor.

---

**TEST YOUR UNDERSTANDING**

**E5.1** Consider a sample of silicon at \( T = 300 \text{ K} \) doped at an impurity concentration of \( N_d = 10^{15} \text{ cm}^{-3} \) and \( N_a = 10^{14} \text{ cm}^{-3} \). Assume electron and hole mobilities given in Table 5.1. Calculate the drift current density if the applied electric field is \( E = 35 \text{ V/cm} \). (\( \mu_n, \mu_p \text{ given in Table 5.1} \))

**E5.2** A drift current density of \( J_{dr} = 120 \text{ A/cm}^2 \) is required in a particular semiconductor device using p-type silicon with an applied electric field of \( E = 20 \text{ V/cm} \). Determine the required impurity doping concentration to achieve this specification. Assume electron and hole mobilities given in Table 5.1. (\( \mu_n, \mu_p \text{ given in Table 5.1} \))

---

**5.1.2 Mobility Effects**

In the last section, we defined mobility, which relates the average drift velocity of a carrier to the electric field. Electron and hole mobilities are important semiconductor parameters in the characterization of carrier drift, as seen in Equation (5.9).

Equation (5.3) related the acceleration of a hole to a force such as an electric field. We may write this equation as

\[ F = m_p^* \frac{dv}{dt} = eE \]  \hspace{1cm} (5.10)

where \( v \) is the velocity of the particle due to the electric field and does not include the random thermal velocity. If we assume that the effective mass and electric field are constants, then we may integrate Equation (5.10) and obtain

\[ v = \frac{eEt}{m_p^*} \]  \hspace{1cm} (5.11)

where we have assumed the initial drift velocity to be zero.

Figure 5.1a shows a schematic model of the random thermal velocity and motion of a hole in a semiconductor with zero electric field. There is a mean time between collisions which may be denoted by \( \tau_{cp} \). If a small electric field (E-field) is
applied as indicated in Figure 5.1b, there will be a net drift of the hole in the direction of the E-field, and the net drift velocity will be a small perturbation on the random thermal velocity, so the time between collisions will not be altered appreciably. If we use the mean time between collisions $\tau_{cp}$ in place of the time $t$ in Equation (5.11), then the mean peak velocity just prior to a collision or scattering event is

$$v_{d|\text{peak}} = \left(\frac{e\tau_{cp}}{m_p^*}\right)E \quad (5.12a)$$

The average drift velocity is one half the peak value so that we can write

$$\langle v_d \rangle = \frac{1}{2}\left(\frac{e\tau_{cp}}{m_p^*}\right)E \quad (5.12b)$$

However, the collision process is not as simple as this model, but is statistical in nature. In a more accurate model including the effect of a statistical distribution, the factor $\frac{1}{2}$ in Equation (5.12b) does not appear. The hole mobility is then given by

$$\mu_p = \frac{v_{dp}}{E} = \frac{e\tau_{cp}}{m_p^*} \quad (5.13)$$

The same analysis applies to electrons; thus we can write the electron mobility as

$$\mu_e = \frac{e\tau_{en}}{m_e^*} \quad (5.14)$$

where $\tau_{en}$ is the mean time between collisions for an electron.

There are two collision or scattering mechanisms that dominate in a semiconductor and affect the carrier mobility: phonon or lattice scattering, and ionized impurity scattering.

The atoms in a semiconductor crystal have a certain amount of thermal energy at temperatures above absolute zero that causes the atoms to randomly vibrate about their lattice position within the crystal. The lattice vibrations cause a disruption in the...
perfect periodic potential function. A perfect periodic potential in a solid allows electrons to move unimpeded, or with no scattering, through the crystal. But the thermal vibrations cause a disruption of the potential function, resulting in an interaction between the electrons or holes and the vibrating lattice atoms. This lattice scattering is also referred to as phonon scattering.

Since lattice scattering is related to the thermal motion of atoms, the rate at which the scattering occurs is a function of temperature. If we denote $\mu_L$ as the mobility that would be observed if only lattice scattering existed, then the scattering theory states that to first order

$$\mu_L \propto T^{-3/2}$$

(5.15)

Mobility that is due to lattice scattering increases as the temperature decreases. Intuitively, we expect the lattice vibrations to decrease as the temperature decreases, which implies that the probability of a scattering event also decreases, thus increasing mobility.

Figure 5.2 shows the temperature dependence of electron and hole mobilities in silicon. In lightly doped semiconductors, lattice scattering dominates and the carrier mobility decreases with temperature as we have discussed. The temperature dependence of mobility is proportional to $T^{-\eta}$. The inserts in the figure show that the parameter $\eta$ is not equal to $\frac{3}{2}$ as the first-order scattering theory predicted. However, mobility does increase as the temperature decreases.

The second interaction mechanism affecting carrier mobility is called ionized impurity scattering. We have seen that impurity atoms are added to the semiconductor to control or alter its characteristics. These impurities are ionized at room temperature so that a coulomb interaction exists between the electrons or holes and the ionized impurities. This coulomb interaction produces scattering or collisions and also alters the velocity characteristics of the charge carrier. If we denote $\mu_I$ as the mobility that would be observed if only ionized impurity scattering existed, then to first order we have

$$\mu_I \propto \frac{T^{3/2}}{N_I}$$

(5.16)

where $N_I = N_d^+ + N_a^-$ is the total ionized impurity concentration in the semiconductor. If temperature increases, the random thermal velocity of a carrier increases, reducing the time the carrier spends in the vicinity of the ionized impurity center. The less time spent in the vicinity of a coulomb force, the smaller the scattering effect and the larger the expected value of $\mu_I$. If the number of ionized impurity centers increases, then the probability of a carrier encountering an ionized impurity center increases, implying a smaller value of $\mu_I$.

Figure 5.3 is a plot of electron and hole mobilities in germanium, silicon, and gallium arsenide at $T = 300$ K as a function of impurity concentration. More accurately, these curves are of mobility versus ionized impurity concentration $N_I$. As the impurity concentration increases, the number of impurity scattering centers increases, thus reducing mobility.
Figure 5.21 (a) Electron and (b) hole mobilities in silicon versus temperature for various doping concentrations. Inserts show temperature dependence for "almost" lattice-stripe n.
Figure 5.3 | Electron and hole mobilities versus impurity concentrations for germanium, silicon, and gallium arsenide at \( T = 300 \text{ K} \).

(From Sze [12].)

**TEST YOUR UNDERSTANDING**

**E5.3**  
(a) Using Figure 5.2, find the electron mobility for (i) \( N_d = 10^{17} \text{ cm}^{-3}, T = 150^\circ \text{C} \) and (ii) \( N_d = 10^{16} \text{ cm}^{-3}, T = 0^\circ \text{C} \).  
(b) Find the hole mobilities for (i) \( N_a = 10^{16} \text{ cm}^{-3}, T = 50^\circ \text{C} \); and (ii) \( N_a = 10^{17} \text{ cm}^{-3}, T = 150^\circ \text{C} \).  

**E5.4** Using Figure 5.3, determine the electron and hole mobilities in (a) silicon for \( N_d = 10^{15} \text{ cm}^{-3}, N_d = 0 \); (b) silicon for \( N_d = 10^{17} \text{ cm}^{-3}, N_d = 5 \times 10^{16} \text{ cm}^{-3} \); (c) silicon for \( N_d = 10^{16} \text{ cm}^{-3}, N_d = 10^{17} \text{ cm}^{-3} \); and (d) GaAs for \( N_d = N_a = 10^{17} \text{ cm}^{-3} \).

If \( \tau_L \) is the mean time between collisions due to lattice scattering, then \( dt/\tau_L \) is the probability of a lattice scattering event occurring in a differential time \( dt \). Likewise, if \( \tau_I \) is the mean time between collisions due to ionized impurity scattering,
then \( dt/\tau_I \) is the probability of an ionized impurity scattering event occurring in the differential time \( dt \). If these two scattering processes are independent, then the total probability of a scattering event occurring in the differential time \( dt \) is the sum of the individual events, or

\[
dt/\tau = dt/\tau_I + dt/\tau_L
\]  

(5.17)

where \( \tau \) is the mean time between any scattering event.

Comparing Equation (5.17) with the definitions of mobility given by Equation (5.13) or (5.14), we can write

\[
1/\mu = 1/\mu_I + 1/\mu_L
\]  

(5.18)

where \( \mu_I \) is the mobility due to the ionized impurity scattering process and \( \mu_L \) is the mobility due to the lattice scattering process. The parameter \( \mu \) is the net mobility. With two or more independent scattering mechanisms, the inverse mobilities add, which means that the net mobility decreases.

### 5.1.3 Conductivity

The drift current density, given by Equation (5.9), may be written as

\[
J_{dr,f} = e(\mu_n n + \mu_p p)E = \sigma E
\]  

(5.19)

where \( \sigma \) is the conductivity of the semiconductor material. The conductivity is given in units of \( (\Omega \cdot \text{cm})^{-1} \) and is a function of the electron and hole concentrations and mobilities. We have just seen that the mobilities are functions of impurity concentrations, so conductivity, then is a somewhat complicated function of impurity concentration.

The reciprocal of conductivity is resistivity, which is denoted by \( \rho \) and is given in units of ohm-cm. We can write the formula for resistivity as

\[
\rho = 1/\sigma = 1/e(\mu_n n + \mu_p p)
\]  

(5.20)

Figure 5.4 is a plot of resistivity as a function of impurity concentration in silicon, germanium, gallium arsenide, and gallium phosphide at \( T = 300 \) K. Obviously, the curves are not linear functions of \( N_d \) or \( N_a \) because of mobility effects.

If we have a bar of semiconductor material as shown in Figure 5.5 with a voltage applied that produces a current \( I \), then we can write

\[
J = \frac{I}{A}
\]  

(5.21a)

and

\[
E = \frac{V}{L}
\]  

(5.21b)
Figure 5.4 | Resistivity versus impurity concentration at $T = 300$ K in (a) silicon and (b) germanium, gallium arsenide, and gallium phosphide. (From Sze [12].)
We can now rewrite Equation (5.19) as

\[
\frac{I}{A} = \sigma \left( \frac{V}{L} \right)
\]  

(5.22)

or

\[
V = \left( \frac{L}{\sigma A} \right) I = \left( \frac{\rho L}{A} \right) I = I R
\]  

(5.22)

Equation (5.22b) is Ohm’s law for a semiconductor. The resistance is a function of resistivity, or conductivity, as well as the geometry of the semiconductor.

If we consider, for example, a p-type semiconductor with an acceptor doping \( N_a (N_d = 0) \) in which \( N_a \gg n_i \), and if we assume that the electron and hole mobilities are of the same order of magnitude, then the conductivity becomes

\[
\sigma = e (\mu_n n + \mu_p p) \approx e \mu_p p
\]  

(5.23)

If we also assume complete ionization, then Equation (5.23) becomes

\[
\sigma \approx e \mu_p N_a \approx \frac{1}{\rho}
\]  

(5.24)

The conductivity and resistivity of an extrinsic semiconductor are a function primarily of the majority carrier parameters.

We may plot the carrier concentration and conductivity of a semiconductor as a function of temperature for a particular doping concentration. Figure 5.6 shows the electron concentration and conductivity of silicon as a function of inverse temperature for the case when \( N_d = 10^{15} \text{ cm}^{-3} \). In the midtemperature range, or extrinsic range, as shown, we have complete ionization—the electron concentration remains essentially constant. However, the mobility is a function of temperature so the conductivity
5.1 Carrier Drift

The carrier concentration varies with temperature in this range. At higher temperatures, the intrinsic carrier concentration increases and begins to dominate the electron concentration as well as the conductivity. In the lower temperature range, freeze-out begins to occur; the electron concentration and conductivity decrease with decreasing temperature.

**Objective**

**EXAMPLE 5.2**

To determine the doping concentration and majority carrier mobility given the type and conductivity of a compensated semiconductor.

Consider compensated n-type silicon at $T = 300$ K, with a conductivity of $\sigma = 16 \text{ (} \Omega \cdot \text{cm)}^{-1}$ and an acceptor doping concentration of $10^{17} \text{ cm}^{-3}$. Determine the donor concentration and the electron mobility.

**Solution**

For n-type silicon at $T = 300$ K, we can assume complete ionization; therefore the conductivity, assuming $N_d - N_a \gg n_i$, is given by

$$\sigma \approx e\mu_n n = e\mu_n (N_d - N_a)$$

We have that

$$16 = (1.6 \times 10^{-19})\mu_n (N_d - 10^{17})$$

Since mobility is a function of the ionized impurity concentration, we can use Figure 5.3 along with trial and error to determine $\mu_n$ and $N_d$. For example, if we choose $N_d = 2 \times 10^{17}$, then...
CHAPTER 5  Carrier Transport Phenomena

\[ N_I = N_d^+ + N_a^- = 3 \times 10^{17} \] so that \( \mu_n \approx 510 \text{ cm}^2/\text{V-s} \) which gives \( \sigma = 8.16 \text{ (}\Omega\text{-cm})^{-1} \)

If we choose \( N_d = 5 \times 10^{17} \), then \( N_I = 6 \times 10^{17} \) so that \( \mu_n \approx 325 \text{ cm}^2/\text{V-s} \), which gives \( \sigma = 20.8 \text{ (}\Omega\text{-cm})^{-1} \). The doping is bounded between these two values. Further trial and error yields

\[ N_d \approx 3.5 \times 10^{17} \text{ cm}^{-3} \]

and

\[ \mu_n \approx 400 \text{ cm}^2/\text{V-s} \]

which gives

\[ \sigma \approx 16 \text{ (}\Omega\text{-cm})^{-1} \]

**Comment**

We can see from this example that, in high-conductivity semiconductor material, mobility is a strong function of carrier concentration.

---

**DESIGN EXAMPLE 5.3**

**Objective**

To design a semiconductor resistor with a specified resistance to handle a given current density.

A silicon semiconductor at \( T = 300 \text{ K} \) is initially doped with donors at a concentration \( N_d = 5 \times 10^{15} \text{ cm}^{-3} \). Acceptors are to be added to form a compensated p-type material. The resistor is to have a resistance of 10 k\( \Omega \) and handle a current density of 50 A/cm\(^2\) when 5 V applied.

**Solution**

For 5 V applied to a 10-k\( \Omega \) resistor, the total current is

\[ I = \frac{V}{R} = \frac{5}{10} = 0.5 \text{ mA} \]

If the current density is limited to 50 A/cm\(^2\), then the cross-sectional area is

\[ A = \frac{I}{J} = \frac{0.5 \times 10^{-3}}{50} = 10^{-5} \text{ cm}^2 \]

If we, somewhat arbitrarily at this point, limit the electric field to \( E = 100 \text{ V/cm} \), then the length of the resistor is

\[ L = \frac{V}{E} = \frac{5}{100} = 5 \times 10^{-2} \text{ cm} \]

From Equation (5.22b), the conductivity of the semiconductor is

\[ \sigma = \frac{L}{RA} = \frac{5 \times 10^{-2}}{(10^4)(10^{-5})} = 0.50 \text{ (}\Omega\text{-cm})^{-1} \]

The conductivity of a compensated p-type semiconductor is

\[ \sigma \approx e\mu_p p = e\mu_p (N_a - N_d) \]

where the mobility is a function of the total ionized impurity concentration \( N_a + N_d \).
Using trial and error, if \( N_o = 1.25 \times 10^{16} \ \text{cm}^{-3} \), then \( N_o + N_d = 1.75 \times 10^{16} \ \text{cm}^{-3} \), and the hole mobility, from Figure 5.3, is approximately \( \mu_p = 410 \ \text{cm}^2/V\text{-s} \). The conductivity is then

\[
\sigma = e\mu_p (N_o - N_d) = (1.6 \times 10^{-19})(410)(1.25 \times 10^{16} - 5 \times 10^{15}) = 0.492
\]

which is very close to the value we need.

**Comment**

Since the mobility is related to the total ionized impurity concentration, the determination of the impurity concentration to achieve a particular conductivity is not straightforward.

### TEST YOUR UNDERSTANDING

**E5.5** Silicon at \( T = 300 \ \text{K} \) is doped with impurity concentrations of \( N_d = 5 \times 10^{16} \ \text{cm}^{-3} \) and \( N_o = 2 \times 10^{16} \ \text{cm}^{-3} \). (a) What are the electron and hole mobilities? (b) Determine the conductivity and resistivity of the material.

**E5.6** For a particular silicon semiconductor device at \( T = 300 \ \text{K} \), the required material is n type with a resistivity of 0.10 \( \Omega\text{-cm} \). (a) Determine the required impurity doping concentration and (b) the resulting electron mobility.

**E5.7** A bar of p-type silicon, such as shown in Figure 5.5, has a cross-sectional area of \( A = 10^{-6} \ \text{cm}^2 \) and a length of \( L = 1.2 \times 10^{-3} \ \text{cm} \). For an applied voltage of 5 V, a current of 2 mA is required. What is the required (a) resistance, (b) resistivity of the silicon, and (c) impurity doping concentration?

For an intrinsic material, the conductivity can be written as

\[
\sigma_i = e(\mu_n + \mu_p)n_i \tag{5.25}
\]

The concentrations of electrons and holes are equal in an intrinsic semiconductor, so the intrinsic conductivity includes both the electron and hole mobility. Since, in general, the electron and hole mobilities are not equal, the intrinsic conductivity is not the minimum value possible at a given temperature.

### 5.1.4 Velocity Saturation

So far in our discussion of drift velocity, we have assumed that mobility is not a function of electric field, meaning that the drift velocity will increase linearly with applied electric field. The total velocity of a particle is the sum of the random thermal velocity and drift velocity. At \( T = 300 \ \text{K} \), the average random thermal energy is given by

\[
\frac{1}{2}m
\nu_{th}^2 = \frac{3}{2}kT = \frac{3}{2}(0.0259) = 0.03885 \ \text{eV} \tag{5.26}
\]
This energy translates into a mean thermal velocity of approximately $10^7$ cm/s for an electron in silicon. If we assume an electron mobility of $\mu_n = 1350$ cm$^2$/V-s in low-doped silicon, a drift velocity of $10^5$ cm/s, or 1 percent of the thermal velocity, is achieved if the applied electric field is approximately 75 V/cm. This applied electric field does not appreciably alter the energy of the electron.

Figure 5.7 is a plot of average drift velocity as a function of applied electric field for electrons and holes in silicon, gallium arsenide, and germanium. At low electric fields, where there is a linear variation of velocity with electric field, the slope of the drift velocity versus electric field curve is the mobility. The behavior of the drift velocity of carriers at high electric fields deviates substantially from the linear relationship observed at low fields. The drift velocity of electrons in silicon, for example, saturates at approximately $10^7$ cm/s at an electric field of approximately 30 kV/cm. If the drift velocity of a charge carrier saturates, then the drift current density also saturates and becomes independent of the applied electric field.

The drift velocity versus electric field characteristic of gallium arsenide is more complicated than for silicon or germanium. At low fields, the slope of the drift velocity versus E-field is constant and is the low-field electron mobility, which is approximately 8500 cm$^2$/V-s for gallium arsenide. The low-field electron mobility in gallium arsenide is much larger than in silicon. As the field increases, the electron drift velocity in gallium arsenide reaches a peak and then decreases. A differential mobility is the slope of the $u_d$ versus E curve at a particular point on the curve and the negative slope of the drift velocity versus electric field represents a negative differential mobility. The negative differential mobility produces a negative differential resistance; this characteristic is used in the design of oscillators.
The negative differential mobility can be understood by considering the $E$ versus $k$ diagram for gallium arsenide, which is shown again in Figure 5.8. The density of states effective mass of the electron in the lower valley is $m_e^* = 0.067m_0$. The small effective mass leads to a large mobility. As the $E$-field increases, the energy of the electron increases and the electron can be scattered into the upper valley, where the density of states effective mass is $0.55m_0$. The larger effective mass in the upper valley yields a smaller mobility. This intervalley transfer mechanism results in a decreasing average drift velocity of electrons with electric field, or the negative differential mobility characteristic.

5.2 CARRIER DIFFUSION

There is a second mechanism, in addition to drift, that can induce a current in a semiconductor. We may consider a classic physics example in which a container, as shown in Figure 5.9, is divided into two parts by a membrane. The left side contains gas molecules at a particular temperature and the right side is initially empty. The gas molecules are in continual random thermal motion so that, when the membrane is broken, the gas molecules flow into the right side of the container. Diffusion is the process whereby particles flow from a region of high concentration toward a region of low concentration.
Figure 5.9 | Container divided by a membrane with gas molecules on one side.

Figure 5.10 | Electron concentration versus distance.

concentration. If the gas molecules were electrically charged, the net flow of charge would result in a diffusion current.

5.2.1 Diffusion Current Density

To begin to understand the diffusion process in a semiconductor, we will consider a simplified analysis. Assume that an electron concentration varies in one dimension as shown in Figure 5.10. The temperature is assumed to be uniform so that the average thermal velocity of electrons is independent of $x$. To calculate the current, we will determine the net flow of electrons per unit time per unit area crossing the plane at $x = 0$. If the distance $l$ shown in Figure 5.10 is the mean-free path of an electron, then, on average, an electron travels between collisions ($l = v_{th} \tau_{coll}$), then the average, electrons moving to the right at $x = -l$ and electrons moving to the left at $x = +l$ will cross the $x = 0$ plane. One half of the electrons at $x = -l$ will be traveling to the right at any instant of time and one half of the electrons at $x = +l$ will be traveling to the left at any given time. The net rate of electron flow, $F_n$, in the $x$ direction is:

$$F_n = \frac{1}{2} \left( n(-l) v_{th} \right) - \frac{1}{2} \left( n(+l) v_{th} \right)$$

where $n(-l)$ and $n(+l)$ are the electron concentrations at $x = -l$ and $x = +l$, respectively.

$$F_n = \frac{1}{2} \left( n(-l) - n(+l) \right) v_{th}$$

This equation represents the net diffusion current density. The term $n(-l) - n(+l)$ is the difference in electron concentration between the two sides of the membrane.
5.2 Carrier Diffusion

Direction at \( x = 0 \) is given by

\[
F_n = \frac{1}{2} n(-l) v_{th} - \frac{1}{2} n(+l) v_{th} = \frac{1}{2} v_{th} [n(-l) - n(+l)] \tag{5.27}
\]

If we expand the electron concentration in a Taylor series about \( x = 0 \) keeping only the first two terms, then we can write Equation (5.27) as

\[
F_n = \frac{1}{2} v_{th} \left\{ \left[ n(0) - l \frac{dn}{dx} \right] - \left[ n(0) + l \frac{dn}{dx} \right] \right\} \tag{5.28}
\]

which becomes

\[
F_n = -v_{th} l \frac{dn}{dx} \tag{5.29}
\]

Each electron has a charge \((-e)\), so the current is

\[
J = -e F_n = +e v_{th} l \frac{dn}{dx} \tag{5.30}
\]

The current described by Equation (5.30) is the electron diffusion current and is proportional to the spatial derivative, or density gradient, of the electron concentration.

The diffusion of electrons from a region of high concentration to a region of low concentration produces a flux of electrons flowing in the negative \( x \) direction for this example. Since electrons have a negative charge, the conventional current direction is in the positive \( x \) direction. Figure 5.11a shows these one-dimensional flux and current directions. We may write the electron diffusion current density for this one-dimensional case, in the form

\[
J_{nx|\text{dif}} = e D_n \frac{dn}{dx} \tag{5.31}
\]

where \( D_n \) is called the electron diffusion coefficient, has units of \( \text{cm}^2/\text{s} \), and is a positive quantity. If the electron density gradient becomes negative, the electron diffusion current density will be in the negative \( x \) direction.

Figure 5.11b shows an example of a hole concentration as a function of distance in a semiconductor. The diffusion of holes, from a region of high concentration to a region of low concentration, produces a flux of holes in the negative \( x \) direction. Since holes are positively charged particles, the conventional diffusion current density is also in the negative \( x \) direction. The hole diffusion current density is proportional to the hole density gradient and to the electronic charge, so we may write

\[
J_{px|\text{dif}} = -e D_p \frac{dp}{dx} \tag{5.32}
\]
for the one-dimensional case. The parameter \( D_p \) is called the \textit{hole diffusion coefficient}, has units of \( \text{cm}^2/\text{s} \), and is a positive quantity. If the hole density gradient becomes negative, the hole diffusion current density will be in the positive \( x \) direction.

**EXAMPLE 5.4**

**Objective**

To calculate the diffusion current density given a density gradient.

Assume that, in an n-type gallium arsenide semiconductor at \( T = 300 \text{ K} \), the electron concentration varies linearly from \( 1 \times 10^{18} \) to \( 7 \times 10^{17} \text{ cm}^{-3} \) over a distance of 0.10 cm. Calculate the diffusion current density if the electron diffusion coefficient is \( D_n = 225 \text{ cm}^2/\text{s} \).

**Solution**

The diffusion current density is given by

\[
J_{n, \text{diff}} = e D_n \frac{dn}{dx} \approx e D_n \frac{\Delta n}{\Delta x}
\]

\[
= (1.6 \times 10^{-19})(225)\left(\frac{1 \times 10^{18} - 7 \times 10^{17}}{0.10}\right) = 108 \text{ A/cm}^2
\]

**Comment**

A significant diffusion current density can be generated in a semiconductor material with a modest density gradient.
TEST YOUR UNDERSTANDING

E5.8 The electron concentration in silicon is given by \( n(x) = 10^{15} e^{-(x/L_n)} \text{ cm}^{-3} \) \((x \geq 0)\)
where \( L_n = 10^{-4} \text{ cm} \). The electron diffusion coefficient is \( D_n = 25 \text{ cm}^2/\text{s} \). Determine the electron diffusion current density at (a) \( x = 0 \), (b) \( x = 10^{-4} \text{ cm} \), and (c) \( x \rightarrow \infty \).

E5.9 The hole concentration in silicon varies linearly from \( x = 0 \) to \( x = 0.01 \text{ cm} \). The hole diffusion coefficient is \( D_p = 10 \text{ cm}^2/\text{s} \), the hole diffusion current density is \( 20 \text{ A/cm}^2 \), and the hole concentration at \( x = 0 \) is \( p = 4 \times 10^{17} \text{ cm}^{-3} \). What is the value of the hole concentration at \( x = 0.01 \text{ cm} \)?

E5.10 The hole concentration in silicon is given by \( p(x) = 2 \times 10^{15} e^{-(x/L_p)} \text{ cm}^{-3} \)
\((x \geq 0)\). The hole diffusion coefficient is \( D_p = 10 \text{ cm}^2/\text{s} \). The value of the diffusion current density at \( x = 0 \) is \( J_{\text{diff}} = +6.4 \text{ A/cm}^2 \). What is the value of \( L_p \)?

5.2.2 Total Current Density

We now have four possible independent current mechanisms in a semiconductor. These components are electron drift and diffusion currents and hole drift and diffusion currents. The total current density is the sum of these four components, or, for the one-dimensional case,

\[
J = en\mu_n E_x + ep\mu_p E_x + eD_n \frac{dn}{dx} - eD_p \frac{dp}{dx}
\] (5.33)

This equation may be generalized to three dimensions as

\[
J = en\mu_n E + ep\mu_p E + eD_n \nabla n - eD_p \nabla p
\] (5.34)

The electron mobility gives an indication of how well an electron moves in a semiconductor as a result of the force of an electric field. The electron diffusion coefficient gives an indication of how well an electron moves in a semiconductor as a result of a density gradient. The electron mobility and diffusion coefficient are not independent parameters. Similarly, the hole mobility and diffusion coefficient are not independent parameters. The relationship between mobility and the diffusion coefficient will be developed in the next section.

The expression for the total current in a semiconductor contains four terms. Fortunately in most situations, we will only need to consider one term at any one time at a particular point in a semiconductor.

5.3 Graded Impurity Distribution

In most cases so far, we have assumed that the semiconductor is uniformly doped. In many semiconductor devices, however, there may be regions that are nonuniformly doped. We will investigate how a nonuniformly doped semiconductor reaches thermal
equilibrium and, from this analysis, we will derive the Einstein relation, which relates mobility and the diffusion coefficient.

### 5.3.1 Induced Electric Field

Consider a semiconductor that is nonuniformly doped with donor impurity atoms. If the semiconductor is in thermal equilibrium, the Fermi energy level is constant through the crystal so the energy-band diagram may qualitatively look like that shown in Figure 5.12. The doping concentration decreases as \( x \) increases in this case. There will be a diffusion of majority carrier electrons from the region of high concentration to the region of low concentration, which is in the \( +x \) direction. The flow of negative electrons leaves behind positively charged donor ions. The separation of positive and negative charge induces an electric field that is in a direction to oppose the diffusion process. When equilibrium is reached, the mobile carrier concentration is not exactly equal to the fixed impurity concentration and the induced electric field prevents any further separation of charge. In most cases of interest, the space charge induced by this diffusion process is a small fraction of the impurity concentration, thus the mobile carrier concentration is not too different from the impurity dopant density.

The electric potential \( \phi \) is related to electron potential energy by the charge \( (-e) \), so we can write

\[
\phi = \frac{-1}{e}(E_F - E_{Fi})
\]  

(5)

The electric field for the one-dimensional situation is defined as

\[
E_x = \frac{-d\phi}{dx} = \frac{1}{e} \frac{dE_{Fi}}{dx}
\]  

(5)

Figure 5.12 | Energy-band diagram for a semiconductor in thermal equilibrium with a nonuniform donor impurity concentration.
If the intrinsic Fermi level changes as a function of distance through a semiconductor in thermal equilibrium, an electric field exists in the semiconductor.

If we assume a quasi-neutrality condition in which the electron concentration is almost equal to the donor impurity concentration, then we can still write

\[ n_0 = n_i \exp \left[ \frac{E_F - E_{Fi}}{kT} \right] \approx N_d(x) \quad (5.37) \]

Solving for \( E_F - E_{Fi} \), we obtain

\[ E_F - E_{Fi} = kT \ln \left( \frac{N_d(x)}{n_i} \right) \quad (5.38) \]

The Fermi level is constant for thermal equilibrium so when we take the derivative with respect to \( x \) we obtain

\[ -\frac{dE_{Fi}}{dx} = \frac{kT}{N_d(x)} \frac{dN_d(x)}{dx} \quad (5.39) \]

The electric field can then be written, combining Equations (5.39) and (5.36), as

\[ E_x = -\left( \frac{kT}{e} \right) \frac{1}{N_d(x)} \frac{dN_d(x)}{dx} \quad (5.40) \]

Since we have an electric field, there will be a potential difference through the semiconductor due to the nonuniform doping.

---

**Objective**

To determine the induced electric field in a semiconductor in thermal equilibrium, given a linear variation in doping concentration.

**Example 5.5**

Assume that the donor concentration in an n-type semiconductor at \( T = 300 \text{ K} \) is given by

\[ N_d(x) = 10^{16} - 10^{19}x \quad (\text{cm}^{-3}) \]

where \( x \) is given in cm and ranges between \( 0 \leq x \leq 1 \mu\text{m} \)

**Solution**

Taking the derivative of the donor concentration, we have

\[ \frac{dN_d(x)}{dx} = -10^{19} \quad (\text{cm}^{-4}) \]

The electric field is given by Equation (5.40), so we have

\[ E_x = \frac{-(0.0259)(-10^{19})}{(10^{16} - 10^{19}x)} \]

At \( x = 0 \), for example, we find

\[ E_x = 25.9 \text{ V/cm} \]
Comment

We may recall from our previous discussion of drift current that fairly small electric fields produce significant drift current densities, so that an induced electric field from nonuniform doping can significantly influence semiconductor device characteristics.

5.3.2 The Einstein Relation

If we consider the nonuniformly doped semiconductor represented by the energy band diagram shown in Figure 5.12 and assume there are no electrical connections that the semiconductor is in thermal equilibrium, then the individual electron and hole currents must be zero. We can write

\[ J_n = 0 = e\mu_n^* E_x + eD_n \frac{dn}{dx} \quad (5.41) \]

If we assume quasi-neutrality so that \( n \approx N_d(x) \), then we can rewrite Equation (5.41) as

\[ J_n = 0 = e\mu_n N_d(x) E_x + eD_n \frac{dN_d(x)}{dx} \quad (5.42) \]

Substituting the expression for the electric field from Equation (5.40) into Equation (5.42), we obtain

\[ 0 = -e\mu_n N_d(x) \left( \frac{kT}{e} \right) \frac{1}{N_d(x)} \frac{dN_d(x)}{dx} + eD_n \frac{dN_d(x)}{dx} \quad (5.43) \]

Equation (5.43) is valid for the condition

\[ \frac{D_n}{\mu_n} = \frac{kT}{e} \quad (5.44a) \]

The hole current must also be zero in the semiconductor. From this condition, we can show that

\[ \frac{D_p}{\mu_p} = \frac{kT}{e} \quad (5.44b) \]

Combining Equations (5.44a) and (5.44b) gives

\[ \frac{D_n}{\mu_n} = \frac{D_p}{\mu_p} = \frac{kT}{e} \quad (5.45) \]

The diffusion coefficient and mobility are not independent parameters. This relation between the mobility and diffusion coefficient, given by Equation (5.45), is known as the Einstein relation.
Table 5.2 | Typical mobility and diffusion coefficient values at
$T = 300$ K ($\mu = \text{cm}^2/\text{V-s}$ and $D = \text{cm}^2/\text{s}$)

<table>
<thead>
<tr>
<th>Material</th>
<th>$\mu_m$</th>
<th>$D_n$</th>
<th>$\mu_p$</th>
<th>$D_p$</th>
</tr>
</thead>
<tbody>
<tr>
<td>Silicon</td>
<td>1350</td>
<td>35</td>
<td>480</td>
<td>12.4</td>
</tr>
<tr>
<td>Gallium arsenide</td>
<td>8500</td>
<td>220</td>
<td>400</td>
<td>10.4</td>
</tr>
<tr>
<td>Germanium</td>
<td>3900</td>
<td>101</td>
<td>1900</td>
<td>49.2</td>
</tr>
</tbody>
</table>

To determine the diffusion coefficient given the carrier mobility. Assume that the mobility of a particular carrier is 1000 cm²/V-s at $T = 300$ K.

**Solution**

Using the Einstein relation, we have that

$$D = \left(\frac{kT}{e}\right)\mu = (0.0259)(1000) = 25.9 \text{ cm}^2/\text{s}$$

**Comment**

Although this example is fairly simple and straightforward, it is important to keep in mind the relative orders of magnitude of the mobility and diffusion coefficient. The diffusion coefficient is approximately 40 times smaller than the mobility at room temperature.

Table 5.2 shows the diffusion coefficient values at $T = 300$ K corresponding to the mobilities listed in Table 5.1 for silicon, gallium arsenide, and germanium.

The relation between the mobility and diffusion coefficient given by Equation (5.45) contains temperature. It is important to keep in mind that the major temperature effects are a result of lattice scattering and ionized impurity scattering processes, as discussed in Section 5.1.2. As the mobilities are strong functions of temperature because of the scattering processes, the diffusion coefficients are also strong functions of temperature. The specific temperature dependence given in Equation (5.45) is a small fraction of the real temperature characteristic.

*5.4 | THE HALL EFFECT*

The Hall effect is a consequence of the forces that are exerted on moving charges by electric and magnetic fields. The Hall effect is used to distinguish whether a semiconductor is n-type or p-type and to measure the majority carrier concentration and majority carrier mobility. The Hall effect device, as discussed in this section, is used to experimentally measure semiconductor parameters. However, it is also used extensively in engineering applications as a magnetic probe and in other circuit applications.

*We will assume an extrinsic semiconductor material in which the majority carrier concentration is much larger than the minority carrier concentration.
The force on a particle having a charge $q$ and moving in a magnetic field is given by

$$F = qv \times B$$

where the cross product is taken between velocity and magnetic field so that the force vector is perpendicular to both the velocity and magnetic field.

Figure 5.13 illustrates the Hall effect. A semiconductor with a current $I_x$ placed in a magnetic field perpendicular to the current. In this case, the magnetic field is in the $z$ direction. Electrons and holes flowing in the semiconductor will experience a force as indicated in the figure. The force on both electrons and holes is in the $(-y)$ direction. In a p-type semiconductor ($p_0 > n_0$), there will be a buildup of positive charge on the $y = 0$ surface of the semiconductor and, in an n-type semiconductor ($n_0 > p_0$), there will be a buildup of negative charge on the $y = 0$ surface. This net charge induces an electric field in the $y$-direction as shown in the figure. In steady state, the magnetic field force will be exactly balanced by the induced electric field force. This balance may be written as

$$F = q[E + v \times B] = 0$$

which becomes

$$qE_y = qv_zB_z$$

The induced electric field in the $y$-direction is called the Hall field. The Hall field produces a voltage across the semiconductor which is called the Hall voltage. We can write

$$V_H = +E_HW$$
The hole mobility is then given by
\[ \mu_p = \frac{I_x L}{epV_x Wd} \]  

Similarly for an n-type semiconductor, the low-field electron mobility is determined from
\[ \mu_n = \frac{I_x L}{enV_x Wd} \]

**EXAMPLE 5.7**

**Objective**

To determine the majority carrier concentration and mobility, given Hall effect parameters.

Consider the geometry shown in Figure 5.13. Let \( L = 10^{-1} \, \text{cm} \), \( W = 10^{-2} \, \text{cm} \), \( d = 10^{-3} \, \text{cm} \). Also assume that \( I_x = 1.0 \, \text{mA} \), \( V_x = 12.5 \, \text{V} \), \( B_z = 500 \, \text{gauss} = 5 \times 10^{-2} \, \text{T} \), and \( V_H = -6.25 \, \text{mV} \).

**Solution**

A negative Hall voltage for this geometry implies that we have an n-type semiconductor.

Using Equation (5.54), we can calculate the electron concentration as
\[ n = \frac{-5 \times 10^{-3}}{(1.6 \times 10^{-19})(10^{-3})(-6.25 \times 10^{-3})} = 5 \times 10^{21} \, \text{m}^{-3} = 5 \times 10^{15} \, \text{cm}^{-3} \]

The electron mobility is then determined from Equation (5.58) as
\[ \mu_n = \frac{(10^{-3})(10^{-3})}{(1.6 \times 10^{-19})(5 \times 10^{21})(12.5)(10^{-4})(10^{-5})} = 0.10 \, \text{m}^2/\text{V-s} \]

or
\[ \mu_n = 1000 \, \text{cm}^2/\text{V-s} \]

**Comment**

It is important to note that the MKS units must be used consistently in the Hall effect equations to yield correct results.

**5.5 SUMMARY**

- The two basic transport mechanisms are drift, due to an applied electric field, and diffusion, due to a density gradient.
- Carriers reach an average drift velocity in the presence of an applied electric field, due to scattering events. Two scattering processes within a semiconductor are lattice scattering and impurity scattering.
- The average drift velocity is a linear function of the applied electric field for small values of electric field, but the drift velocity reaches a saturation limit that is on the order of \( 10^7 \, \text{cm/s} \) at high electric fields.
Carrier mobility is the ratio of the average drift velocity and applied electric field. The electron and hole mobilities are functions of temperature and of the ionized impurity concentration.

The drift current density is the product of conductivity and electric field (a form of Ohm's law). Conductivity is a function of the carrier concentrations and mobilities. Resistivity is the inverse of conductivity.

The diffusion current density is proportional to the carrier diffusion coefficient and the carrier density gradient.

The diffusion coefficient and mobility are related through the Einstein relation.

The Hall effect is a consequence of a charged carrier moving in the presence of perpendicular electric and magnetic fields. The charged carrier is deflected, inducing a Hall voltage. The polarity of the Hall voltage is a function of the semiconductor conductivity type. The majority carrier concentration and mobility can be determined from the Hall voltage.

**GLOSSARY OF IMPORTANT TERMS**

**conductivity** A material parameter related to carrier drift; quantitatively, the ratio of drift current density to electric field.

**diffusion** The process whereby particles flow from a region of high concentration to a region of low concentration.

**diffusion coefficient** The parameter relating particle flux to the particle density gradient.

**diffusion current** The current that results from the diffusion of charged particles.

**drift** The process whereby charged particles move while under the influence of an electric field.

**drift current** The current that results from the drift of charged particles.

**drift velocity** The average velocity of charged particles in the presence of an electric field.

**Einstein relation** The relation between the mobility and the diffusion coefficient.

**Hall voltage** The voltage induced across a semiconductor in a Hall effect measurement.

**ionized impurity scattering** The interaction between a charged carrier and an ionized impurity center.

**lattice scattering** The interaction between a charged carrier and a thermally vibrating lattice atom.

**mobility** The parameter relating carrier drift velocity and electric field.

**resistivity** The reciprocal of conductivity; a material parameter that is a measure of the resistance to current.

**velocity saturation** The saturation of carrier drift velocity with increasing electric field.

**CHECKPOINT**

After studying this chapter, the reader should have the ability to:

- Discuss carrier drift current density.
- Explain why carriers reach an average drift velocity in the presence of an applied electric field.
- Discuss the mechanisms of lattice scattering and impurity scattering.
CHAPTER 5 Carrier Transport Phenomena

- Define mobility and discuss the temperature and ionized impurity concentration dependence on mobility.
- Define conductivity and resistivity.
- Discuss velocity saturation.
- Discuss carrier diffusion current density.
- State the Einstein relation.
- Describe the Hall effect.

REVIEW QUESTIONS

1. Write the equation for the total drift current density.
2. Define carrier mobility. What is the unit of mobility?
3. Explain the temperature dependence of mobility. Why is the carrier mobility a function of the ionized impurity concentrations?
4. Define conductivity. Define resistivity. What are the units of conductivity and resistivity?
5. Sketch the drift velocity of electrons in silicon versus electric field. Repeat for GaAs.
6. Write the equations for the diffusion current densities of electrons and holes.
7. What is the Einstein relation?
8. Describe the Hall effect.
9. Explain why the polarity of the Hall voltage changes depending on the conductivity (n-type or p-type) of the semiconductor.

PROBLEMS

(Note: Use the semiconductor parameters given in Appendix B if the parameters are specifically given in a problem.)

Section 5.1 Carrier Drift

5.1 Consider a homogeneous gallium arsenide semiconductor at \( T = 300 \text{ K} \) with \( N_d = 10^{16} \text{ cm}^{-3} \) and \( N_a = 0. \) (a) Calculate the thermal-equilibrium values of electron and hole concentrations. (b) For an applied E-field of \( 10 \text{ V/cm} \), calculate the drift current density. (c) Repeat parts (a) and (b) if \( N_d = 0 \) and \( N_a = 10^{16} \text{ cm}^{-3} \).

5.2 A silicon crystal having a cross-sectional area of \( 0.001 \text{ cm}^2 \) and a length of \( 10^{-3} \text{ cm} \) connected at its ends to a 10-V battery. At \( T = 300 \text{ K} \), we want a current of 100 nA in the silicon. Calculate: (a) the required resistance \( R \), (b) the required conductivity, (c) the density of donor atoms to be added to achieve this conductivity, and (d) the concentration of acceptor atoms to be added to form a compensated p-type material with the conductivity given from part (b) if the initial concentration of donor atoms \( N_d = 10^{15} \text{ cm}^{-3} \).

5.3 (a) A silicon semiconductor is in the shape of a rectangular bar with a cross-sectional area of \( 100 \mu \text{m}^2 \), a length of 0.1 cm, and is doped with \( 5 \times 10^{16} \text{ cm}^{-3} \) arsenic atoms. The temperature is \( T = 300 \text{ K} \). Determine the current if 5 V is applied across the length. (b) Repeat part (a) if the length is reduced to 0.01 cm. (c) Calculate the average drift velocity of electrons in parts (a) and (b).

5.4 (a) A GaAs semiconductor resistor is doped with acceptor impurities at a concentration of \( N_a = 10^{17} \text{ cm}^{-3} \). The cross-sectional area is 85 \( \mu \text{m}^2 \). The current in the
resistor is to be \( I = 20 \text{ mA} \) with 10 V applied. Determine the required length of the device. (b) Repeat part (a) for silicon.

5.5  
(a) Three volts is applied across a 1-cm-long semiconductor bar. The average electron drift velocity is \( 10^4 \text{ cm/s} \). Find the electron mobility. (b) If the electron mobility in part (a) were 800 cm\(^2\)/V-s, what is the average electron drift velocity?

5.6  
Use the velocity–field relations for silicon and gallium arsenide shown in Figure 5.7 to determine the transit time of electrons through a 1-μm distance in these materials for an electric field of (a) 1 kV/cm and (b) 50 kV/cm.

5.7  
A perfectly compensated semiconductor is one in which the donor and acceptor impurity concentrations are exactly equal. Assuming complete ionization, determine the conductivity of silicon at \( T = 300 \text{ K} \) in which the impurity concentrations are (a) \( N_d = N_a = 10^{14} \text{ cm}^{-3} \) and (b) \( N_d = N_a = 10^{18} \text{ cm}^{-3} \).

5.8  
(a) In a p-type gallium arsenide semiconductor, the conductivity is \( \sigma = 5 (\Omega\text{-cm})^{-1} \) at \( T = 300 \text{ K} \). Calculate the thermal-equilibrium values of the electron and hole concentrations. (b) Repeat part (a) for n-type silicon if the resistivity is \( \rho = 8 \Omega\text{-cm} \).

5.9  
In a particular semiconductor material, \( \mu_n = 1000 \text{ cm}^2/\text{V-s} \), \( \mu_p = 600 \text{ cm}^2/\text{V-s} \), and \( N_c = N_v = 10^{19} \text{ cm}^{-3} \). These parameters are independent of temperature. The measured conductivity of the intrinsic material is \( \sigma = 10^{-6} (\Omega\text{-cm})^{-1} \) at \( T = 300 \text{ K} \). Find the conductivity at \( T = 500 \text{ K} \).

5.10  
(a) Calculate the resistivity at \( T = 300 \text{ K} \) of intrinsic (i) silicon, (ii) germanium, and (iii) gallium arsenide. (b) If rectangular semiconductor bars are fabricated using the materials in part (a), determine the resistance of each bar if its cross-sectional area is 85 μm\(^2\) and length is 200 μm.

5.11  
An n-type silicon sample has a resistivity of 5 Ω·cm at \( T = 300 \text{ K} \). (a) What is the donor impurity concentration? (b) What is the expected resistivity at (i) \( T = 200 \text{ K} \) and (ii) \( T = 400 \text{ K} \).

5.12  
Consider silicon doped at impurity concentrations of \( N_d = 2 \times 10^{16} \text{ cm}^{-3} \) and \( N_a = 0 \). An empirical expression relating electron drift velocity to electric field is given by

\[
\nu_d = \frac{\mu_{n0} E}{\sqrt{1 + \left( \frac{\mu_{n0} E}{v_{sat}} \right)^2}}
\]

where \( \mu_{n0} = 1350 \text{ cm}^2/\text{V-s} \), \( v_{sat} = 1.8 \times 10^7 \text{ cm/s} \), and \( E \) is given in V/cm. Plot electron drift current density (magnitude) versus electric field (log–log scale) over the range \( 0 \leq E \leq 10^6 \text{ V/cm} \).

5.13  
Consider silicon at \( T = 300 \text{ K} \). Assume the electron mobility is \( \mu_n = 1350 \text{ cm}^2/\text{V-s} \). The kinetic energy of an electron in the conduction band is \( (1/2)m^*_e v_e^2 \), where \( m^*_e \) is the effective mass and \( v_e \) is the drift velocity. Determine the kinetic energy of an electron in the conduction band if the applied electric field is (a) \( 10 \text{ V/cm} \) and (b) \( 1 \text{ kV/cm} \).

5.14  
Consider a semiconductor that is uniformly doped with \( N_d = 10^{14} \text{ cm}^{-3} \) and \( N_a = 0 \), with an applied electric field of \( E = 100 \text{ V/cm} \). Assume that \( \mu_n = 1000 \text{ cm}^2/\text{V-s} \) and \( \mu_p = 0 \). Also assume the following parameters:

\[
N_c = 2 \times 10^{19} (T/300)^{3/2} \text{ cm}^{-3}
\]

\[
N_v = 1 \times 10^{19} (T/300)^{3/2} \text{ cm}^{-3}
\]

\[
E_g = 1.10 \text{ eV}
\]
(a) Calculate the electric-current density at \( T = 300 \) K. (b) At what temperature will this current increase by 5 percent? (Assume the mobilities are independent of temperature.)

5.15 A semiconductor material has electron and hole mobilities \( \mu_n \) and \( \mu_p \), respectively. When the conductivity is considered as a function of the hole concentration \( p_0 \), (a) show that the minimum value of conductivity, \( \sigma_{\text{min}} \), can be written as

\[
\sigma_{\text{min}} = \frac{2\sigma_i (\mu_n \mu_p)^{1/2}}{(\mu_n + \mu_p)}
\]

where \( \sigma_i \) is the intrinsic conductivity, and (b) show that the corresponding hole concentration is \( p_0 = n_i (\mu_n / \mu_p)^{1/2} \).

5.16 A particular intrinsic semiconductor has a resistivity of 50 \( \Omega \)-cm at \( T = 300 \) K and 5 \( \Omega \)-cm at \( T = 330 \) K. Neglecting the change in mobility with temperature, determine the bandgap energy of the semiconductor.

5.17 Three scattering mechanisms are present in a particular semiconductor material. If only the first scattering mechanism were present, the mobility would be \( \mu_1 = 2000 \) cm\(^2\)/V-s, if only the second mechanism were present, the mobility would be \( \mu_2 = 1500 \) cm\(^2\)/V-s, and if only the third mechanism were present, the mobility would be \( \mu_3 = 500 \) cm\(^2\)/V-s. What is the net mobility?

5.18 Assume that the mobility of electrons in silicon at \( T = 300 \) K is \( \mu_n = 1300 \) cm\(^2\)/V-s. Also assume that the mobility is limited by lattice scattering and varies as \( T^{-3/2} \). Determine the electron mobility at (a) \( T = 200 \) K and (b) \( T = 400 \) K.

5.19 Two scattering mechanisms exist in a semiconductor. If only the first mechanism is present, the mobility would be 250 cm\(^2\)/V-s. If only the second mechanism is present, the mobility would be 500 cm\(^2\)/V-s. Determine the mobility when both scattering mechanisms exist at the same time.

5.20 The effective density of states functions in silicon can be written in the form

\[
N_{\epsilon} = 2.8 \times 10^{19} \left( \frac{T}{300} \right)^{3/2} \quad N_{\sigma} = 1.04 \times 10^{19} \left( \frac{T}{300} \right)^{3/2}
\]

Assume the mobilities are given by

\[
\mu_n = 1350 \left( \frac{T}{300} \right)^{-3/2} \quad \mu_p = 480 \left( \frac{T}{300} \right)^{-3/2}
\]

Assume the bandgap energy is \( E_g = 1.12 \) eV and independent of temperature. Plot the intrinsic conductivity as a function of \( T \) over the range \( 200 \leq T \leq 600 \) K.

5.21 (a) Assume that the electron mobility in an n-type semiconductor is given by

\[
\mu_n = \frac{1350}{\left( 1 + \frac{N_d}{5 \times 10^{16}} \right)^{1/2}} \text{ cm}^2/\text{V-s}
\]

where \( N_d \) is the donor concentration in cm \(^3\). Assuming complete ionization, plot conductivity as a function of \( N_d \) over the range \( 10^{15} \leq N_d \leq 10^{18} \) cm\(^{-3}\). (b) Com the results of part (a) to that if the mobility were assumed to be a constant equal to...
1350 \text{cm}^2/\text{V-s}. (c) If an electric field of \( E = 10 \text{ V/cm} \) is applied to the semiconductor, plot the electron drift current density of parts (a) and (b).

**Section 5.2  Carrier Diffusion**

5.22 Consider a sample of silicon at \( T = 300 \text{ K} \). Assume that the electron concentration varies linearly with distance, as shown in Figure 5.14. The diffusion current density is found to be \( J_n = 0.19 \text{ A/cm}^2 \). If the electron diffusion coefficient is \( D_n = 25 \text{ cm}^2/\text{s} \), determine the electron concentration at \( x = 0 \).

5.23 The electron concentration in silicon decreases linearly from \( 10^{16} \text{ cm}^{-3} \) to \( 10^{15} \text{ cm}^{-3} \) over a distance of 0.1 cm. The cross-sectional area of the sample is 0.05 cm\(^2\). The electron diffusion coefficient is 25 cm\(^2\)/s. Calculate the electron diffusion current.

5.24 The electron concentration in a sample of n-type silicon varies linearly from \( 10^{17} \text{ cm}^{-3} \) at \( x = 0 \) to \( 6 \times 10^{16} \text{ cm}^{-3} \) at \( x = 4 \mu m \). There is no applied electric field. The electron current density is experimentally measured to be \(-400 \text{ A/cm}^2\). What is the electron diffusion coefficient?

5.25 The hole concentration in p type GaAs is given by \( p = 10^{16}(1 - x/L) \text{ cm}^{-3} \) for \( 0 \leq x \leq L \) where \( L = 10 \mu m \). The hole diffusion coefficient is 10 cm\(^2\)/s. Calculate the hole diffusion current density at (a) \( x = 0 \), (b) \( x = 5 \mu m \), and (c) \( x = 10 \mu m \).

5.26 The hole concentration is given by \( p = 10^{15} \text{ exp} (-x/L_p) \text{ cm}^{-3} \) for \( x \geq 0 \) and the electron concentration is given by \( 5 \times 10^{14} \text{ exp} (+x/L_n) \text{ cm}^{-3} \) for \( x \leq 0 \). The values of \( L_p \) and \( L_n \) are \( 5 \times 10^{-4} \text{ cm} \) and \( 10^{-3} \text{ cm} \), respectively. The hole and electron diffusion coefficients are 10 cm\(^2\)/s and 25 cm\(^2\)/s, respectively. The total current density is defined as the sum of the hole diffusion current density at \( x = 0 \) and the electron diffusion current density at \( x = 0 \). Calculate the total current density.

5.27 The hole concentration in germanium at \( T = 300 \text{ K} \) varies as

\[
p(x) = 10^{15} \text{ exp} \left( \frac{-x}{22.5} \right) \text{ cm}^{-3}
\]

where \( x \) is measured in \( \mu m \). If the hole diffusion coefficient is \( D_p = 48 \text{ cm}^2/\text{s} \), determine the hole diffusion current density as a function of \( x \).

5.28 The electron concentration in silicon at \( T = 300 \text{ K} \) is given by

\[
n(x) = 10^{16} \text{ exp} \left( \frac{-x}{18} \right) \text{ cm}^{-3}
\]
where \( x \) is measured in \( \mu m \) and is limited to \( 0 \leq x \leq 25 \mu m \). The electron diffusion coefficient is \( D_e = 25 \text{ cm}^2/\text{s} \) and the electron mobility is \( \mu_e = 960 \text{ cm}^2/\text{V-s} \). The total electron current density through the semiconductor is constant and equal to \( J_n = -40 \text{ A/cm}^2 \). The electron current has both diffusion and drift current components. Determine the electric field as a function of \( x \) which must exist in the semiconductor.

5.29 The total current in a semiconductor is constant and is composed of electron drift current and hole diffusion current. The electron concentration is constant and is equal to \( 10^{16} \text{ cm}^{-3} \). The hole concentration is given by

\[
p(x) = 10^{15} \exp\left(\frac{-x}{L}\right) \text{ cm}^{-3} \quad (x \geq 0)
\]

where \( L = 12 \mu m \). The hole diffusion coefficient is \( D_h = 12 \text{ cm}^2/\text{s} \) and the electron mobility is \( \mu_n = 1000 \text{ cm}^2/\text{V-s} \). The total current density is \( J = 4.8 \text{ A/cm}^2 \). Calculate (a) the hole diffusion current density versus \( x \), (b) the electron current density versus \( x \), and (c) the electric field versus \( x \).

*5.30* A constant electric field, \( E = 12 \text{ V/cm} \), exists in the +\( x \) direction of an n-type gallium arsenide semiconductor for \( 0 \leq x \leq 50 \mu m \). The total current density is a constant and is \( J = 100 \text{ A/cm}^2 \). At \( x = 0 \), the drift and diffusion currents are equal. Let \( T = 300 \text{ K} \) and \( \mu_n = 8000 \text{ cm}^2/\text{V-s} \). (a) Determine the expression for the electron concentration \( n(x) \). (b) Calculate the electron concentration at \( x = 0 \) and at \( x = 50 \mu m \). (c) Calculate the drift and diffusion current densities at \( x = 50 \mu m \).

*5.31* In n-type silicon, the Fermi energy level varies linearly with distance over a short range. At \( x = 0 \), \( E_F - E_{F_i} = 0.4 \text{ eV} \) and, at \( x = 10^{-3} \text{ cm} \), \( E_F - E_{F_i} = 0.15 \text{ eV} \). (a) Write the expression for the electron concentration over the distance. (b) If the electron diffusion coefficient is \( D_n = 25 \text{ cm}^2/\text{s} \), calculate the electron diffusion current density at (i) \( x = 0 \) and (ii) \( x = 5 \times 10^{-4} \text{ cm} \).

*5.32* (a) The electron concentration in a semiconductor is given by \( n = 10^{16}(1 - x/L) \text{ cm}^{-3} \) for \( 0 \leq x \leq L \), where \( L = 10 \mu m \). The electron mobility and diffusion coefficient are \( \mu_n = 1000 \text{ cm}^2/\text{V-s} \) and \( D_n = 25.9 \text{ cm}^2/\text{s} \). An electric field is applied such that the total electron current density is a constant over the given range of \( x \) and is \( J_n = -80 \text{ A/cm}^2 \). Determine the required electric field versus distance function. (b) Repeat part (a) if \( J_n = -20 \text{ A/cm}^2 \).

### Section 5.3 Graded Impurity Distribution

5.33 Consider a semiconductor in thermal equilibrium (no current). Assume that the donor concentration varies exponentially as

\[
N_d(x) = N_{d0} \exp(-ax)
\]

over the range \( 0 \leq x \leq 1/\alpha \) where \( N_{d0} \) is a constant. (a) Calculate the electric field as a function of \( x \) for \( 0 \leq x \leq 1/\alpha \). (b) Calculate the potential difference between \( x = 0 \) and \( x = 1/\alpha \).

5.34 Using the data in Example 5.5, calculate the potential difference between \( x = 0 \) and \( x = 1 \mu m \).

5.35 Determine a doping profile in a semiconductor at \( T = 300 \text{ K} \) that will induce an electric field of \( 1 \text{ kV/cm} \) over a length of \( 0.2 \mu m \).
In GaAs, the donor impurity concentration varies as $N_d$ $\exp(-x/L)$ for $0 \leq x \leq L$, where $L = 0.1$ $\mu$m and $N_{d0} = 5 \times 10^{16}$ $cm^{-3}$. Assume $\mu_e = 6000$ $cm^2/V$-$s$ and $T = 300$ K. (a) Derive the expression for the electron diffusion current density versus distance over the given range of $x$. (b) Determine the induced electric field that generates a drift current density that compensates the diffusion current density.

Consider the electron mobility in silicon for $N_d = 10^{17}$ $cm^{-3}$ from Figure 5.2a. Calculate and plot the electron diffusion coefficient versus temperature over the range $-50 \leq T \leq 200^\circ C$. (b) Repeat part (a) if the electron diffusion coefficient is given by $D_{e1}$ = $(0.0259)\mu_e$ for all temperatures. What conclusion can be made about the temperature dependence of the diffusion coefficient?

Assume that the mobility of a carrier at $T = 300$ K is $\mu = 925$ $cm^2/V$-$s$. Calculate the carrier diffusion coefficient, (b) Assume that the diffusion coefficient of a carrier at $T = 300$ K is $D = 28.3$ $cm^2/s$. Calculate the carrier mobility.

Section 5.4 The Hall Effect

(Note: Refer to Figure 5.13 for the geometry of the Hall effect.)

A sample of silicon is doped with $10^{16}$ boron atoms per cm$^3$. The Hall sample has the same geometrical dimensions given in Example 5.7. The current is $I_x = 1$ mA with $B_z = 350$ gauss = $3.5 \times 10^{-2}$ tesla. Determine (a) the Hall voltage and (b) the Hall field.

Germanium is doped with $5 \times 10^{15}$ donor atoms per cm$^3$ at $T = 300$ K. The dimensions of the Hall device are $d = 5 \times 10^{-2}$ cm, $W = 2 \times 10^{-2}$ cm, and $L = 10^{-1}$ cm. The current is $I_x = 250$ $\mu$A, the applied voltage is $V_x = 100$ mV, and the magnetic flux density is $B_z = 500$ gauss = $5 \times 10^{-2}$ tesla. Calculate: (a) the Hall voltage, (b) the Hall field, and (c) the carrier mobility.

A silicon Hall device at $T = 300$ K has the following geometry: $d = 10^{-3}$ cm, $W = 10^{-2}$ cm, and $L = 10^{-1}$ cm. The following parameters are measured: $I_x = 0.75$ mA, $V_x = 15$ V, $V_H = +5.8$ mV, and $B_z = 1000$ gauss = $10^{-1}$ tesla. Determine (a) the conductivity type, (b) the majority carrier concentration, and (c) the majority carrier mobility.

Consider silicon at $T = 300$ K. A Hall effect device is fabricated with the following geometry: $d = 5 \times 10^{-3}$ cm, $W = 5 \times 10^{-2}$ cm, and $L = 0.50$ cm. The electrical parameters measured are: $I_x = 0.50$ mA, $V_x = 1.25$ V, and $B_z = 650$ gauss = $6.5 \times 10^{-2}$ tesla. The Hall field is $E_H = -16.5$ mV/cm. Determine (a) the Hall voltage, (b) the conductivity type, (c) the majority carrier concentration, and (d) the majority carrier mobility.

Consider a gallium arsenide sample at $T = 300$ K. A Hall effect device has been fabricated with the following geometry: $d = 0.01$ cm, $W = 0.05$ cm, and $L = 0.5$ cm. The electrical parameters are: $I_x = 2.5$ mA, $V_x = 2.2$ V, and $B_z = 2.5 \times 10^{-3}$ tesla. The Hall voltage is $V_H = -4.5$ mV. Find: (a) the conductivity type, (b) the majority carrier concentration, (c) the mobility, and (d) the resistivity.

Summary and Review

An n-type silicon semiconductor resistor is to be designed so that it carries a current of 5 mA with an applied voltage of 5 V. (a) If $N_d = 3 \times 10^{14}$ $cm^{-3}$ and $N_u = 0$, design a resistor to meet the required specifications. (b) If $N_d = 3 \times 10^{16}$ $cm^{-3}$ and
\[ N_a = 2.5 \times 10^{16} \text{ cm}^{-3} \], redesign the resistor. (c) Discuss the relative lengths of the two designs compared to the doping concentration. Is there a linear relationship?

5.45 In fabricating a Hall effect device, the two points at which the Hall voltage is measured may not be lined up exactly perpendicular to the current \( I_x \) (see Figure 5.13). Discuss the effect this misalignment will have on the Hall voltage. Show that a valid Hall voltage can be obtained from two measurements: first with the magnetic field in the \( +z \) direction, and then in the \( -z \) direction.

5.46 Another technique for determining the conductivity type of a semiconductor is called the hot probe method. It consists of two probes and an ammeter that indicates the direction of current. One probe is heated and the other is at room temperature. No voltage is applied, but a current will exist when the probes touch the semiconductor. Explain the operation of this hot probe technique and sketch a diagram indicating the direction of current for \( p \)- and \( n \)-type semiconductor samples.

**READING LIST**